

# SAMSUNG

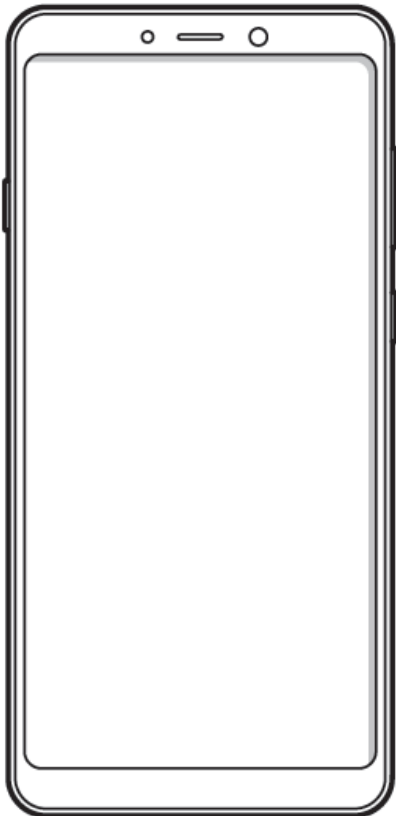
## Mobile Device SM-A920F Common



# SERVICE *Manual*

Mobile Device

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# 1. Safety Precautions

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## 1-1. Repair Precaution

Before attempting any repair or detailed tuning, shield the device from RF noise or static electricity discharges.

Use only demagnetized tools that are specifically designed for small electronic repairs, as most electronic parts are sensitive to electromagnetic forces.

Use only high quality screwdrivers when servicing products. Low quality screwdrivers can easily damage the heads of screws.

Use only conductor wire of the properly gauge and insulation for low resistance, because of the low margin of error of most testing equipment.

We recommend 22-gauge twisted copper wire.

Hand-soldering is not recommended, because printed circuit boards (PCBs) can be easily damaged, even with relatively low heat. Never use a soldering iron with a power rating of more than 100 watts and use only lead-free solder with a melting point below 250°C (482°F).

Prior to disassembling the battery charger for repair, ensure that the AC power is disconnected.

Always use the replacement parts that are registered in the SEC system. Third-party replacement parts may not function properly.

# 1. Safety Precautions

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## 1-2. ESD(Electrostatically Sensitive Devices) Precaution

Many semiconductors and ESDs in electronic devices are particularly sensitive to static discharge and can be easily damaged by it. We recommend protecting these components with conductive anti-static bags when you store or transport them.

Always use an anti-static strap or wristband and remove electrostatic buildup or dissipate static electricity from your body before repairing ESDs.

Ensure that soldering irons have AC adapter with ground wires and that the ground wires are properly connected.

Use only desoldering tools with plastic tips to prevent static discharge.

Properly shield the work environment from accidental electrostatic discharge before opening packages containing ESDs.

The potential for static electricity discharge may be increased in low humidity environments, such as air-conditioned rooms. Increase the airflow to the working area to decrease the chance of accidental static electricity discharges.

## 2. Specification

### 2-1. GSM General Specification

| Item                              |               | GSM 850                | EGSM 900               | DCS1800                | PCS1900                |
|-----------------------------------|---------------|------------------------|------------------------|------------------------|------------------------|
| Freq. Band[MHz]                   |               | 824~849                | 880~915                | 1710~1785              | 1850~1910              |
| Uplink/Downlink                   |               | 869~894                | 925~960                | 1805~1880              | 1930~1990              |
| ARFCN range                       |               | 128~251                | 0~124 & 975~1023       | 512~885                | 512~810                |
| Tx/Rx spacing                     |               | 45MHz                  | 45MHz                  | 95MHz                  | 80MHz                  |
| Mod. Bit rate/<br>Bit Period      |               | 270.833kbps<br>3.692us | 270.833kbps<br>3.692us | 270.833kbps<br>3.692us | 270.833kbps<br>3.692us |
| Time Slot Period/<br>Frame Period |               | 576.9us<br>4.615ms     | 576.9us<br>4.615ms     | 576.9us<br>4.615ms     | 576.9us<br>4.615ms     |
| Modulation                        | GSM/<br>EGPRS | GMSK/<br>8PSK          | GMSK/<br>8PSK          | GMSK/<br>8PSK          | GMSK/<br>8PSK          |
| MS Power                          |               | 32.8dBm~5dBm           | 33dBm~5dBm             | 29.5dBm~0dBm           | 29.8dBm~0dBm           |
| Power Class                       |               | 4(GMSK)<br>E2(8PSK)    | 4(GMSK)<br>E2(8PSK)    | 1(GMSK)<br>E2(8PSK)    | 1(GMSK)<br>E2(8PSK)    |
| Sensitivity                       |               | -109.5dBm              | -109.5dBm              | -108.5dBm              | -108dBm                |
| TDMA Mux                          |               | 8                      | 8                      | 8                      | 8                      |



## 2. Specification

### 2-2. GSM Tx Power Class

| TX Power control level | GSM850   | TX Power control level | EGSM900  | TX Power control level | DCS1800  | TX Power control level | PCS1900  |
|------------------------|----------|------------------------|----------|------------------------|----------|------------------------|----------|
| 5                      | 33±2 dBm | 5                      | 33±2 dBm | 0                      | 30±3 dBm | 0                      | 30±3 dBm |
| 6                      | 31±2 dBm | 6                      | 31±2 dBm | 1                      | 28±3 dBm | 1                      | 28±3 dBm |
| 7                      | 29±2 dBm | 7                      | 29±2 dBm | 2                      | 26±3 dBm | 2                      | 26±3 dBm |
| 8                      | 27±2 dBm | 8                      | 27±2 dBm | 3                      | 24±3 dBm | 3                      | 24±3 dBm |
| 9                      | 25±2 dBm | 9                      | 25±2 dBm | 4                      | 22±3 dBm | 4                      | 22±3 dBm |
| 10                     | 23±2 dBm | 10                     | 23±2 dBm | 5                      | 20±3 dBm | 5                      | 20±3 dBm |
| 11                     | 21±2 dBm | 11                     | 21±2 dBm | 6                      | 18±3 dBm | 6                      | 18±3 dBm |
| 12                     | 19±2 dBm | 12                     | 19±2 dBm | 7                      | 16±3 dBm | 7                      | 16±3 dBm |
| 13                     | 17±2 dBm | 13                     | 17±2 dBm | 8                      | 14±3 dBm | 8                      | 14±3 dBm |
| 14                     | 15±2 dBm | 14                     | 15±2 dBm | 9                      | 12±4 dBm | 9                      | 12±4 dBm |
| 15                     | 13±2 dBm | 15                     | 13±2 dBm | 10                     | 10±4 dBm | 10                     | 10±4 dBm |
| 16                     | 11±3 dBm | 16                     | 11±3 dBm | 11                     | 8±4 dBm  | 11                     | 8±4 dBm  |
| 17                     | 9±3 dBm  | 17                     | 9±3 dBm  | 12                     | 6±4 dBm  | 12                     | 6±4 dBm  |
| 18                     | 7±3 dBm  | 18                     | 7±3 dBm  | 13                     | 4±4 dBm  | 13                     | 4±4 dBm  |
| 19                     | 5±3 dBm  | 19                     | 5±3 dBm  | 14                     | 2±5 dBm  | 14                     | 2±5 dBm  |
| -                      | -        | -                      | -        | 15                     | 0±5 dBm  | 15                     | 0±5 dBm  |

## 2. Specification

### 2-3. WCDMA General Specification

| Item                               | WCDMA2100(B1)                                | WCDMA1900(B2)                                | WCDMA1700(B4)                                | WCDMA850(B5)                                 | WCDMA900(B8)                                 |
|------------------------------------|----------------------------------------------|----------------------------------------------|----------------------------------------------|----------------------------------------------|----------------------------------------------|
| Freq. Band[MHz]<br>Uplink/Downlink | 1920~1980<br>2110~2170                       | 1850~1910<br>1930~1990                       | 1710~1755<br>2110~2155                       | 824~849<br>869~894                           | 880~915<br>925~960                           |
| ARFCN range                        | UL: 9612~9888<br>DL: 10562~10838             | UL: 9262~9538<br>DL: 9662~9938               | UL: 1312~1513<br>DL: 1537~1738               | UL: 4132~4233<br>DL: 4357~4458               | UL: 2712~2868<br>DL: 2937~3088               |
| Tx/Rx spacing                      | 190MHz                                       | 80MHz                                        | 400MHz                                       | 45MHz                                        | 45MHz                                        |
| Mod. Bit rate/<br>Bit Period       | 42.2Mbps(DL)<br>5.42Mbps(UL)                 | 42.2Mbps(DL)<br>5.42Mbps(UL)                 | 42.2Mbps(DL)<br>5.42Mbps(UL)                 | 42.2Mbps(DL)<br>5.42Mbps(UL)                 | 42.2Mbps(DL)<br>5.42Mbps(UL)                 |
| Time Slot Period/<br>Frame Period  | WCDMA<br>10ms/0.667ms<br>HSPA<br>2ms/0.667ms | WCDMA<br>10ms/0.667ms<br>HSPA<br>2ms/0.667ms | WCDMA<br>10ms/0.667ms<br>HSPA<br>2ms/0.667ms | WCDMA<br>10ms/0.667ms<br>HSPA<br>2ms/0.667ms | WCDMA<br>10ms/0.667ms<br>HSPA<br>2ms/0.667ms |
| Modulation                         | QPSK<br>16QAM<br>64QAM                       | QPSK<br>16QAM<br>64QAM                       | QPSK<br>16QAM<br>64QAM                       | QPSK<br>16QAM<br>64QAM                       | QPSK<br>16QAM<br>64QAM                       |
| MS Power<br>(dBm)                  | 23.5 ~ -49(↓)                                | 22.5 ~ -49(↓)                                | 22.5 ~ -49(↓)                                | 23 ~ -49(↓)                                  | 22.5 ~ -49(↓)                                |
| Power Class                        | 3(max+24dBm)                                 | 3(max+24dBm)                                 | 3(max+24dBm)                                 | 3(max+24dBm)                                 | 3(max+24dBm)                                 |
| Sensitivity                        | -111.0dBm                                    | -110dBm                                      | -110dBm                                      | -111.5dBm                                    | -111.5dBm                                    |

## 2. Specification

### 2-4. LTE General Specification

| Item                                     | LTE Band1                        | LTE Band2                        | LTE Band3                        | LTE Band4                        | LTE Band5                        |
|------------------------------------------|----------------------------------|----------------------------------|----------------------------------|----------------------------------|----------------------------------|
| Freq. Band[MHz]<br>Uplink/Downlink       | 1920~1980<br>2110~2170           | 1850~1910<br>1930~1990           | 1710~1785<br>1805~1880           | 1710~1755<br>2110~2155           | 824~849<br>869~894               |
| ARFCN range                              | UL:18000~18599<br>DL:0~599       | UL:18600~19199<br>DL:600~1199    | UL:19200~19949<br>DL:1200~1949   | UL:19950~20399<br>DL:1950~2399   | UL:20400~20649<br>DL:2400~2649   |
| Tx/Rx spacing<br>(MHz)                   | 190                              | 80                               | 95                               | 400                              | 45                               |
| Channel Bandwidth<br>(MHz)               | 5/10/15/20                       | 1.4/3/5/10/15/20                 | 1.4/3/5/10/15/20                 | 1.4/3/5/10/15/20                 | 1.4/3/5/10                       |
| Modulation                               | QPSK,16/64QAM<br>256QAM(DL only) | QPSK,16/64QAM<br>256QAM(DL only) | QPSK,16/64QAM<br>256QAM(DL only) | QPSK,16/64QAM<br>256QAM(DL only) | QPSK,16/64QAM<br>256QAM(DL only) |
| MS Power<br>(dBm)                        | 25.7~-39(↓)                      | 25.7~-39(↓)                      | 25.7~-39(↓)                      | 25.7~-39(↓)                      | 25.7~-39(↓)                      |
| Sensitivity<br>(QPSK, BW 10MHz)<br>(dBm) | -100                             | -98.5                            | -99                              | -99                              | -100                             |

| Item                                     | LTE Band7                        | LTE Band8                        | LTE Band12                       | LTE Band13                       |
|------------------------------------------|----------------------------------|----------------------------------|----------------------------------|----------------------------------|
| Freq. Band[MHz]<br>Uplink/Downlink       | 2500~2570<br>2620~2690           | 880~915<br>925~960               | 699~716<br>729~746               | 777~787<br>746~756               |
| ARFCN range                              | UL:20750~21449<br>DL:2750~3449   | UL:21450~21799<br>DL:3450~3799   | UL:23010~23179<br>DL:5010~5179   | UL:23180~23179<br>DL:5180~5279   |
| Tx/Rx spacing<br>(MHz)                   | 120                              | 45                               | 30                               | -31                              |
| Channel Bandwidth<br>(MHz)               | 5/10/15/20                       | 1.4/3/5/10                       | 1.4/3/5/10                       | 5/10                             |
| Modulation                               | QPSK,16/64QAM<br>256QAM(DL only) | QPSK,16/64QAM<br>256QAM(DL only) | QPSK,16/64QAM<br>256QAM(DL only) | QPSK,16/64QAM<br>256QAM(DL only) |
| MS Power (dBm)                           | 25.7~-39(↓)                      | 25.7~-39(↓)                      | 25.7~-39(↓)                      | 25.7~-39(↓)                      |
| Sensitivity<br>(QPSK, BW 10MHz)<br>(dBm) | -99                              | -100                             | -99                              | -99                              |

## 2. Specification

| Item                                     | LTE Band17                       | LTE Band20                       | LTE Band26                       | LTE Band28                       |
|------------------------------------------|----------------------------------|----------------------------------|----------------------------------|----------------------------------|
| Freq. Band[MHz]<br>Uplink/Downlink       | 704~716<br>734~746               | 832~862<br>791~821               | 814~849<br>859~894               | 703~748<br>758~803               |
| ARFCN range                              | UL:23730~23849<br>DL:5730~5849   | UL:24150~24449<br>DL:6150~6449   | UL:26690~27039<br>DL:8690~9039   | UL:27210~27659<br>DL:9210~9659   |
| Tx/Rx spacing<br>(MHz)                   | 30                               | -41                              | 45                               | 55                               |
| Channel Bandwidth<br>(MHz)               | 5/10                             | 5/10/15/20                       | 1.4/3/5/10/15                    | 3/5/10/15/20                     |
| Modulation                               | QPSK,16/64QAM<br>256QAM(DL only) | QPSK,16/64QAM<br>256QAM(DL only) | QPSK,16/64QAM<br>256QAM(DL only) | QPSK,16/64QAM<br>256QAM(DL only) |
| MS Power<br>(dBm)                        | 25.7~-39(↓)                      | 25.7~-39(↓)                      | 25.7~-39(↓)                      | 25.7~-39(↓)                      |
| Sensitivity<br>(QPSK, BW 10MHz)<br>(dBm) | -99                              | -100                             | -99                              | -98.5                            |

| Item                                     | LTE Band38                       | LTE Band40                       | LTE Band41                       | LTE Band66                           |
|------------------------------------------|----------------------------------|----------------------------------|----------------------------------|--------------------------------------|
| Freq. Band[MHz]<br>Uplink/Downlink       | 2570~2620                        | 2300~2400                        | 2496~2690                        | 1710~1780<br>2111~2200               |
| ARFCN range                              | UL/DL:37750 ~ 38249              | UL/DL:38650 ~ 39649              | UL/DL:39650 ~ 41589              | UL: 131972~132671<br>DL: 66436~67335 |
| Tx/Rx spacing<br>(MHz)                   | 0                                | 0                                | 0                                | 400                                  |
| Channel Bandwidth<br>(MHz)               | 5/10/15/20                       | 5/10/15/20                       | 5/10/15/20                       | 1.4/3/5/10/15/20                     |
| Modulation                               | QPSK,16/64QAM<br>256QAM(DL only) | QPSK,16/64QAM<br>256QAM(DL only) | QPSK,16/64QAM<br>256QAM(DL only) | QPSK,16/64QAM<br>256QAM(DL only)     |
| MS Power<br>(dBm)                        | 25.7~-39(↓)                      | 25.7~-39(↓)                      | 25.7~-39(↓)                      | 25.7~-39(↓)                          |
| Sensitivity<br>(QPSK, BW 10MHz)<br>(dBm) | -98                              | -98                              | -98                              | -98                                  |

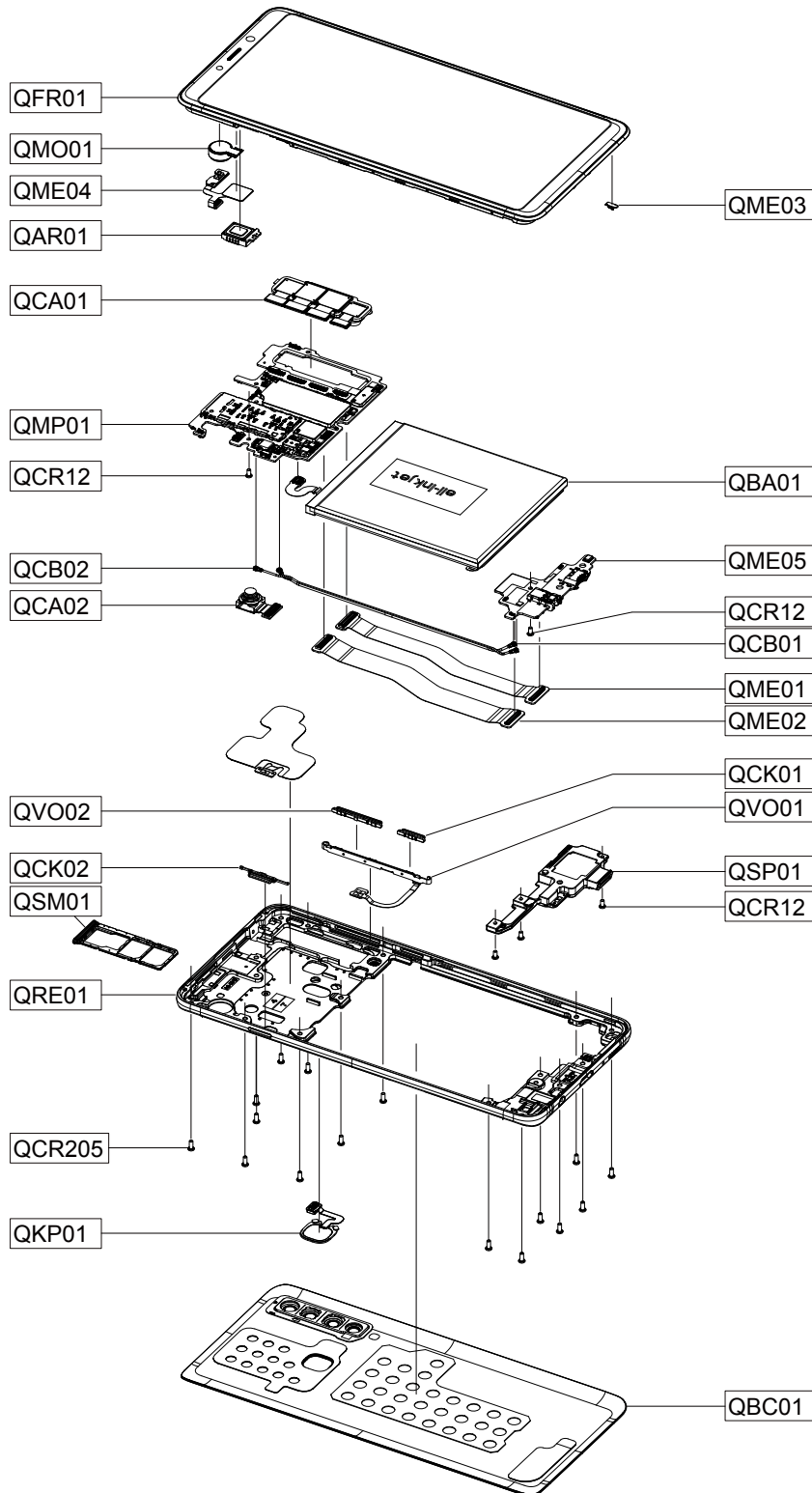
### 3. Product Function

#### Main Function

| Item      | Description                                                                                                                                           |
|-----------|-------------------------------------------------------------------------------------------------------------------------------------------------------|
| OS        | Android V8.0                                                                                                                                          |
| RF        | GSM850 / GSM900 / DCS1800 / PCS1900<br>WCDMA: B1/ B2/ B4/ B5/ B8<br>LTE: B1/ B2/ B3/ B4/ B5/ B7/ B8/ B12/ B13/ B17/ B20/ B26/ B28/ B38/ B40/ B41/ B66 |
| Battery   | 3720mAh                                                                                                                                               |
| Base Band | 2.2Ghz Quad + 1.8GHz Quad                                                                                                                             |
| Other RF  | A-GPS, Glonass, BEIDOU, Galileo, BT5.0, USB 2.0 Type-C, WIFI 802.11 a/b/g/n/ac MIMO,NFC,                                                              |
| Camera    | QUAD Camera<br>(24MP F1.7+5M F2.2+10M F2.4+8MP F2.4) with LED Flash, 24MP F2.0 (Front)                                                                |
| LCD       | 6.3", Super AMOLED FHD+, 2220x1080                                                                                                                    |
| RAM       | 6GB                                                                                                                                                   |
| Sensor    | Accelerometer, Fingerprint Sensor, Gyro Sensor, Geomagnetic Sensor, Proximity Sensor, RGB Light Sensor                                                |
| Accessory | Charger: 5V/2A (AFC: 9V/1.67A)<br>Data cable: 3.2pi, 0.8m(Type C/ USB-A)<br>Ear phone: 3.5pi, 4pin                                                    |

## 4. Exploded View and Parts List

### 4-1. Cellular phone Exploded View



※ SVC REPAIR TAPE  
 QRT01, QRT02

## 5. MAIN Electrical Parts List

| Parts Code  | Design LOC           | Description     |
|-------------|----------------------|-----------------|
| 0401-001110 | D8000                | DIODE-SWITCHING |
| 0404-001250 | D5000,D6001          | DIODE-SCHOTTKY  |
| 0406-001561 | ZD6004,ZD6006,ZD6007 | DIODE-TVS       |
| 0406-001561 | ZD8002,ZD8004        | DIODE-TVS       |
| 0406-001592 | ZD3002,ZD3003,ZD3004 | DIODE-TVS       |
| 0406-001592 | ZD3005,ZD3006,ZD3007 | DIODE-TVS       |
| 0406-001592 | ZD3009,ZD3012        | DIODE-TVS       |
| 0406-001728 | ZD5000               | DIODE-TVS       |
| 0406-001743 | C3053,ZD6020         | DIODE-TVS       |
| 0406-001763 | D6007                | DIODE-TVS       |
| 0406-001776 | ZD6000,ZD6001,ZD6018 | DIODE-TVS       |
| 0406-001776 | ZD6019,ZD6021        | DIODE-TVS       |
| 0406-001787 | D6003,D6004          | DIODE-TVS       |
| 0406-001789 | ZD6005               | DIODE-TVS       |
| 0406-001797 | ZD6028,ZD6029        | DIODE-TVS       |
| 0406-001808 | D6000                | DIODE-TVS       |
| 0406-001829 | ZD4000               | DIODE-TVS       |
| 0505-002088 | TR5001,TR5002        | FET-SILICON     |
| 0505-003234 | TR5000               | FET-SILICON     |
| 0601-003629 | LED5000              | LED             |
| 1001-001835 | U3003,U3004          | IC              |
| 1001-001844 | U1009                | IC              |
| 1001-001911 | U2027                | IC              |
| 1001-001968 | U8003                | IC              |
| 1001-001970 | U1005,U2004          | IC              |
| 1001-001974 | U1001                | IC              |
| 1001-001975 | U2025                | IC              |
| 1001-001994 | U2000                | IC              |
| 1003-002911 | U5006                | IC              |
| 1108-000660 | UME6000              | IC              |
| 1201-003869 | U3009                | IC              |
| 1201-003976 | U1000,U1006          | IC              |
| 1201-003984 | U2032,U2033          | IC              |
| 1201-004109 | PAM2000              | IC              |
| 1201-004135 | U1004                | IC              |
| 1201-004156 | U8014                | IC              |
| 1203-008249 | U3000                | IC              |
| 1203-008251 | U5004                | IC              |

## 5. MAIN Electrical Parts List

|             |                      |            |
|-------------|----------------------|------------|
| 1203-008379 | U2003                | IC         |
| 1203-008603 | U3017                | IC         |
| 1203-008704 | U7003                | IC         |
| 1203-008797 | U6002                | IC         |
| 1203-008819 | U5002                | IC         |
| 1203-008859 | U7011,U7015          | IC         |
| 1203-008865 | U7004,U7008,U7009    | IC         |
| 1203-008865 | U7013,U7014          | IC         |
| 1203-008867 | U8008                | IC         |
| 1203-008955 | U7006                | IC         |
| 1203-008998 | U6000                | IC         |
| 1203-009012 | U5003                | IC         |
| 1203-009014 | U5005                | IC         |
| 1203-009158 | U7000,U7001          | IC         |
| 1203-009169 | U8000                | IC         |
| 1204-003685 | U8010                | IC         |
| 1205-005106 | U6001                | IC         |
| 1205-005217 | U7002,U7073          | IC         |
| 1205-005821 | U3002                | IC         |
| 1205-005830 | UCP4000              | IC         |
| 1205-005833 | U2029                | IC         |
| 1205-005979 | U3021                | IC         |
| 1205-006037 | U4000                | IC         |
| 1209-002450 | U3010                | IC         |
| 1209-002513 | U3020                | IC         |
| 1404-001724 | TH2000,TH4000,TH5000 | THERMISTOR |
| 1404-001724 | THM3000              | THERMISTOR |
| 1405-001395 | VR2001               | VARISTOR   |
| 1405-001398 | VR3001,VR3002        | VARISTOR   |
| 1405-001403 | V2000                | VARISTOR   |
| 1405-001412 | VR1007               | VARISTOR   |
| 1405-001415 | VR2000               | VARISTOR   |
| 1405-001428 | VR6010,VR6015        | VARISTOR   |
| 1405-001434 | VR2002               | VARISTOR   |
| 1405-001458 | V3000                | VARISTOR   |
| 2007-003015 | R6014,R6016          | R-CHIP     |
| 2007-007014 | R3010                | R-CHIP     |
| 2007-007142 | R6060,R7003,R7016    | R-CHIP     |
| 2007-007190 | R6005,R6006          | R-CHIP     |



## 5. MAIN Electrical Parts List

|             |                   |        |
|-------------|-------------------|--------|
| 2007-007308 | R5029             | R-CHIP |
| 2007-007741 | R3000,R3002,R4032 | R-CHIP |
| 2007-007741 | R4034,R4042,R4046 | R-CHIP |
| 2007-007741 | R5040,R5047,R5054 | R-CHIP |
| 2007-007741 | R6015,R6023,R6026 | R-CHIP |
| 2007-007741 | R6051             | R-CHIP |
| 2007-008056 | R1008,R1009       | R-CHIP |
| 2007-008211 | R7012             | R-CHIP |
| 2007-008263 | R4007             | R-CHIP |
| 2007-008298 | R3006             | R-CHIP |
| 2007-008403 | R8011             | R-CHIP |
| 2007-008420 | R3011,R7002       | R-CHIP |
| 2007-008516 | R6013             | R-CHIP |
| 2007-008531 | R5005,R7001,R7008 | R-CHIP |
| 2007-008531 | R7011,R7015,R8003 | R-CHIP |
| 2007-008588 | C3084,C3085,R4001 | R-CHIP |
| 2007-008588 | R4002,R4003,R4008 | R-CHIP |
| 2007-008588 | R4009,R4010,R4011 | R-CHIP |
| 2007-008588 | R4013,R4014,R4015 | R-CHIP |
| 2007-008588 | R4016,R4017,R4021 | R-CHIP |
| 2007-008588 | R4022,R4023,R4024 | R-CHIP |
| 2007-008588 | R4025,R4026,R4028 | R-CHIP |
| 2007-008588 | R4029,R4030,R4031 | R-CHIP |
| 2007-008766 | R4005,R4006       | R-CHIP |
| 2007-008785 | R1007             | R-CHIP |
| 2007-008800 | R6025             | R-CHIP |
| 2007-009111 | R3001             | R-CHIP |
| 2007-009155 | R5009,R5020,R8006 | R-CHIP |
| 2007-009157 | R5019,R5022,R5026 | R-CHIP |
| 2007-009157 | R5038,R6019,R8007 | R-CHIP |
| 2007-009158 | R5003             | R-CHIP |
| 2007-009201 | R4019,R4020,R8021 | R-CHIP |
| 2007-009201 | R8022             | R-CHIP |
| 2007-009212 | R4045,R4047,R5014 | R-CHIP |
| 2007-009212 | R8000             | R-CHIP |
| 2007-009223 | R6037             | R-CHIP |
| 2007-009315 | R5011,R6002,R6056 | R-CHIP |
| 2007-009315 | R6057,R6058,R6059 | R-CHIP |
| 2007-009315 | R6061,R6062,R6063 | R-CHIP |

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## 5. MAIN Electrical Parts List

|             |                   |                |
|-------------|-------------------|----------------|
| 2007-009315 | R6064,R6065,R6066 | R-CHIP         |
| 2007-009352 | R4033,R7006       | R-CHIP         |
| 2007-009408 | R4037,R4038,R5036 | R-CHIP         |
| 2007-009408 | R5037,R6032       | R-CHIP         |
| 2007-009766 | R6001,R6007,R7000 | R-CHIP         |
| 2007-009766 | R7014,R8002       | R-CHIP         |
| 2007-009793 | R6018             | R-CHIP         |
| 2007-009801 | R4049,R8023,R8024 | R-CHIP         |
| 2007-009805 | R1000,R1001,R1002 | R-CHIP         |
| 2007-009805 | R1003,R1004,R2001 | R-CHIP         |
| 2007-009866 | R5016,R7013,R7017 | R-CHIP         |
| 2007-009920 | R4050,R5043,R5044 | R-CHIP         |
| 2007-009920 | R6009,R6010       | R-CHIP         |
| 2007-009954 | R5027,R5028,R5030 | R-CHIP         |
| 2007-009954 | R6011             | R-CHIP         |
| 2007-009969 | R3024,R3025,R4018 | R-CHIP         |
| 2007-009969 | R8001             | R-CHIP         |
| 2007-010202 | R5041             | R-CHIP         |
| 2007-010233 | R4048             | R-CHIP         |
| 2007-010685 | R6000             | R-CHIP         |
| 2007-011043 | R4027             | R-CHIP         |
| 2007-011648 | R6047,R6048       | R-CHIP         |
| 2007-012068 | R5049             | R-CHIP         |
| 2203-000254 | C5068,C5074       | C-CERAMIC,CHIP |
| 2203-000278 | C3007             | C-CERAMIC,CHIP |
| 2203-001072 | C3102             | C-CERAMIC,CHIP |
| 2203-001239 | C3062,C3063       | C-CERAMIC,CHIP |
| 2203-005344 | C5014             | C-CERAMIC,CHIP |
| 2203-005682 | C1023,C2030,C2031 | C-CERAMIC,CHIP |
| 2203-005682 | C2045,C2046,C2051 | C-CERAMIC,CHIP |
| 2203-005682 | C2121,C2127,C2128 | C-CERAMIC,CHIP |
| 2203-005682 | C3017,C6063,C6064 | C-CERAMIC,CHIP |
| 2203-005682 | C6069,C7138,C7148 | C-CERAMIC,CHIP |
| 2203-005682 | L1001,L1020,L1029 | C-CERAMIC,CHIP |
| 2203-005682 | L1040,L1046,L1049 | C-CERAMIC,CHIP |
| 2203-005682 | L2079             | C-CERAMIC,CHIP |
| 2203-005717 | C1007,C1027,C1030 | C-CERAMIC,CHIP |
| 2203-005717 | C1050,C1121,C1122 | C-CERAMIC,CHIP |
| 2203-005717 | C2003,C2011,C2023 | C-CERAMIC,CHIP |

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## 5. MAIN Electrical Parts List

|             |                   |                |
|-------------|-------------------|----------------|
| 2203-005717 | C2029,C2043,C2055 | C-CERAMIC,CHIP |
| 2203-005717 | C2076,C2077,C2096 | C-CERAMIC,CHIP |
| 2203-005717 | U8066             | C-CERAMIC,CHIP |
| 2203-005719 | C1118,C2085,C2086 | C-CERAMIC,CHIP |
| 2203-005719 | C3037,C3914,C4011 | C-CERAMIC,CHIP |
| 2203-005725 | C3079,C7079       | C-CERAMIC,CHIP |
| 2203-005726 | C8039             | C-CERAMIC,CHIP |
| 2203-005729 | C7073,C8000,C8009 | C-CERAMIC,CHIP |
| 2203-005729 | C8017             | C-CERAMIC,CHIP |
| 2203-005731 | C3040,C3041,C3058 | C-CERAMIC,CHIP |
| 2203-005731 | C3059,C6041,C6044 | C-CERAMIC,CHIP |
| 2203-005732 | C2092,C8002       | C-CERAMIC,CHIP |
| 2203-005734 | C6042,C6043       | C-CERAMIC,CHIP |
| 2203-005736 | C1014,C1016,C1032 | C-CERAMIC,CHIP |
| 2203-005736 | C1033,C1036,C1037 | C-CERAMIC,CHIP |
| 2203-005736 | C1046,C1095,C1096 | C-CERAMIC,CHIP |
| 2203-005736 | C1104,C1125,C1128 | C-CERAMIC,CHIP |
| 2203-005736 | C1129,C2006,C2007 | C-CERAMIC,CHIP |
| 2203-005736 | C2012,C2015,C2016 | C-CERAMIC,CHIP |
| 2203-005736 | C2017,C2021,C2040 | C-CERAMIC,CHIP |
| 2203-005736 | C2053,C2059,C2060 | C-CERAMIC,CHIP |
| 2203-005736 | C2078,C2080,C3009 | C-CERAMIC,CHIP |
| 2203-005736 | C3029,C3031,C3036 | C-CERAMIC,CHIP |
| 2203-005736 | C3039,C3046,C3049 | C-CERAMIC,CHIP |
| 2203-005736 | C3051,C5123,C5124 | C-CERAMIC,CHIP |
| 2203-005736 | L1004,L1048,L1062 | C-CERAMIC,CHIP |
| 2203-005736 | L1070,L2001,L2004 | C-CERAMIC,CHIP |
| 2203-005736 | L2005,L2012,L2019 | C-CERAMIC,CHIP |
| 2203-005736 | L2020,L2023,L2027 | C-CERAMIC,CHIP |
| 2203-005736 | L2048,L2057,L2058 | C-CERAMIC,CHIP |
| 2203-005736 | L3016,L3025       | C-CERAMIC,CHIP |
| 2203-005777 | C1006,C1080,C1086 | C-CERAMIC,CHIP |
| 2203-005777 | C1090,C1092,C1126 | C-CERAMIC,CHIP |
| 2203-005777 | C1127,C2036,C2038 | C-CERAMIC,CHIP |
| 2203-005777 | C2082,C2088,C2095 | C-CERAMIC,CHIP |
| 2203-005789 | C1031,C2025,C2093 | C-CERAMIC,CHIP |
| 2203-005789 | C2094,L2061,L2062 | C-CERAMIC,CHIP |
| 2203-005792 | C1013,C1078,C1094 | C-CERAMIC,CHIP |
| 2203-005792 | C1101,C1106       | C-CERAMIC,CHIP |

## 5. MAIN Electrical Parts List

|             |                   |                |
|-------------|-------------------|----------------|
| 2203-005806 | C2044,C2074,C2081 | C-CERAMIC,CHIP |
| 2203-005806 | C5017             | C-CERAMIC,CHIP |
| 2203-006120 | C8134,C8135       | C-CERAMIC,CHIP |
| 2203-006121 | C6045             | C-CERAMIC,CHIP |
| 2203-006123 | C1114,C3006       | C-CERAMIC,CHIP |
| 2203-006187 | C2028,C2033       | C-CERAMIC,CHIP |
| 2203-006194 | C3028,C3030,C3033 | C-CERAMIC,CHIP |
| 2203-006194 | C3070,C3071,C3072 | C-CERAMIC,CHIP |
| 2203-006194 | C3073,C3074,C3075 | C-CERAMIC,CHIP |
| 2203-006194 | C3076,C3077,C3078 | C-CERAMIC,CHIP |
| 2203-006194 | C6052             | C-CERAMIC,CHIP |
| 2203-006305 | C1020,C1077,C3012 | C-CERAMIC,CHIP |
| 2203-006305 | C7011,C7019,L1035 | C-CERAMIC,CHIP |
| 2203-006318 | C1089,L1064       | C-CERAMIC,CHIP |
| 2203-006400 | C2052,C3101,C3103 | C-CERAMIC,CHIP |
| 2203-006400 | C5054,C6031,C8004 | C-CERAMIC,CHIP |
| 2203-006400 | C8133             | C-CERAMIC,CHIP |
| 2203-006410 | C1047,C1093       | C-CERAMIC,CHIP |
| 2203-006423 | C4082,C6071,C8015 | C-CERAMIC,CHIP |
| 2203-006462 | C8026,C8027       | C-CERAMIC,CHIP |
| 2203-006556 | C1065,C1071,C1074 | C-CERAMIC,CHIP |
| 2203-006556 | C2070             | C-CERAMIC,CHIP |
| 2203-006611 | C3008,C3010,C6053 | C-CERAMIC,CHIP |
| 2203-006648 | C4077             | C-CERAMIC,CHIP |
| 2203-006707 | C3018,L2043       | C-CERAMIC,CHIP |
| 2203-006839 | C3106,C3109,C4083 | C-CERAMIC,CHIP |
| 2203-006839 | C5011,C5019,C5037 | C-CERAMIC,CHIP |
| 2203-006839 | C5071,C5084,C5087 | C-CERAMIC,CHIP |
| 2203-006839 | C5120,C6067       | C-CERAMIC,CHIP |
| 2203-006846 | C6008,C6033,C6046 | C-CERAMIC,CHIP |
| 2203-006846 | C6047,C6058,C6059 | C-CERAMIC,CHIP |
| 2203-006846 | L1066             | C-CERAMIC,CHIP |
| 2203-006872 | C3026,C3065,C3107 | C-CERAMIC,CHIP |
| 2203-006872 | C5076,C5078,C5079 | C-CERAMIC,CHIP |
| 2203-006872 | C5080,C7004,C7076 | C-CERAMIC,CHIP |
| 2203-006979 | C2050             | C-CERAMIC,CHIP |
| 2203-007143 | C5059             | C-CERAMIC,CHIP |
| 2203-007194 | C3015             | C-CERAMIC,CHIP |
| 2203-007210 | C3027,C4004,C4006 | C-CERAMIC,CHIP |

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## 5. MAIN Electrical Parts List

|             |                   |                |
|-------------|-------------------|----------------|
| 2203-007210 | C4028,C4029,C4037 | C-CERAMIC,CHIP |
| 2203-007210 | C4038             | C-CERAMIC,CHIP |
| 2203-007317 | C2099,C2102,C2111 | C-CERAMIC,CHIP |
| 2203-007317 | C2115,C2120,C2123 | C-CERAMIC,CHIP |
| 2203-007317 | C3021,C3034,C3069 | C-CERAMIC,CHIP |
| 2203-007317 | C3908,C5035,C5038 | C-CERAMIC,CHIP |
| 2203-007317 | C5069,C5075,C5077 | C-CERAMIC,CHIP |
| 2203-007317 | C5081,C6014,C6068 | C-CERAMIC,CHIP |
| 2203-007317 | C7013,C7075,C7077 | C-CERAMIC,CHIP |
| 2203-007317 | C8024             | C-CERAMIC,CHIP |
| 2203-007391 | C3024,C3025,C3035 | C-CERAMIC,CHIP |
| 2203-007391 | C3087,C3088,C3108 | C-CERAMIC,CHIP |
| 2203-007391 | C6072,C6075       | C-CERAMIC,CHIP |
| 2203-007393 | C2124,C5043,C5052 | C-CERAMIC,CHIP |
| 2203-007393 | C5122,C6040,C6065 | C-CERAMIC,CHIP |
| 2203-007425 | C5095             | C-CERAMIC,CHIP |
| 2203-007449 | C7024             | C-CERAMIC,CHIP |
| 2203-007474 | C3023,C7018       | C-CERAMIC,CHIP |
| 2203-007486 | C6036             | C-CERAMIC,CHIP |
| 2203-007544 | C3019,C3910,C3911 | C-CERAMIC,CHIP |
| 2203-007781 | C6039,C8012       | C-CERAMIC,CHIP |
| 2203-007796 | C3001,C3105,C4000 | C-CERAMIC,CHIP |
| 2203-007796 | C4001,C4002,C4007 | C-CERAMIC,CHIP |
| 2203-007796 | C4008,C4009,C4010 | C-CERAMIC,CHIP |
| 2203-007796 | C4012,C4013,C4016 | C-CERAMIC,CHIP |
| 2203-007796 | C4017,C4039,C4040 | C-CERAMIC,CHIP |
| 2203-007796 | C4041,C4042,C4043 | C-CERAMIC,CHIP |
| 2203-007796 | C4044,C4046,C4047 | C-CERAMIC,CHIP |
| 2203-007796 | C4055,C4068,C4069 | C-CERAMIC,CHIP |
| 2203-007796 | C4070,C4071,C4072 | C-CERAMIC,CHIP |
| 2203-007796 | C4073,C4074,C4075 | C-CERAMIC,CHIP |
| 2203-007796 | C4076,C4078,C4079 | C-CERAMIC,CHIP |
| 2203-007796 | C4080,C4081,C4084 | C-CERAMIC,CHIP |
| 2203-007796 | C4086,C4087,C4088 | C-CERAMIC,CHIP |
| 2203-007796 | C4089,C4091,C4092 | C-CERAMIC,CHIP |
| 2203-007796 | C4093,C4094,C4096 | C-CERAMIC,CHIP |
| 2203-007796 | C4097,C4099,C4100 | C-CERAMIC,CHIP |
| 2203-007796 | C5010,C5012,C5031 | C-CERAMIC,CHIP |
| 2203-007796 | C5044,C5048,C5050 | C-CERAMIC,CHIP |

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## 5. MAIN Electrical Parts List

|             |                   |                |
|-------------|-------------------|----------------|
| 2203-007796 | C5060,C5061,C5062 | C-CERAMIC,CHIP |
| 2203-007796 | C5065,C5066,C5067 | C-CERAMIC,CHIP |
| 2203-007796 | C5083,C5085,C5086 | C-CERAMIC,CHIP |
| 2203-007796 | C5088,C5089,C5090 | C-CERAMIC,CHIP |
| 2203-007796 | C5091,C5092,C6004 | C-CERAMIC,CHIP |
| 2203-007796 | C6005,C6006,C6007 | C-CERAMIC,CHIP |
| 2203-007796 | C6012,C6013,C6015 | C-CERAMIC,CHIP |
| 2203-007796 | C6018,C6019,C6021 | C-CERAMIC,CHIP |
| 2203-007796 | C6022,C6023,C6024 | C-CERAMIC,CHIP |
| 2203-007796 | C6025,C6026,C6027 | C-CERAMIC,CHIP |
| 2203-007796 | C6028,C6029,C6049 | C-CERAMIC,CHIP |
| 2203-007796 | C6050,C6051,C7000 | C-CERAMIC,CHIP |
| 2203-007796 | C7002,C7005,C7006 | C-CERAMIC,CHIP |
| 2203-007796 | C7017,C7021,C7022 | C-CERAMIC,CHIP |
| 2203-007796 | C7023,C7030,C7031 | C-CERAMIC,CHIP |
| 2203-007796 | C7032,C7033,C7034 | C-CERAMIC,CHIP |
| 2203-007796 | C7036,C7044,C7045 | C-CERAMIC,CHIP |
| 2203-007796 | C7053,C7055,C7056 | C-CERAMIC,CHIP |
| 2203-007796 | C7057,C7059,C7063 | C-CERAMIC,CHIP |
| 2203-007796 | C7064,C7078,C7083 | C-CERAMIC,CHIP |
| 2203-007796 | C7092,C8005,C8019 | C-CERAMIC,CHIP |
| 2203-007796 | C8020,C8028,C8030 | C-CERAMIC,CHIP |
| 2203-007796 | C8034,C8038       | C-CERAMIC,CHIP |
| 2203-008097 | C1000,C1003,C1004 | C-CERAMIC,CHIP |
| 2203-008097 | C1044,C1066,C1072 | C-CERAMIC,CHIP |
| 2203-008097 | C1073,C1075,C1113 | C-CERAMIC,CHIP |
| 2203-008097 | C1117,C1131,C2002 | C-CERAMIC,CHIP |
| 2203-008097 | C2005,C2020,C2100 | C-CERAMIC,CHIP |
| 2203-008097 | C2101,C2103,C2104 | C-CERAMIC,CHIP |
| 2203-008097 | C2105,C2106,C2107 | C-CERAMIC,CHIP |
| 2203-008097 | C2108,C2109,C2110 | C-CERAMIC,CHIP |
| 2203-008097 | C2112,C2113,C2114 | C-CERAMIC,CHIP |
| 2203-008097 | C2116,C2117,C2118 | C-CERAMIC,CHIP |
| 2203-008097 | C2119,C3052,C4048 | C-CERAMIC,CHIP |
| 2203-008097 | C4049,C4090,C5049 | C-CERAMIC,CHIP |
| 2203-008097 | C6000,C6001,C6002 | C-CERAMIC,CHIP |
| 2203-008097 | C6003,C8010,C8013 | C-CERAMIC,CHIP |
| 2203-008097 | C8021,C8025,R8012 | C-CERAMIC,CHIP |
| 2203-008242 | C3092,C4050,C4051 | C-CERAMIC,CHIP |

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## 5. MAIN Electrical Parts List

|             |                   |                |
|-------------|-------------------|----------------|
| 2203-008242 | C4052,C4053,C5039 | C-CERAMIC,CHIP |
| 2203-008242 | C6016,C6017       | C-CERAMIC,CHIP |
| 2203-008529 | C3016,C3081,C6066 | C-CERAMIC,CHIP |
| 2203-008529 | C7012             | C-CERAMIC,CHIP |
| 2203-008749 | C6035             | C-CERAMIC,CHIP |
| 2203-008860 | C2072,C3000,C3086 | C-CERAMIC,CHIP |
| 2203-008860 | C5022,C5025,C5064 | C-CERAMIC,CHIP |
| 2203-008860 | C7020,C7025,C7029 | C-CERAMIC,CHIP |
| 2203-008860 | C7035,C7039,C7042 | C-CERAMIC,CHIP |
| 2203-008860 | C7043,C7080,C7082 | C-CERAMIC,CHIP |
| 2203-008860 | C7086,C8007       | C-CERAMIC,CHIP |
| 2203-008876 | C1067,C2073,C3066 | C-CERAMIC,CHIP |
| 2203-008876 | C3067,C3091,C5000 | C-CERAMIC,CHIP |
| 2203-008876 | C5007,C5009,C5013 | C-CERAMIC,CHIP |
| 2203-008876 | C5020,C5021,C5041 | C-CERAMIC,CHIP |
| 2203-008876 | C5042,C5045,C5046 | C-CERAMIC,CHIP |
| 2203-008876 | C5047,C5051,C5053 | C-CERAMIC,CHIP |
| 2203-008876 | C5056,C5058,C6010 | C-CERAMIC,CHIP |
| 2203-008876 | C6011,C7015,C7016 | C-CERAMIC,CHIP |
| 2203-008876 | C7038,C7040,C7081 | C-CERAMIC,CHIP |
| 2203-008876 | C7084             | C-CERAMIC,CHIP |
| 2203-009064 | C4005,C4018,C4019 | C-CERAMIC,CHIP |
| 2203-009064 | C4020,C4030,C4031 | C-CERAMIC,CHIP |
| 2203-009167 | C3100,C3104       | C-CERAMIC,CHIP |
| 2203-009328 | C3032             | C-CERAMIC,CHIP |
| 2203-009444 | C5018             | C-CERAMIC,CHIP |
| 2203-009618 | C5028,C5029,C7007 | C-CERAMIC,CHIP |
| 2203-009618 | C7008,C7027       | C-CERAMIC,CHIP |
| 2203-009733 | C1076,C2049,C3020 | C-CERAMIC,CHIP |
| 2203-009733 | C3022,C3907,C5001 | C-CERAMIC,CHIP |
| 2203-009733 | C5002,C5003,C5004 | C-CERAMIC,CHIP |
| 2203-009733 | C5005,C5030,C5094 | C-CERAMIC,CHIP |
| 2203-009733 | C5100,C5101,C5102 | C-CERAMIC,CHIP |
| 2203-009733 | C5103,C5104,C5105 | C-CERAMIC,CHIP |
| 2203-009733 | C5106,C5107,C7001 | C-CERAMIC,CHIP |
| 2203-009733 | C7003,C7058,C7074 | C-CERAMIC,CHIP |
| 2203-009733 | C7134             | C-CERAMIC,CHIP |
| 2203-009734 | C5055             | C-CERAMIC,CHIP |
| 2203-009735 | C4057,C4058       | C-CERAMIC,CHIP |

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## 5. MAIN Electrical Parts List

|             |                   |                |
|-------------|-------------------|----------------|
| 2203-009738 | C4003,C4999,C5008 | C-CERAMIC,CHIP |
| 2203-009738 | C5057,C6020       | C-CERAMIC,CHIP |
| 2203-009858 | C5015,C5016,C5023 | C-CERAMIC,CHIP |
| 2203-009858 | C5073,C5108,C5109 | C-CERAMIC,CHIP |
| 2203-009858 | C7026,C8003,C8006 | C-CERAMIC,CHIP |
| 2203-009859 | C7009,C7010       | C-CERAMIC,CHIP |
| 2203-009969 | C5096,C5097,C8011 | C-CERAMIC,CHIP |
| 2203-010085 | C6009,C6057       | C-CERAMIC,CHIP |
| 2703-002649 | C2024,C2122,L2065 | INDUCTOR-SMD   |
| 2703-002900 | L1005             | INDUCTOR-SMD   |
| 2703-002901 | C1024,C6060,L1021 | INDUCTOR-SMD   |
| 2703-002901 | L1071,L6001,L6005 | INDUCTOR-SMD   |
| 2703-002901 | L6006,L6008,L6009 | INDUCTOR-SMD   |
| 2703-002903 | L2010,L2071       | INDUCTOR-SMD   |
| 2703-002953 | L1033,L6000       | INDUCTOR-SMD   |
| 2703-002955 | L2016,L3022       | INDUCTOR-SMD   |
| 2703-002958 | C1034,L3004       | INDUCTOR-SMD   |
| 2703-002959 | L3916             | INDUCTOR-SMD   |
| 2703-003970 | C1035             | INDUCTOR-SMD   |
| 2703-004000 | C1098,L3020       | INDUCTOR-SMD   |
| 2703-004001 | L2014             | INDUCTOR-SMD   |
| 2703-004012 | C1018,L1008,L1059 | INDUCTOR-SMD   |
| 2703-004012 | L2036,L2050,L2055 | INDUCTOR-SMD   |
| 2703-004012 | L2076,L2081,L3013 | INDUCTOR-SMD   |
| 2703-004012 | L8018             | INDUCTOR-SMD   |
| 2703-004013 | L1009,L1023       | INDUCTOR-SMD   |
| 2703-004014 | L1006,L1024,L1074 | INDUCTOR-SMD   |
| 2703-004014 | L3008             | INDUCTOR-SMD   |
| 2703-004018 | C1029,L1002,L1031 | INDUCTOR-SMD   |
| 2703-004018 | L1057             | INDUCTOR-SMD   |
| 2703-004032 | C1005             | INDUCTOR-SMD   |
| 2703-004034 | C1040,C1115,L2009 | INDUCTOR-SMD   |
| 2703-004034 | L2067,L3014,L3017 | INDUCTOR-SMD   |
| 2703-004034 | L3023             | INDUCTOR-SMD   |
| 2703-004035 | C1010             | INDUCTOR-SMD   |
| 2703-004036 | L1063,L2003,L2008 | INDUCTOR-SMD   |
| 2703-004038 | L1028,L1038,L2002 | INDUCTOR-SMD   |
| 2703-004038 | L2006,L2021,L2022 | INDUCTOR-SMD   |
| 2703-004038 | L2051,L2066,L2068 | INDUCTOR-SMD   |



## 5. MAIN Electrical Parts List

|             |                   |              |
|-------------|-------------------|--------------|
| 2703-004259 | L2035,L2059       | INDUCTOR-SMD |
| 2703-004286 | C2004,L1077,L2007 | INDUCTOR-SMD |
| 2703-004286 | L2029,L2047,L2056 | INDUCTOR-SMD |
| 2703-004286 | L3005             | INDUCTOR-SMD |
| 2703-004287 | L1058,L1072,L2042 | INDUCTOR-SMD |
| 2703-004287 | L2072,L3018,L3019 | INDUCTOR-SMD |
| 2703-004288 | L1022,L2038,L2077 | INDUCTOR-SMD |
| 2703-004288 | L2078             | INDUCTOR-SMD |
| 2703-004290 | C1001             | INDUCTOR-SMD |
| 2703-004300 | L3000             | INDUCTOR-SMD |
| 2703-004301 | L3015             | INDUCTOR-SMD |
| 2703-004302 | L1060             | INDUCTOR-SMD |
| 2703-004317 | L2045             | INDUCTOR-SMD |
| 2703-004328 | C1041,C1043,L2084 | INDUCTOR-SMD |
| 2703-004328 | L3006             | INDUCTOR-SMD |
| 2703-004363 | L2018             | INDUCTOR-SMD |
| 2703-004408 | C1110             | INDUCTOR-SMD |
| 2703-004703 | L2013             | INDUCTOR-SMD |
| 2703-004763 | L2082             | INDUCTOR-SMD |
| 2703-004862 | L1052,L2049,L2080 | INDUCTOR-SMD |
| 2703-004911 | L3012             | INDUCTOR-SMD |
| 2703-004976 | L2070,U8065       | INDUCTOR-SMD |
| 2703-005066 | L5012,L5013,L5014 | INDUCTOR-SMD |
| 2703-005085 | C2063,L2026,L2046 | INDUCTOR-SMD |
| 2703-005085 | L2063             | INDUCTOR-SMD |
| 2703-005087 | L1056,L3026       | INDUCTOR-SMD |
| 2703-005089 | C1119             | INDUCTOR-SMD |
| 2703-005098 | C1116,L2025       | INDUCTOR-SMD |
| 2703-005101 | L2039             | INDUCTOR-SMD |
| 2703-005295 | C1025,C1105,C2047 | INDUCTOR-SMD |
| 2703-005295 | L2011,L2074       | INDUCTOR-SMD |
| 2703-005296 | L1030,L1041,L3011 | INDUCTOR-SMD |
| 2703-005418 | L7016             | INDUCTOR-SMD |
| 2703-005419 | L7005             | INDUCTOR-SMD |
| 2703-005428 | L7004             | INDUCTOR-SMD |
| 2703-005505 | L8001             | INDUCTOR-SMD |
| 2703-005555 | L3021,U8056       | INDUCTOR-SMD |
| 2703-005581 | L5002,L5006,L5008 | INDUCTOR-SMD |
| 2703-005581 | L6002             | INDUCTOR-SMD |

## 5. MAIN Electrical Parts List

|             |                   |                   |
|-------------|-------------------|-------------------|
| 2703-005614 | L1053             | INDUCTOR-SMD      |
| 2703-005660 | L5001,L5003,L5004 | INDUCTOR-SMD      |
| 2703-005660 | L5005,L5007,L5009 | INDUCTOR-SMD      |
| 2703-005660 | L5011             | INDUCTOR-SMD      |
| 2801-005495 | OSC5000           | CRYSTAL-UNIT      |
| 2901-001690 | C4056             | FILTER-EMI SMD    |
| 2901-001798 | F7010,F7011,F7012 | FILTER-EMI SMD    |
| 2901-001798 | F7013,F7014       | FILTER-EMI SMD    |
| 2903-001576 | F3000,F3004       | FILTER-CERAMIC    |
| 2904-002134 | F1009             | FILTER-SAW        |
| 2904-002143 | F2008             | FILTER-SAW        |
| 2904-002190 | F1004             | FILTER-SAW        |
| 2904-002198 | F2001             | FILTER-SAW        |
| 2904-002326 | F2006             | FILTER-SAW        |
| 2904-002339 | F2002             | FILTER-SAW        |
| 2904-002350 | F2010             | FILTER-SAW        |
| 2904-002356 | F3003             | FILTER-SAW        |
| 2904-002361 | F2004             | FILTER-SAW        |
| 2904-002390 | F3005,F3006       | FILTER-SAW        |
| 2904-002397 | F2000,F2003       | FILTER-SAW        |
| 2910-000364 | F1006             | FILTER            |
| 2910-000390 | F2007             | FILTER            |
| 2910-000402 | F1005             | FILTER            |
| 2910-000404 | F1010             | FILTER            |
| 2911-000430 | U2031             | FILTER            |
| 2911-000452 | F1000             | FILTER            |
| 3003-001210 | MIC1000           | MIC-CONDENSOR     |
| 3301-001885 | L8000,L8006       | CORE-FERRITE BEAD |
| 3301-002085 | L6003,L6004,L8002 | CORE-FERRITE BEAD |
| 3301-002085 | L8003,L8004,L8005 | CORE-FERRITE BEAD |
| 3301-002122 | L8016,L8017       | CORE-FERRITE BEAD |
| 3301-002223 | L7000,L7001,L7008 | CORE-FERRITE BEAD |
| 3301-002223 | L7012,L7013       | CORE-FERRITE BEAD |
| 3301-002237 | L1000,L8008       | CORE-FERRITE BEAD |
| 3301-002238 | L3010             | CORE-FERRITE BEAD |
| 3301-002312 | L5010,L7002,L7003 | CORE-FERRITE BEAD |
| 3301-002312 | L7017             | CORE-FERRITE BEAD |
| 3301-002331 | L5000,L6007       | CORE-FERRITE BEAD |
| 3404-001567 | SW6000            | SWITCH-TACT       |

## 5. MAIN Electrical Parts List

|             |                 |                     |
|-------------|-----------------|---------------------|
| 3705-001937 | RFS1000,RFS1001 | CONNECTOR-COAXIAL   |
| 3709-001932 | SIM4UP          | CONNECTOR-CARD EDGE |
| 3709-001933 | SIM1            | CONNECTOR-CARD EDGE |
| 3709-001934 | SIM2,SIM3       | CONNECTOR-CARD EDGE |
| 3711-007107 | HEA7000         | CONNECTOR-HEADER    |
| 3711-008508 | HDC7000,HDC7001 | CONNECTOR-HEADER    |
| 3711-008511 | HEA7003         | CONNECTOR-HEADER    |
| 3711-008593 | HEA7001         | CONNECTOR-HEADER    |
| 3711-008847 | HDC5000         | CONNECTOR-HEADER    |
| 3711-008931 | HEA7004         | CONNECTOR-HEADER    |
| 3711-008997 | HDC3001,HEA3000 | CONNECTOR-HEADER    |
| 3711-009073 | HEA6000         | CONNECTOR-HEADER    |
| 3712-001604 | ANT3003,ANT3004 | CONNECTOR           |
| 3712-001626 | ANT2001,ANT2002 | CONNECTOR           |
| 3712-001626 | ANT2005,ANT2007 | CONNECTOR           |
| 3712-001626 | ANT2008,ANT2009 | CONNECTOR           |
| 3712-001626 | ANT3001,ANT3005 | CONNECTOR           |
| 3712-001626 | ANT3016,CON6003 | CONNECTOR           |
| 3712-001633 | ANT1007,ANT2003 | CONNECTOR           |
| 3712-001633 | ANT3015         | CONNECTOR           |
| 3712-001634 | ANT8003,ANT8004 | CONNECTOR           |
| 3712-001694 | ANT3014,ANT3017 | CONNECTOR           |
| 3712-001694 | ANT6000,ANT6001 | CONNECTOR           |
| 3712-001694 | ANT8001,ANT8002 | CONNECTOR           |
| 4709-002226 | F1007           | RF-MODULE           |
| 4709-002285 | DIF3000,DIF3001 | RF-MODULE           |
| 4709-002484 | U2002           | RF-MODULE           |
| 4709-002589 | F1001,F1003     | RF-MODULE           |
| GH60-00010A | CON6004         | CLIP                |
| GH61-10712A | SUS6000,SUS6001 | SUS                 |
| GH62-00048A | CON6000         | GASKET              |
| GH63-12632A | SC6006          | SHIELD-CAN          |
| GH63-15682A | SC6002          | SHIELD-CAN          |
| GH63-16351A | SC6001          | SHIELD-CAN          |
| GH63-16352A | SC6005          | SHIELD-CAN          |
| GH63-16353A | SC6003          | SHIELD-CAN          |
| GH63-16354A | SC6007          | SHIELD-CAN          |
| GH63-16355A | SC6004          | SHIELD-CAN          |
| GH63-16356A | SC6008          | SHIELD-CAN          |

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## 5. MAIN Electrical Parts List

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|             |          |            |
|-------------|----------|------------|
| GH63-16357A | SC6000   | SHIELD-CAN |
| GH02-17416A | SC6003SP | TAPE       |
| GH02-16575A | SC6002SP | TAPE       |

Please consult the GSPN website (Samsung Portal) for the most recent version of the product's part list.

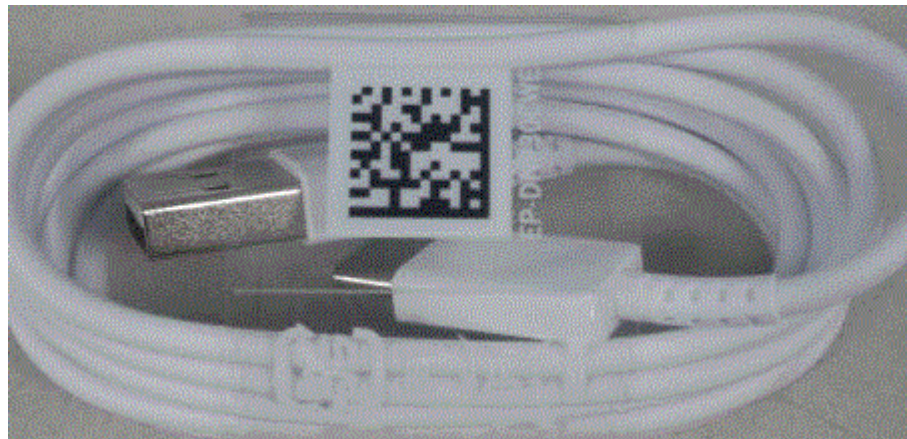
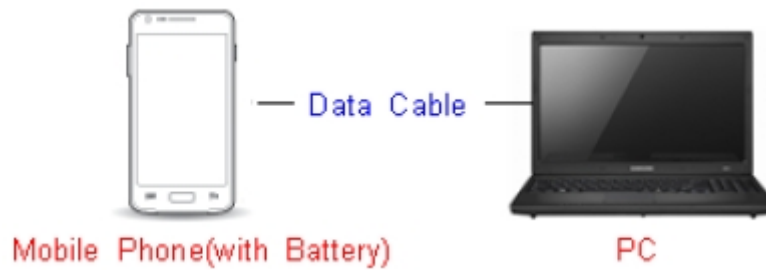
## 6. Level 1 Repair

### 6-1. S/W Update

#### 6-1-1. Preparation

- S/W Update program : [Fenrir 5.17.xxxx](#)
- Mobile Phone
- Data Cable

#### ※ Settings

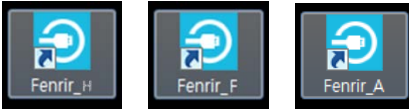


Data Cable : [GH39-01949A](#)

## 6. Level 1 Repair

### 6-1-2. How to use 'Fenrir' S/W update program.

1) Launch Fenrir by clicking on the icon on the desktop



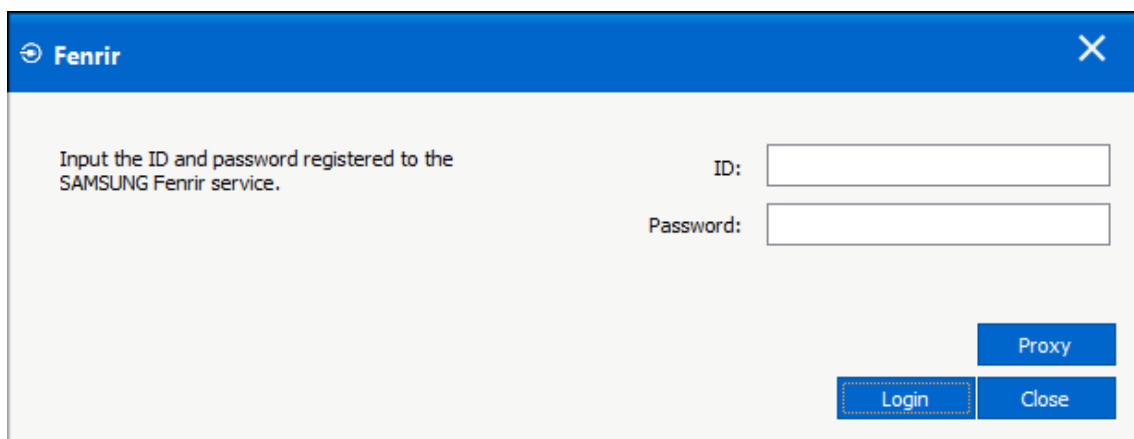
- SVH (Fenrir\_Home) : It uses Home binary which does not have user data area in the memory when flashed to a device. (Keep user data)

- SVC (Fenrir\_Factory) : It uses Factory binary which erases all user data in the memory when flashed to a device. (Clear user data)

- SVA (Fenrir\_All) : It uses Factory and Home binaries. you can download Home and Factory binary in a PC (but requires double HDD storage and NW traffic)

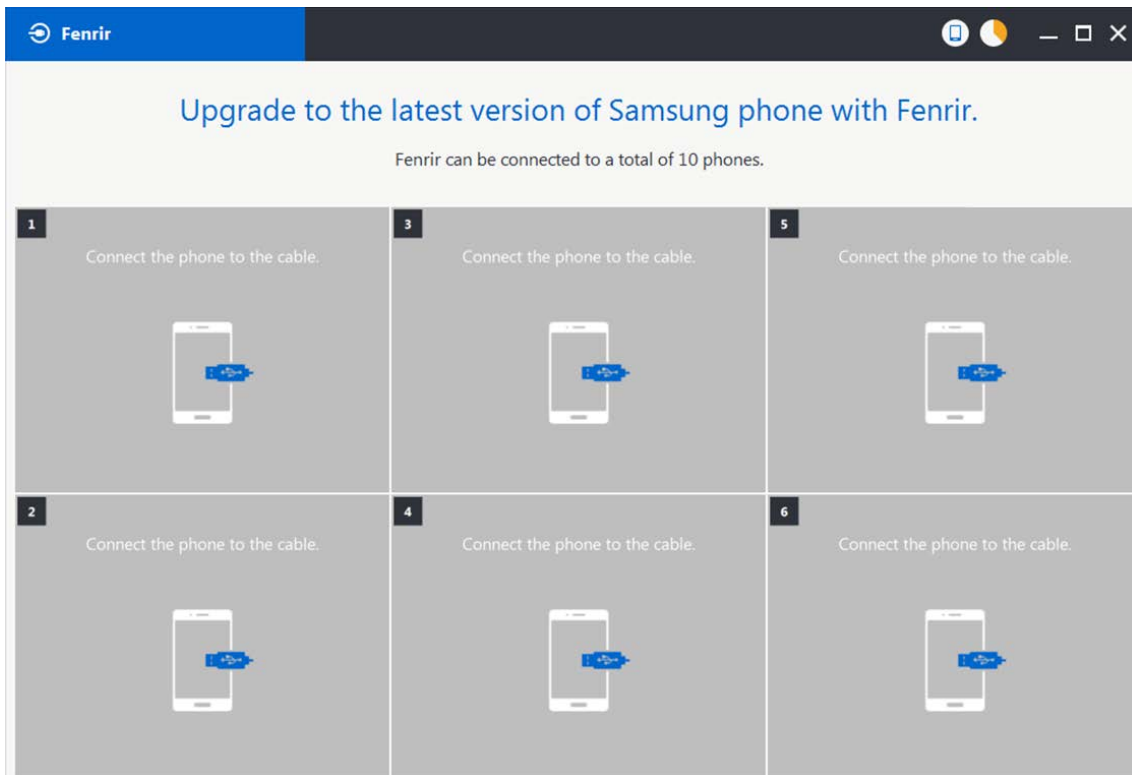
2) Input ID & password

※ You need to reset the ID information in case of PC change and format and repair, hard disk change

A screenshot of the Fenrir software login window. The window has a blue title bar with the 'Fenrir' logo and a close button. The main area is light gray and contains the text: 'Input the ID and password registered to the SAMSUNG Fenrir service.' Below this text are two input fields: 'ID:' and 'Password:'. At the bottom right, there are three buttons: 'Proxy', 'Login', and 'Close'. The 'Login' button is highlighted with a dashed border.

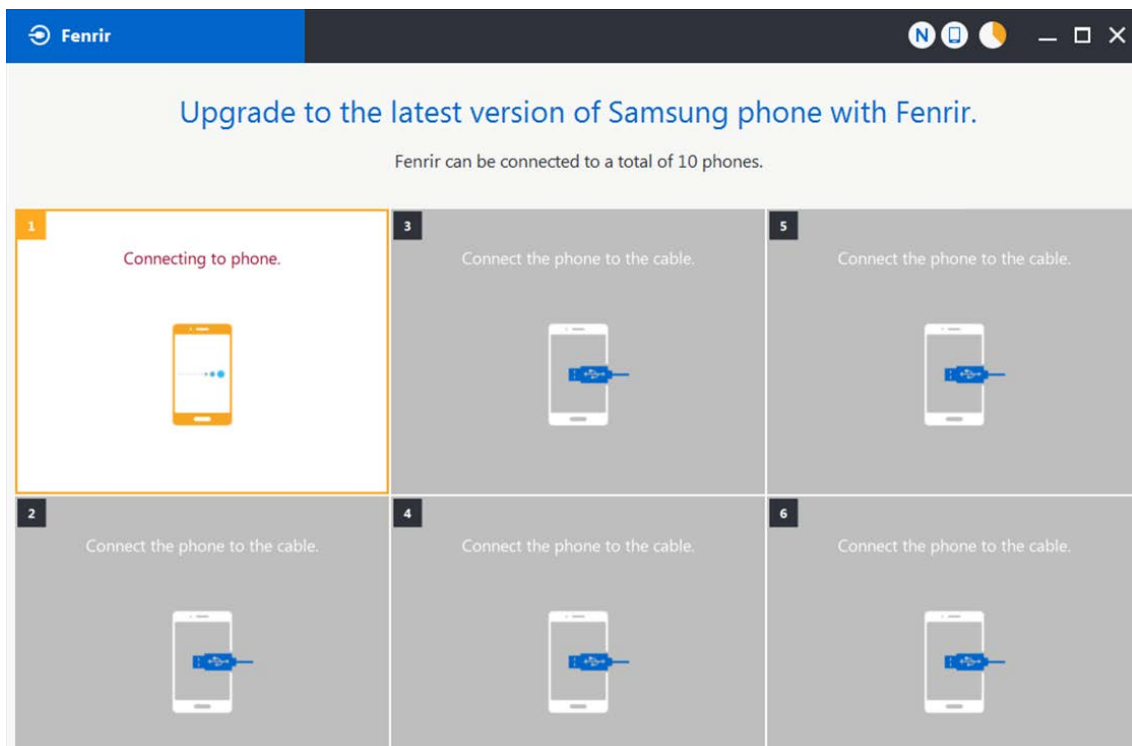
## 6. Level 1 Repair

3) Ensure device has sufficient charge (at least 20%) to start firmware update.



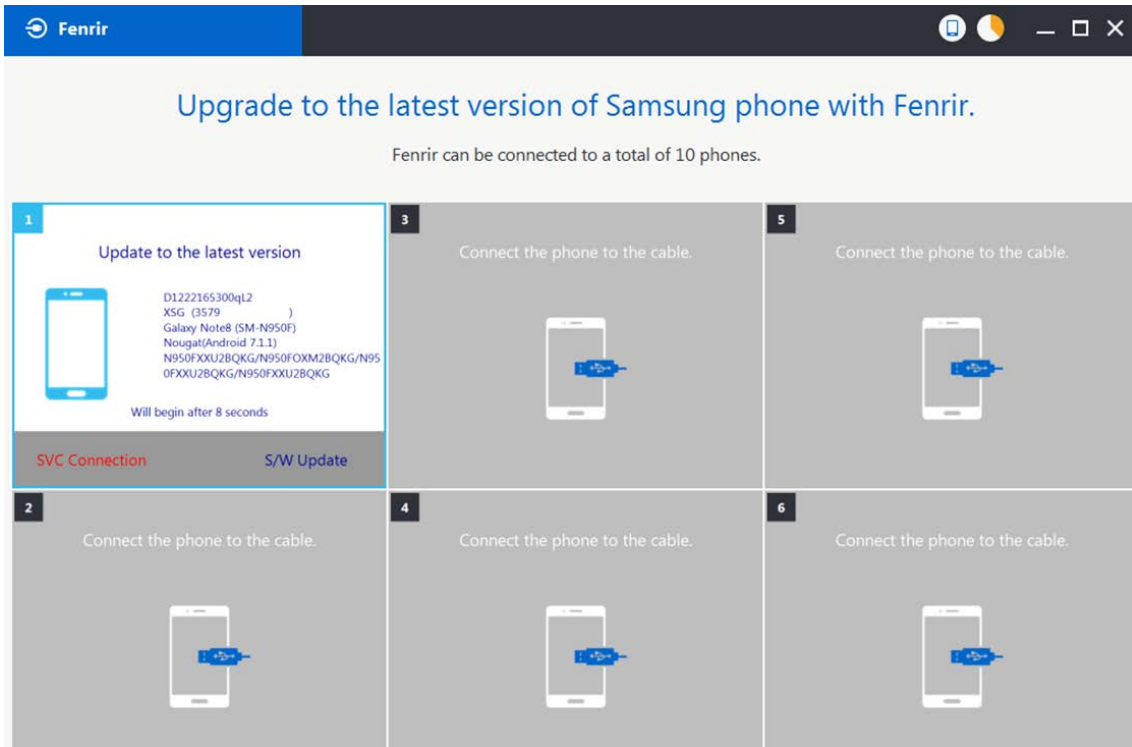
4) Connect the device to PC via data cable.

5) Upon USB connection, you will be presented with below screen.

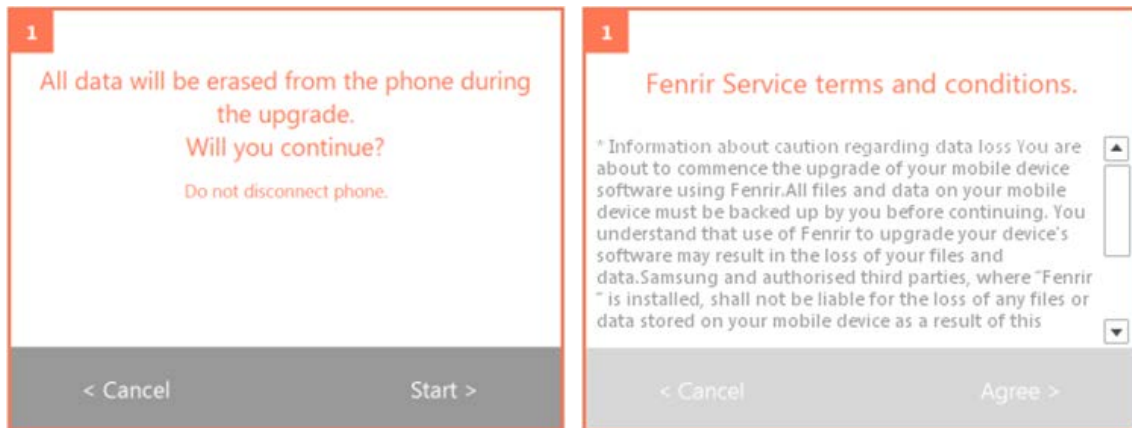


## 6. Level 1 Repair

6) Once device is detected, you will be presented with below screen. To update S/W, select “S/W Update” or to exit select “SVC Connection”. If you select “SVC Connection”, only Fenrir connection history (record) will be stored in the FUS server to support warranty validation. (This is known as “Service Connection” history)



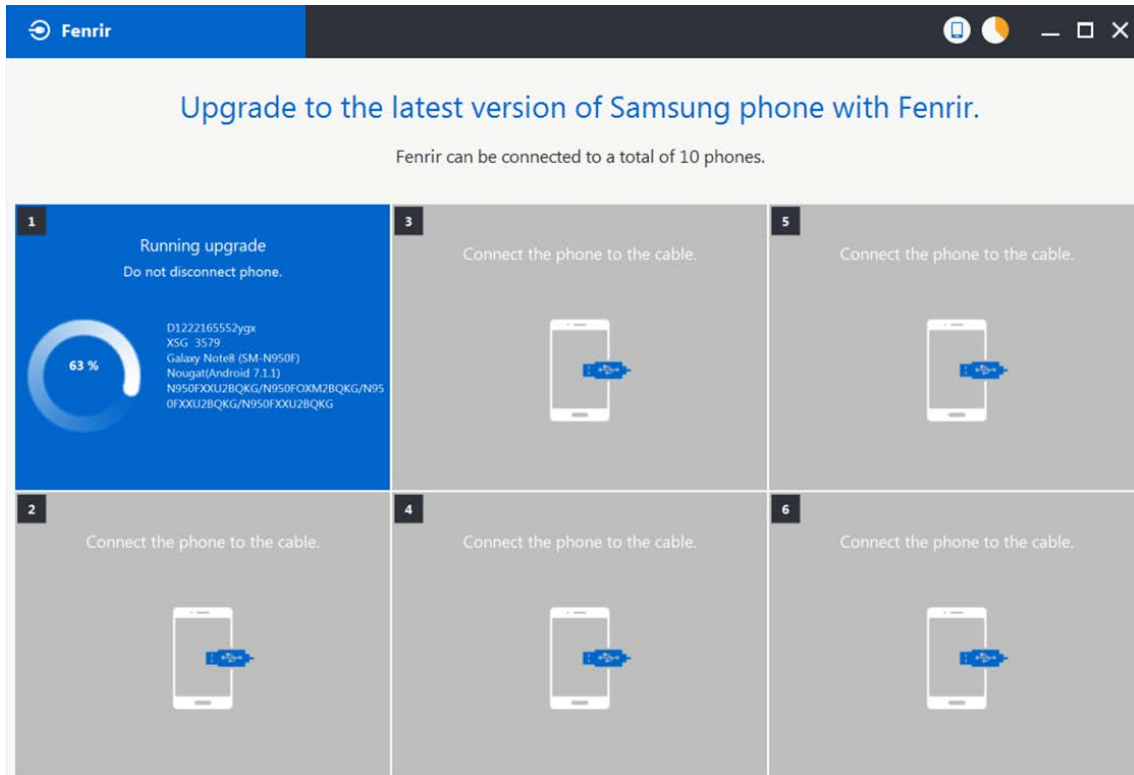
7) Once Fenrir starts, application will display the below screen. And select the Start button & Agree button.



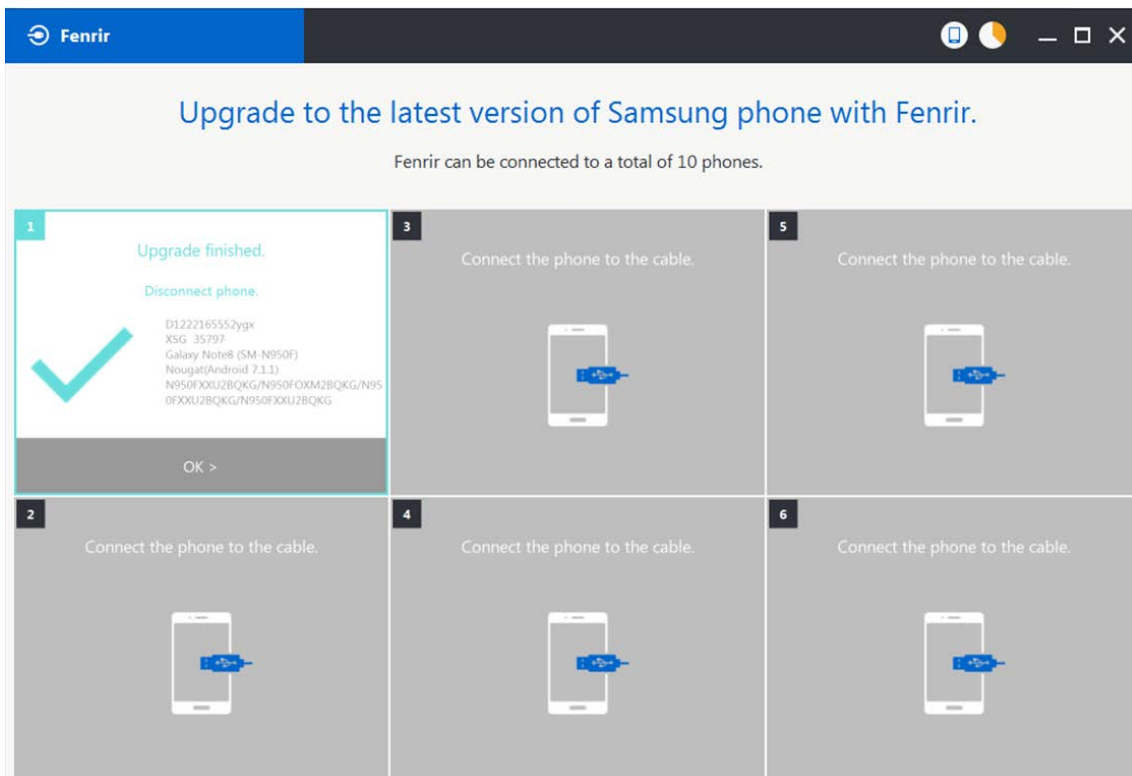


## 6. Level 1 Repair

8) The status circle increases as the update installs. The update process takes approximately 5-10 minutes to complete. Do not disconnect the device from USB during processing.



9) Once complete, application will present the below screen indicating update complete. Click Ok and detach device from USB.



## 6. Level 1 Repair

### 6-2. How to use 'Odin' program

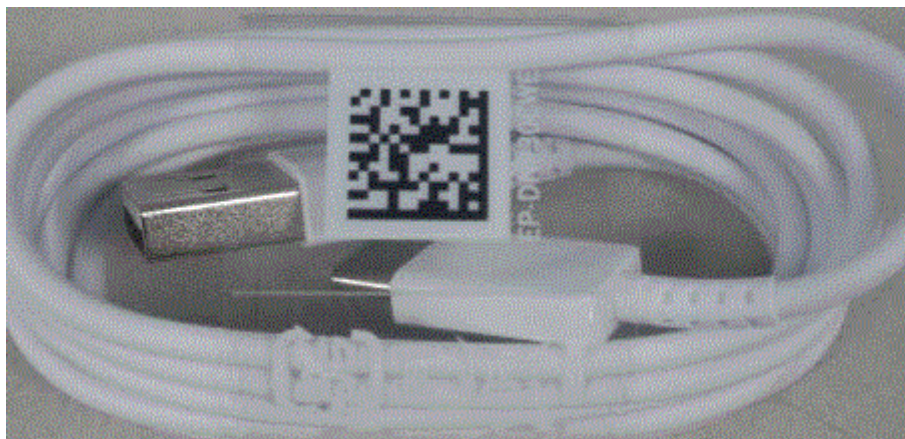
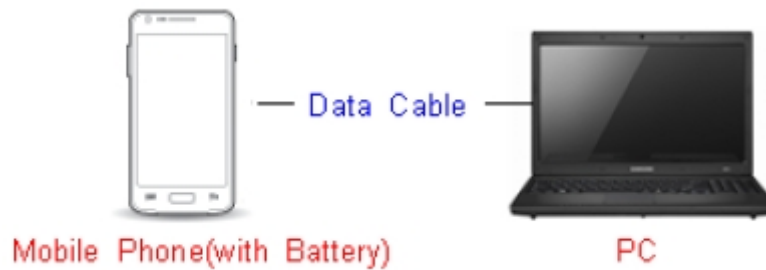
※ S/W Update via Fenrir is mandatory.

Below is the method to use 'Odin' program in any specific case.

#### 6-2-1. Preparation

- Installation program : [Odin3 v3.13.2.exe or above](#)
- Mobile Phone
- Data Cable
- S/W Binary files (downloaded from GSPN)

#### ※ Settings

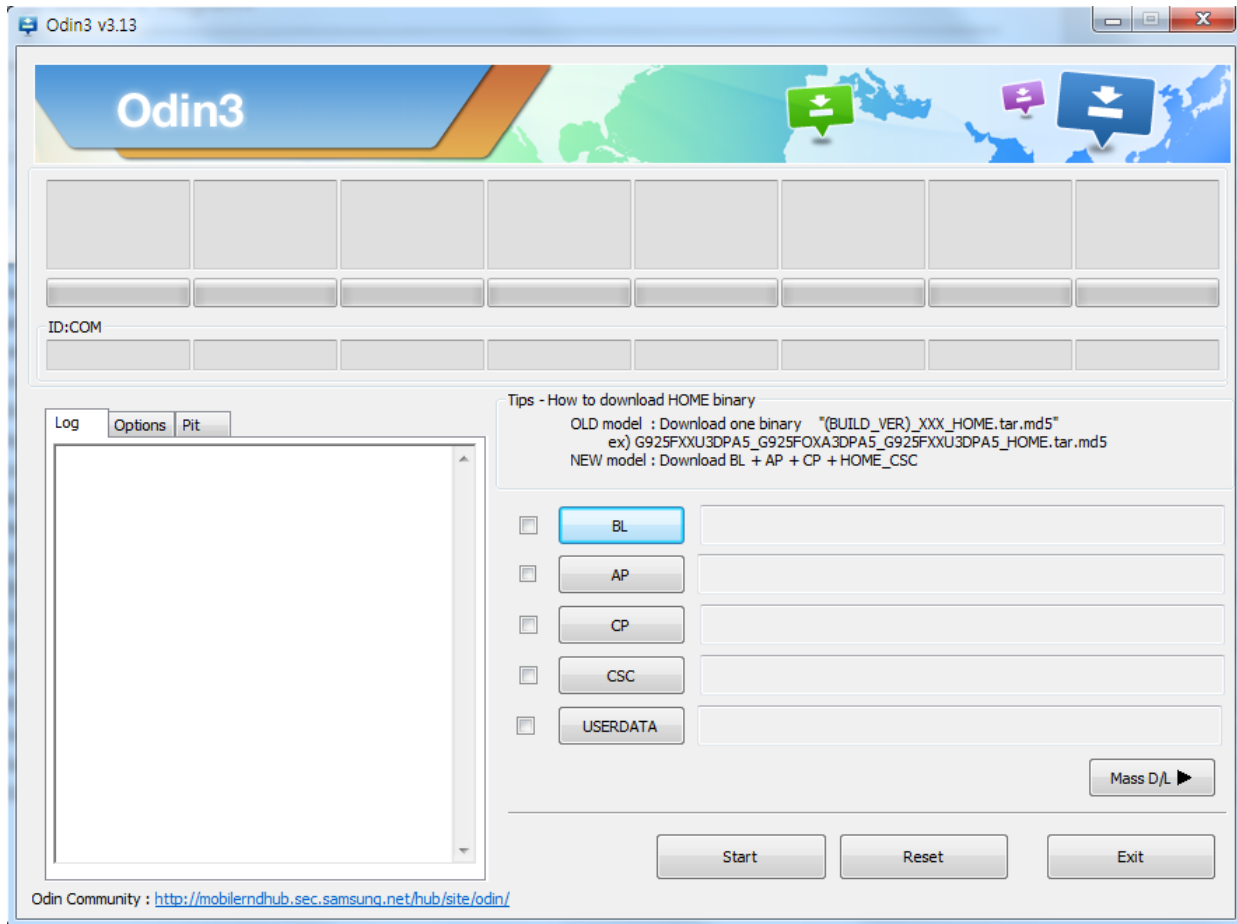


Data Cable : [GH39-01949A](#)

## 6. Level 1 Repair

### 6-2-2. S/W Installation Program (Downloader program)

Open up the S/W Installation Program by executing the "**Odin3 v3.13.2.exe**"

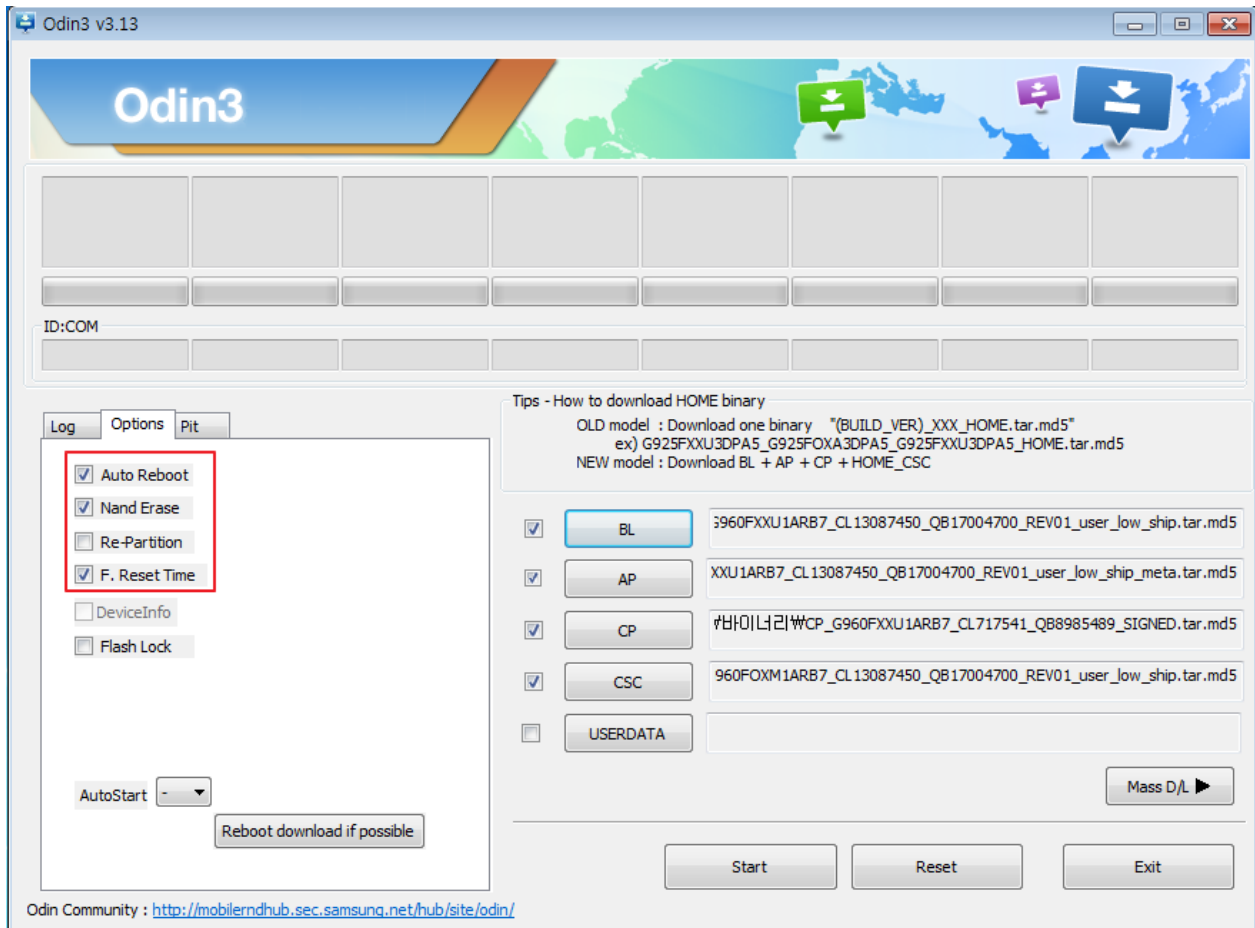


## 6. Level 1 Repair

1. Enable the check mark by click on the following options

- Check Auto Reboot, F. Reset Time, Nand Erase
- Check BL, AP, CP, CSC Files

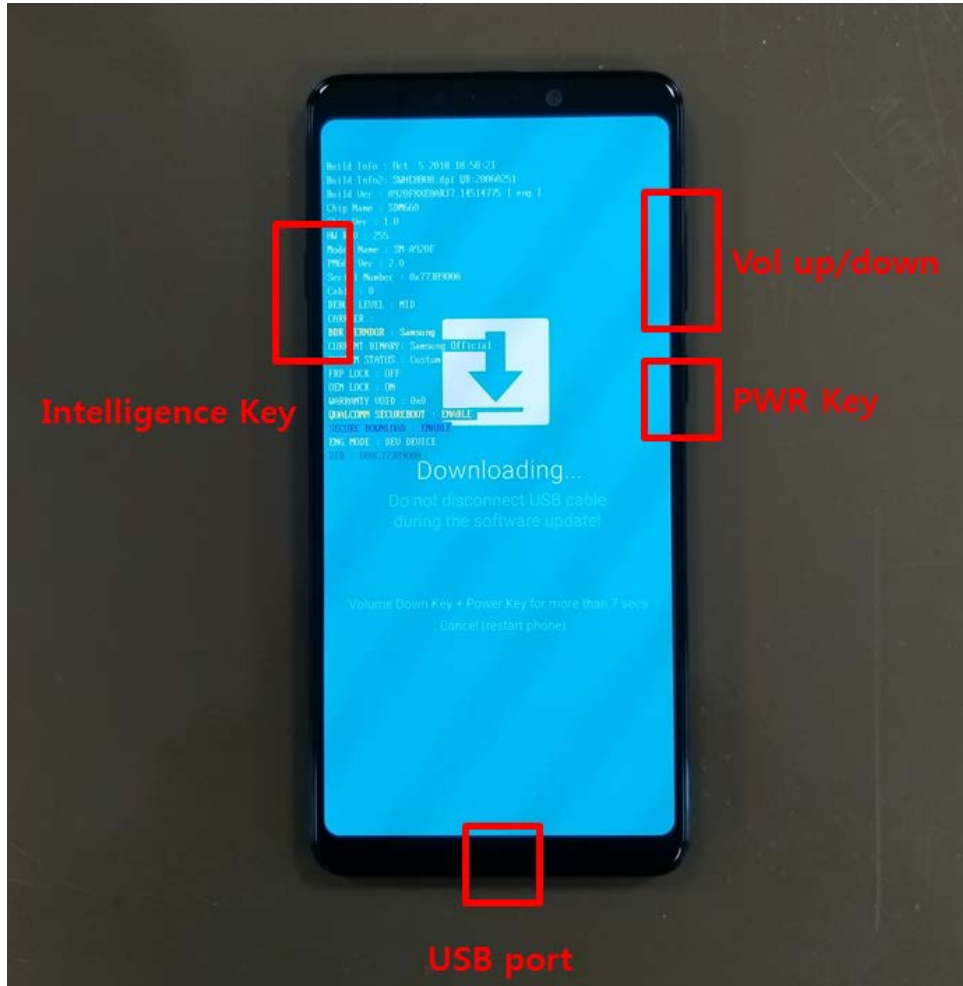
\* Note : "Odin v3.13.2 or above" checks MD5 checksum just after file selection.



## 6. Level 1 Repair

### 2. Enter into Download Mode

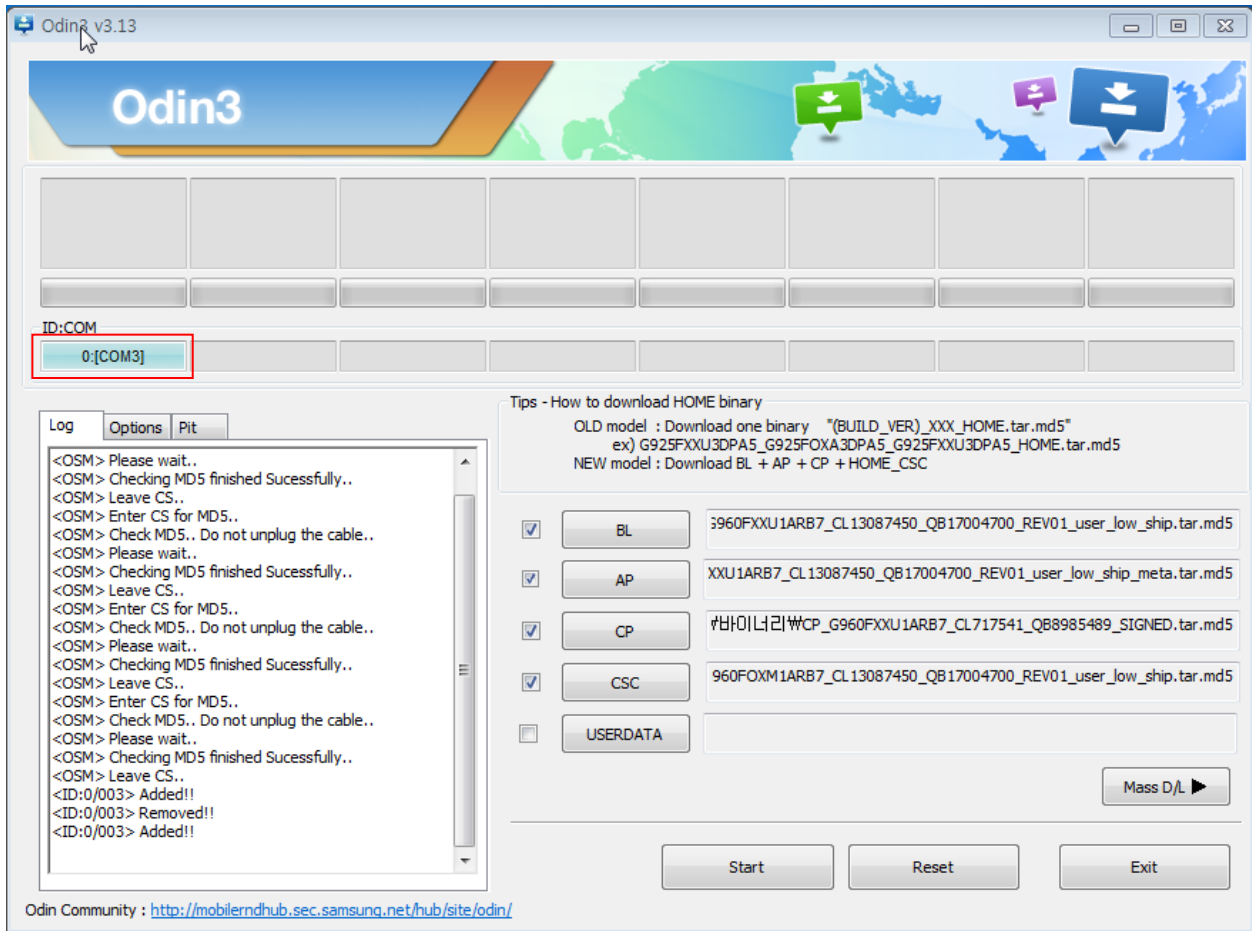
- Enter into Download Mode by pressing Volume Down button, Intelligence button and connecting USB cable
- Press Volume Up button to download mode.



## 6. Level 1 Repair

### 3. Connect the device to PC via Data Cable.

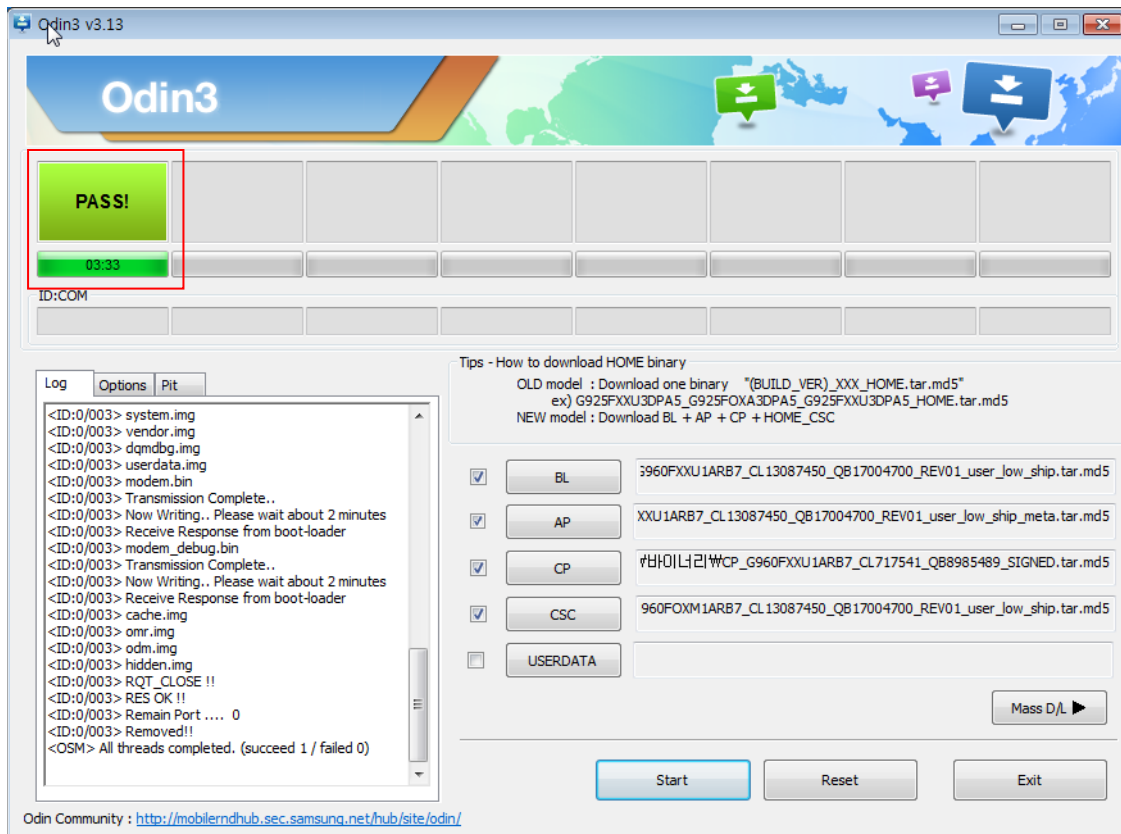
Make sure that the one of communication ports [ID:COM] box is highlighted in sky blue. The device is now connected with the PC and ready to download the binary files in it.



## 6. Level 1 Repair

4. Start downloading the binary files into the device by clicking Start button on the screen.

The green colored "PASS!" sign will appear on the upper-left box if the binary files have been successfully downloaded into the device.



5. Disconnect the device from the Data cable.

6. Once the device boots up, you can check the version of the binary file or name by pressing the following code in sequence; **\*#1234#**

You can perform Factory data Reset by Settings → General Management → Reset

**※ Caution. Never disconnect during the S/W downloading.**

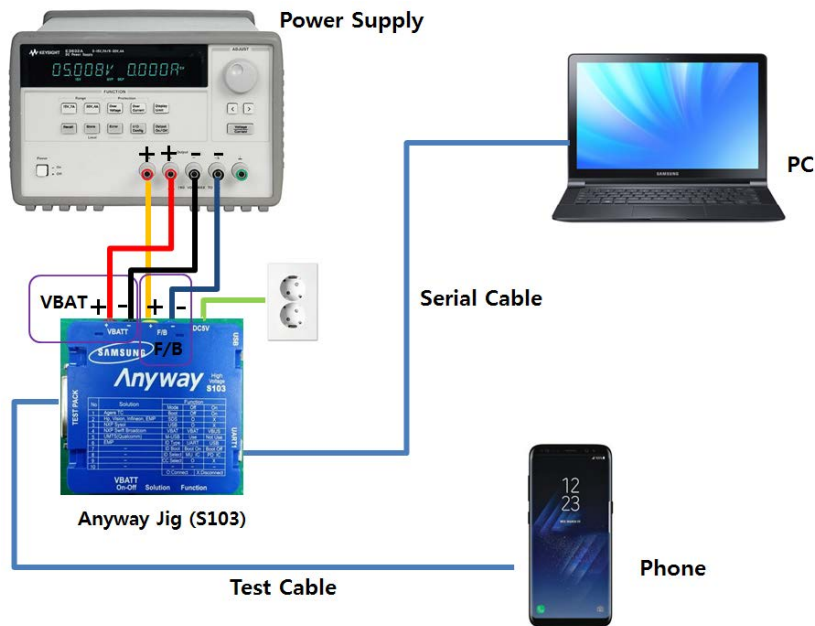
## 6. Level 1 Repair

### 6-3. IMEI writing

#### 6-3-1. Preparation

- New IMEI writing Program has been released.
- Supported Model : Models which CAB files are uploaded on HHPsvc INI File category, instead of ini file.
- Refer to below IMEI writing procedure.

#### - H/W



#### - S/W


|                   |                                                                                                                                                                                     |
|-------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| ① Library Install | To use Daseul, library files should be installed.<br>Refer to SVC Bulletin<br>“(11-82) Daseul (New IMEI writing Program) Library Install guide_rev1.0”                              |
| ② Launcher        | <b>DASEUL_Launcher_v4.0.0</b> or higher<br>-Uploaded on HHPsvc Notice                                                                                                               |
| ③ Runtime File    | 1. <b>DASEUL_IMEI_ALL_Runtime_3.1.386.0_r00573.CAB</b> or higher<br>-Uploaded on HHPsvc Notice<br>2. Make ‘ModelName’ folder at the same position with launcher & Runtime file.<br> |
| ④ Model File      | Copy Model File under the ‘SM-A920F’ folder                                                                                                                                         |



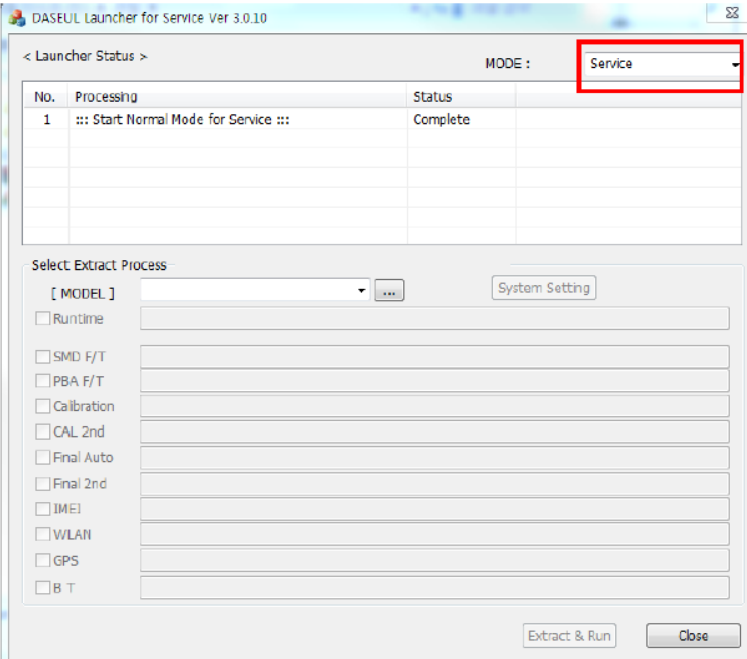
## 6. Level 1 Repair

### 6-3-2. IMEI writing Process

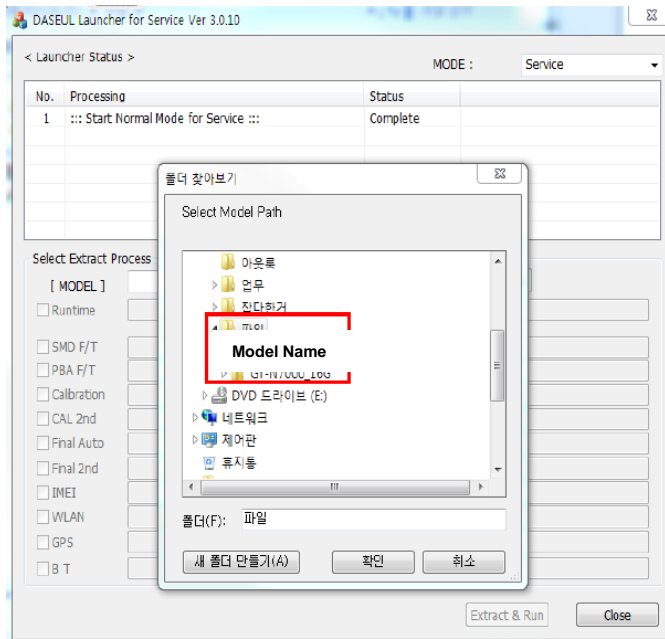
#### 1. Run DASEUL\_Launcher\_v4.0.0

 DASEUL\_Launcher\_v4.0.0.exe

#### 2. Select Service Mode

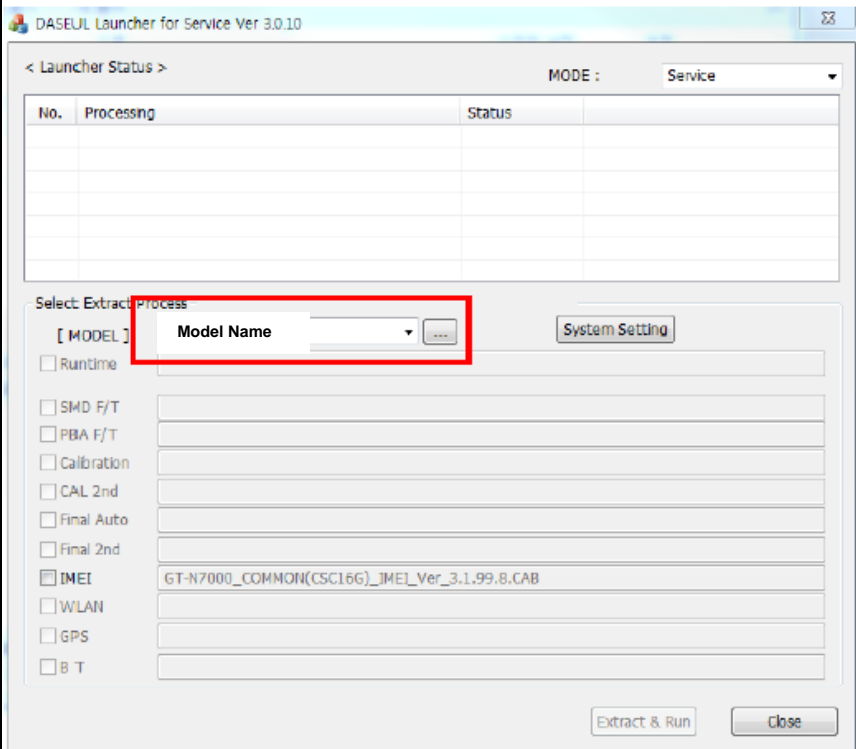


#### 3. Click and Select folder where the Launcher exists



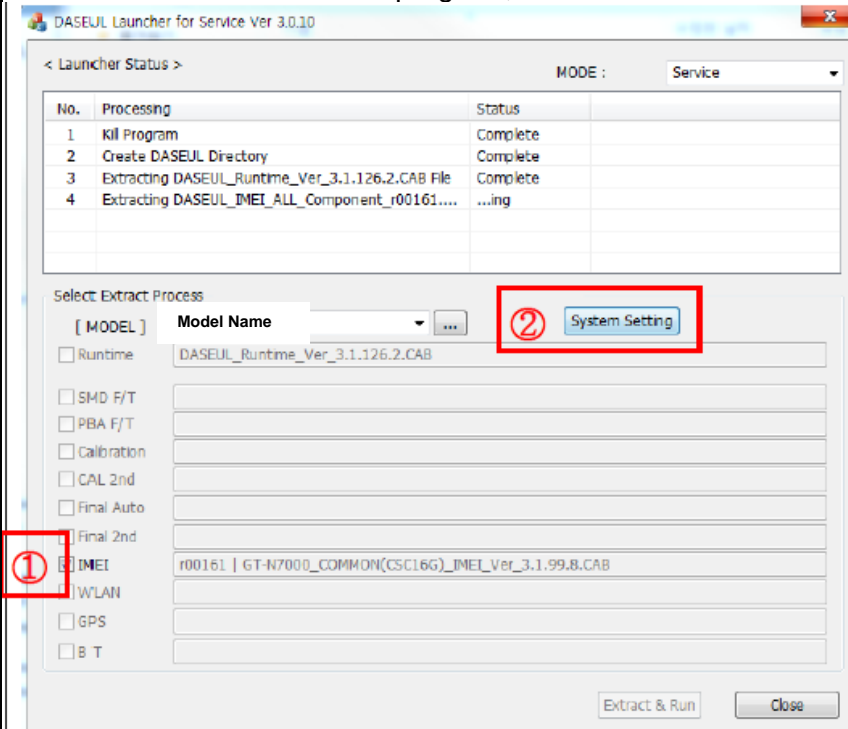
## 6. Level 1 Repair

### 4. Select Model



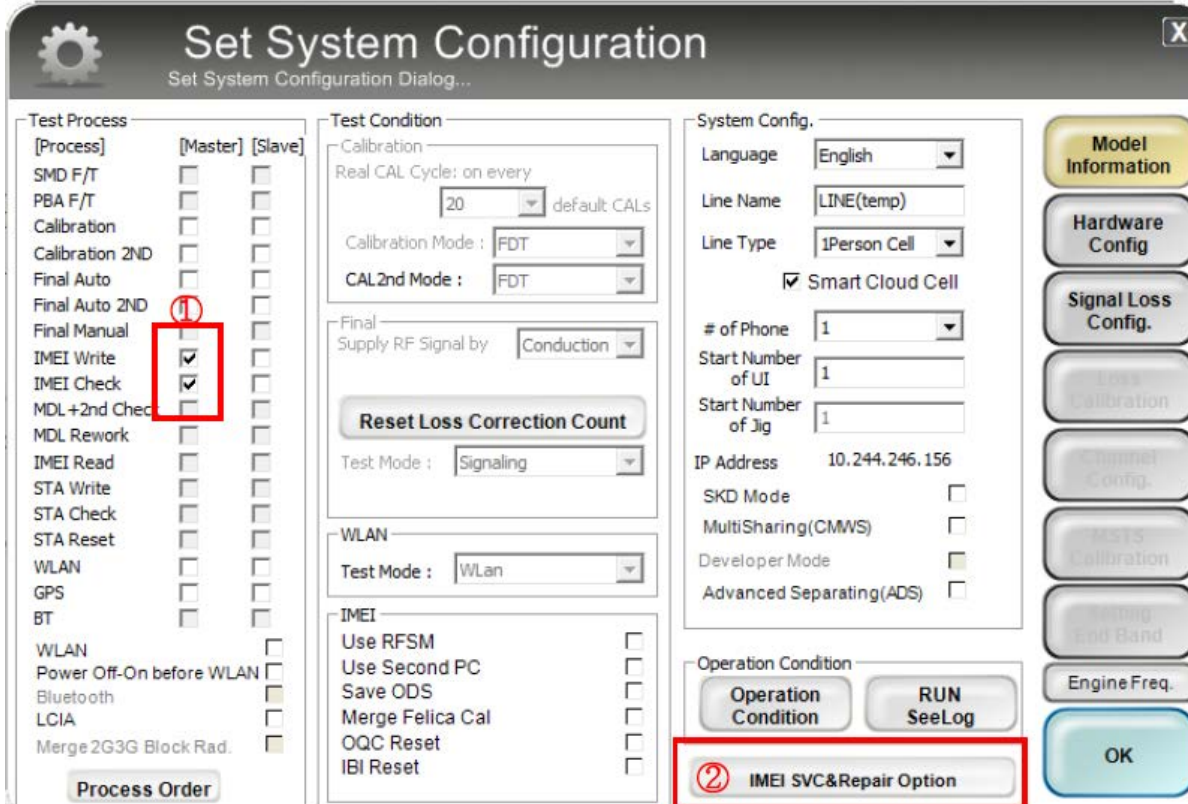
### 5. Check IMEI and click System Setting

※ Once you setup the setting, you don't have to do it again, unless there is change. From second run of the IMEI program, check IMEI and click Extract & Run.



## 6. Level 1 Repair

6. Check IMEI Write / IMEI Check and click IMEI SVC & Repair Option.



**Set System Configuration**  
Set System Configuration Dialog...

**Test Process**

| [Process]                | [Master]                            | [Slave]                  |
|--------------------------|-------------------------------------|--------------------------|
| SMD F/T                  | <input type="checkbox"/>            | <input type="checkbox"/> |
| PBA F/T                  | <input type="checkbox"/>            | <input type="checkbox"/> |
| Calibration              | <input type="checkbox"/>            | <input type="checkbox"/> |
| Calibration 2ND          | <input type="checkbox"/>            | <input type="checkbox"/> |
| Final Auto               | <input type="checkbox"/>            | <input type="checkbox"/> |
| Final Auto 2ND           | <input type="checkbox"/>            | <input type="checkbox"/> |
| Final Manual             | <input type="checkbox"/>            | <input type="checkbox"/> |
| IMEI Write               | <input checked="" type="checkbox"/> | <input type="checkbox"/> |
| IMEI Check               | <input checked="" type="checkbox"/> | <input type="checkbox"/> |
| MDL +2nd Check           | <input type="checkbox"/>            | <input type="checkbox"/> |
| MDL Rework               | <input type="checkbox"/>            | <input type="checkbox"/> |
| IMEI Read                | <input type="checkbox"/>            | <input type="checkbox"/> |
| STA Write                | <input type="checkbox"/>            | <input type="checkbox"/> |
| STA Check                | <input type="checkbox"/>            | <input type="checkbox"/> |
| STA Reset                | <input type="checkbox"/>            | <input type="checkbox"/> |
| WLAN                     | <input type="checkbox"/>            | <input type="checkbox"/> |
| GPS                      | <input type="checkbox"/>            | <input type="checkbox"/> |
| BT                       | <input type="checkbox"/>            | <input type="checkbox"/> |
| WLAN                     | <input type="checkbox"/>            | <input type="checkbox"/> |
| Power Off-On before WLAN | <input type="checkbox"/>            | <input type="checkbox"/> |
| Bluetooth                | <input type="checkbox"/>            | <input type="checkbox"/> |
| LCIA                     | <input type="checkbox"/>            | <input type="checkbox"/> |
| Merge 2G3G Block Rad.    | <input type="checkbox"/>            | <input type="checkbox"/> |

**Test Condition**

Calibration  
Real CAL Cycle: on every 20 default CALs  
Calibration Mode: FDT  
CAL2nd Mode: FDT

Final  
Supply RF Signal by: Conduction

**Reset Loss Correction Count**

Test Mode: Signaling

WLAN  
Test Mode: WLAN

IMEI  
Use RFSM   
Use Second PC   
Save ODS   
Merge Felica Cal   
OQC Reset   
IBI Reset

**System Config.**

Language: English  
Line Name: LINE(temp)  
Line Type: 1Person Cell  
 Smart Cloud Cell  
# of Phone: 1  
Start Number of UI: 1  
Start Number of Jig: 1  
IP Address: 10.244.246.156  
SKD Mode   
MultiSharing(CMWS)   
Developer Mode   
Advanced Separating(ADS)

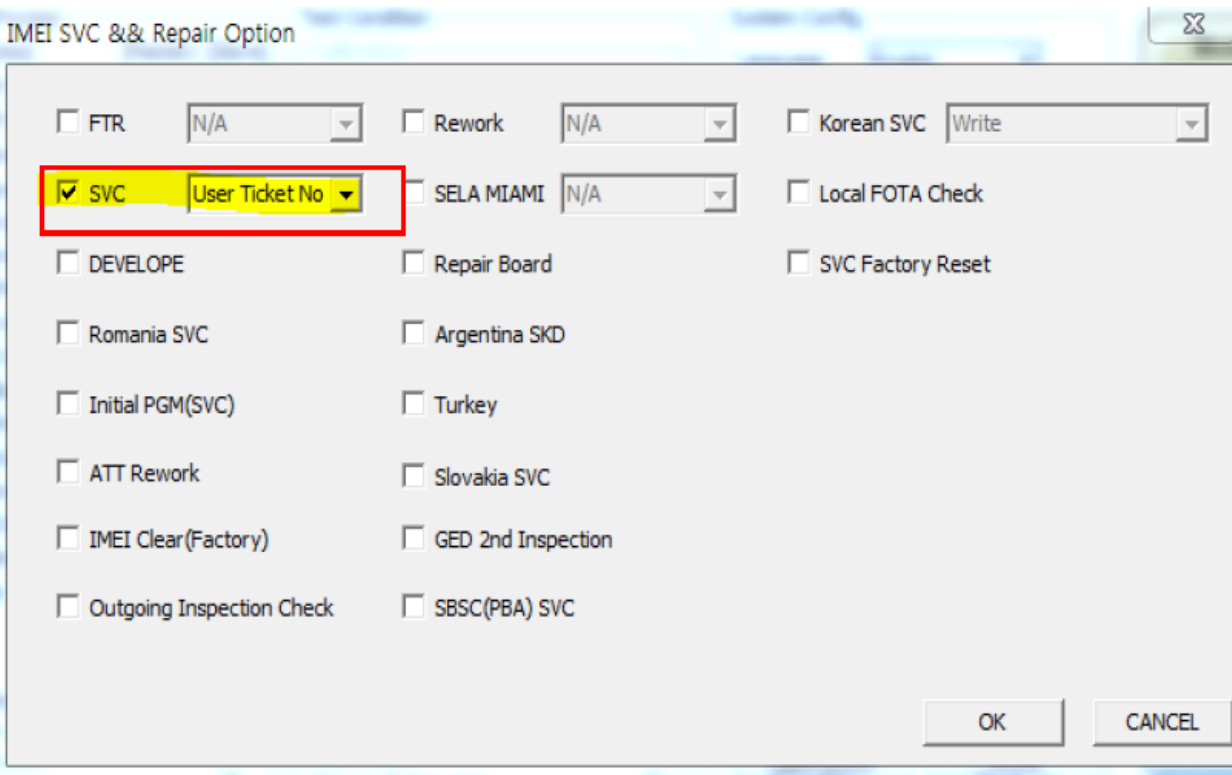
**Operation Condition**

Operation Condition

**IMEI SVC&Repair Option**

**Model Information**  
**Hardware Config**  
**Signal Loss Config.**  
Loss Calibration  
Signal Config.  
MMS Calibration  
Setting End Band  
Engine Freq.  
**OK**

7. Check 'SVC , User Ticket No' and click OK



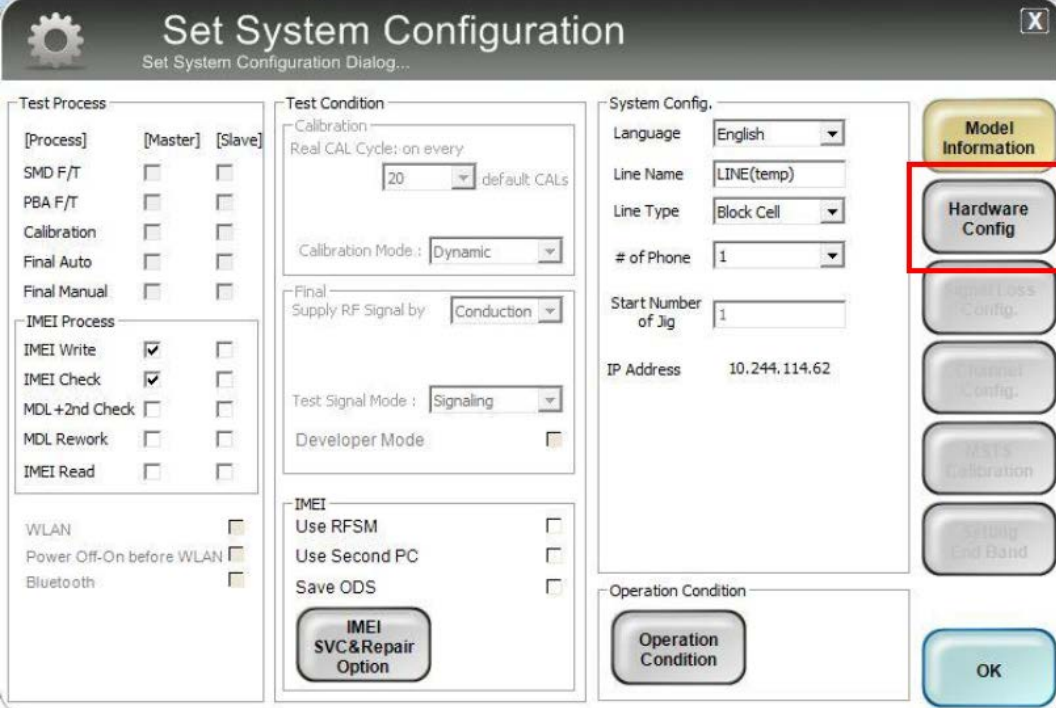
**IMEI SVC && Repair Option**

FTR N/A  Rework N/A  Korean SVC Write  
 SVC User Ticket No  SELA MIAMI N/A  Local FOTA Check  
 DEVELOPE  Repair Board  SVC Factory Reset  
 Romania SVC  Argentina SKD  
 Initial PGM(SVC)  Turkey  
 ATT Rework  Slovakia SVC  
 IMEI Clear(Factory)  GED 2nd Inspection  
 Outgoing Inspection Check  SBSC(PBA) SVC

**OK** **CANCEL**

## 6. Level 1 Repair

### 8. Click 'Hardware Config'



**Set System Configuration**  
Set System Configuration Dialog...

**Test Process**

|              |                          |                          |
|--------------|--------------------------|--------------------------|
| [Process]    | [Master]                 | [Slave]                  |
| SMD F/T      | <input type="checkbox"/> | <input type="checkbox"/> |
| PBA F/T      | <input type="checkbox"/> | <input type="checkbox"/> |
| Calibration  | <input type="checkbox"/> | <input type="checkbox"/> |
| Final Auto   | <input type="checkbox"/> | <input type="checkbox"/> |
| Final Manual | <input type="checkbox"/> | <input type="checkbox"/> |

**IMEI Process**

|               |                                     |                          |
|---------------|-------------------------------------|--------------------------|
| IMEI Write    | <input checked="" type="checkbox"/> | <input type="checkbox"/> |
| IMEI Check    | <input checked="" type="checkbox"/> | <input type="checkbox"/> |
| MDL+2nd Check | <input type="checkbox"/>            | <input type="checkbox"/> |
| MDL Rework    | <input type="checkbox"/>            | <input type="checkbox"/> |
| IMEI Read     | <input type="checkbox"/>            | <input type="checkbox"/> |

WLAN   
Power Off-On before WLAN   
Bluetooth

**Test Condition**

Calibration  
Real CAL Cycle: on every  
20 default CALs  
Calibration Mode.: Dynamic

Final  
Supply RF Signal by: Conduction

Test Signal Mode: Signaling  
Developer Mode

IMEI  
Use RFSM   
Use Second PC   
Save ODS

IMEI SVC&Repair Option

**System Config.**

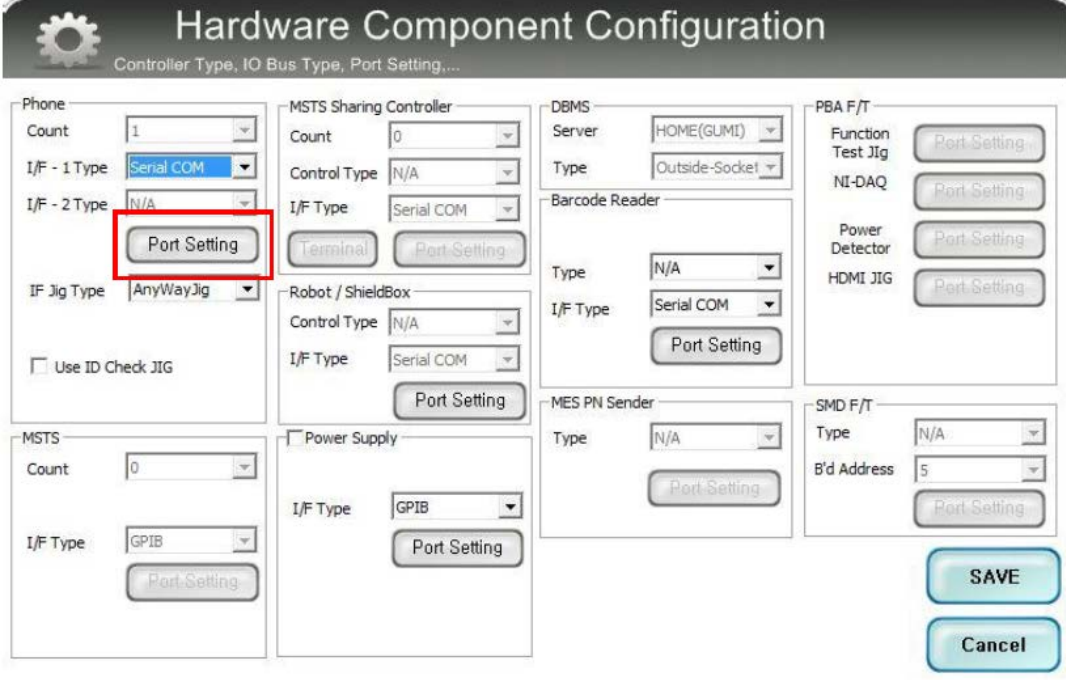
Language: English  
Line Name: LINE(temp)  
Line Type: Block Cell  
# of Phone: 1  
Start Number of Jig: 1  
IP Address: 10.244.114.62

Operation Condition

Model Information  
Hardware Config  
Signal Loss Config.  
Terminal Config.  
MST's Calibration  
Setting End Band

OK

### 9. Click 'Port Setting'



**Hardware Component Configuration**  
Controller Type, IO Bus Type, Port Setting,...

Phone  
Count: 1  
I/F - 1 Type: Serial COM  
I/F - 2 Type: N/A  
IF Jig Type: AnyWayJig  
Use ID Check JIG

MSTS Sharing Controller  
Count: 0  
Control Type: N/A  
I/F Type: Serial COM  
Terminal  
Port Setting

Robot / ShieldBox  
Control Type: N/A  
I/F Type: Serial COM  
Port Setting

Power Supply  
I/F Type: GPIB  
Port Setting

DBMS  
Server: HOME(GUMI)  
Type: Outside-Socket

Barcode Reader  
Type: N/A  
I/F Type: Serial COM  
Port Setting

MES PN Sender  
Type: N/A  
Port Setting

PBA F/T  
Function Test Jig  
NI-DAQ  
Power Detector  
HDMI JIG  
Port Setting

SMD F/T  
Type: N/A  
B'd Address: 5  
Port Setting

SAVE  
Cancel

## 6. Level 1 Repair

### 10. Select Port Number and SAVE

Set IO BUS Configuration

Phone IO Bus Setting

**Common**

BaudRate: 115200  
Data Bit: 8  
Parity: No  
Stop Bit: 1

| No. | Port #1 |
|-----|---------|
| 1   | 1       |

SAVE  
Cancel

### 11. Click OK to proceed

Set System Configuration

Set System Configuration Dialog...

Test Process

| [Process]    | [Master]                 | [Slave]                  |
|--------------|--------------------------|--------------------------|
| SMD F/T      | <input type="checkbox"/> | <input type="checkbox"/> |
| PBA F/T      | <input type="checkbox"/> | <input type="checkbox"/> |
| Calibration  | <input type="checkbox"/> | <input type="checkbox"/> |
| Final Auto   | <input type="checkbox"/> | <input type="checkbox"/> |
| Final Manual | <input type="checkbox"/> | <input type="checkbox"/> |

IMEI Process

|                |                                     |                          |
|----------------|-------------------------------------|--------------------------|
| IMEI Write     | <input checked="" type="checkbox"/> | <input type="checkbox"/> |
| IMEI Check     | <input checked="" type="checkbox"/> | <input type="checkbox"/> |
| MDL +2nd Check | <input type="checkbox"/>            | <input type="checkbox"/> |
| MDL Rework     | <input type="checkbox"/>            | <input type="checkbox"/> |
| IMEI Read      | <input type="checkbox"/>            | <input type="checkbox"/> |

WLAN   
Power Off-On before WLAN   
Bluetooth

Test Condition

Calibration  
Real CAL Cycle: on every  
20 default CALs  
Calibration Mode: Dynamic  
Final  
Supply RF Signal by: Conduction  
Test Signal Mode: Signaling  
Developer Mode

IMEI  
Use RFSM   
Use Second PC   
Save ODS

IMEI SVC&Repair Option

System Config.

Language: English  
Line Name: LINE(temp)  
Line Type: Block Cell  
# of Phone: 1  
Start Number of Jig: 1  
IP Address: 10.244.114.62

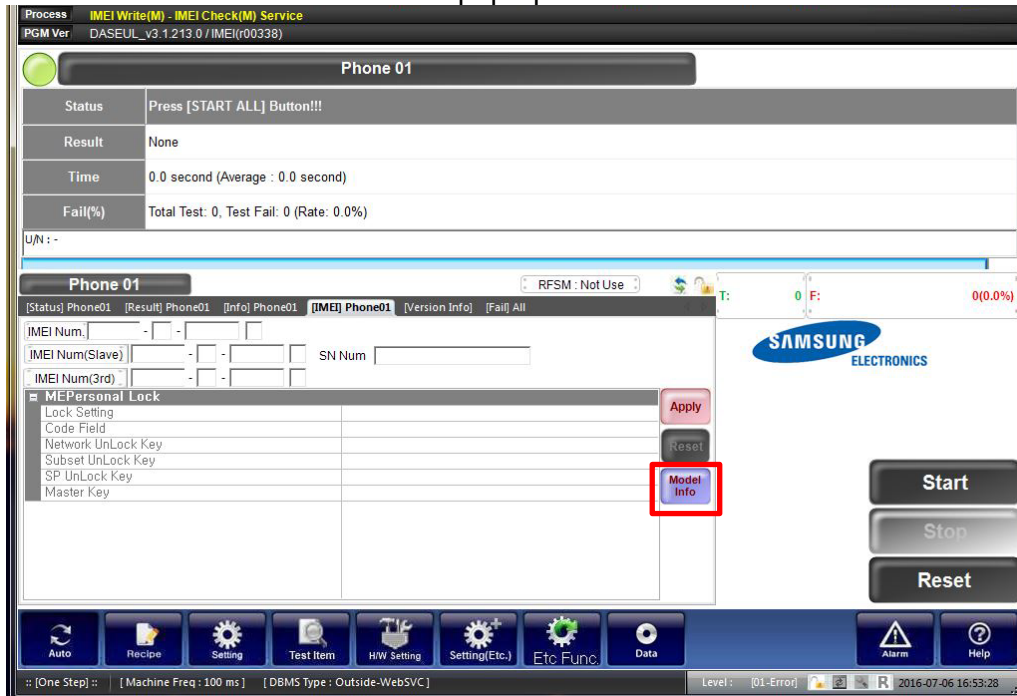
Operation Condition

Operation Condition

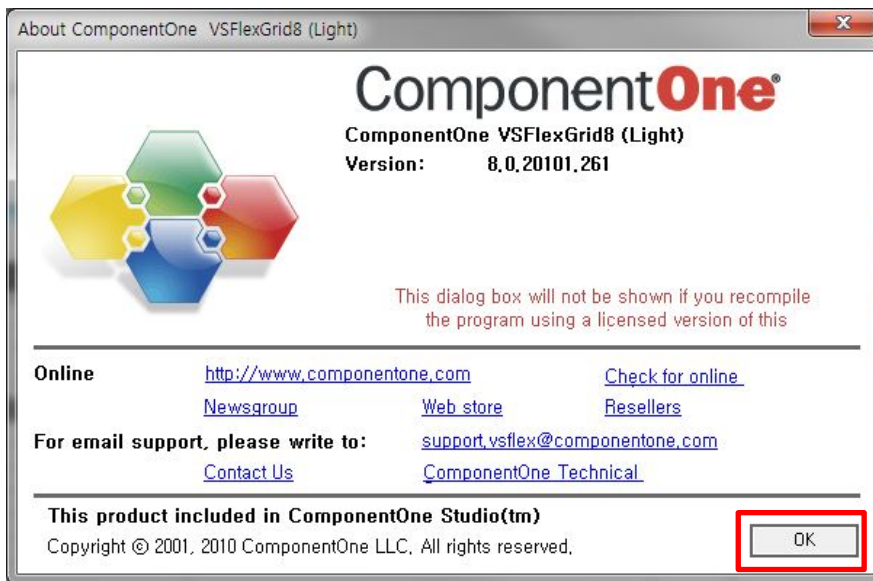
Model Information  
Hardware Config  
Signal Loss Config.  
Channel Config.  
Start Calibration  
Setting End Band  
OK

## 6. Level 1 Repair

### 12. Click Model Info and OK when pop-up shows



### 13. Click OK

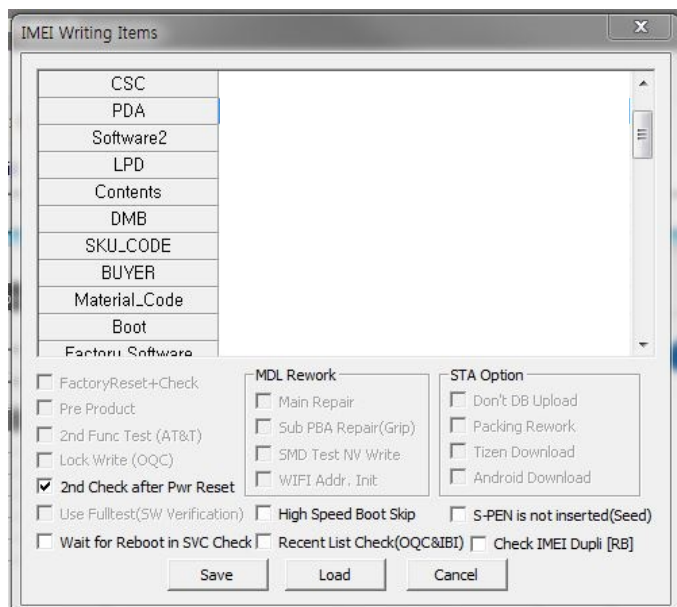




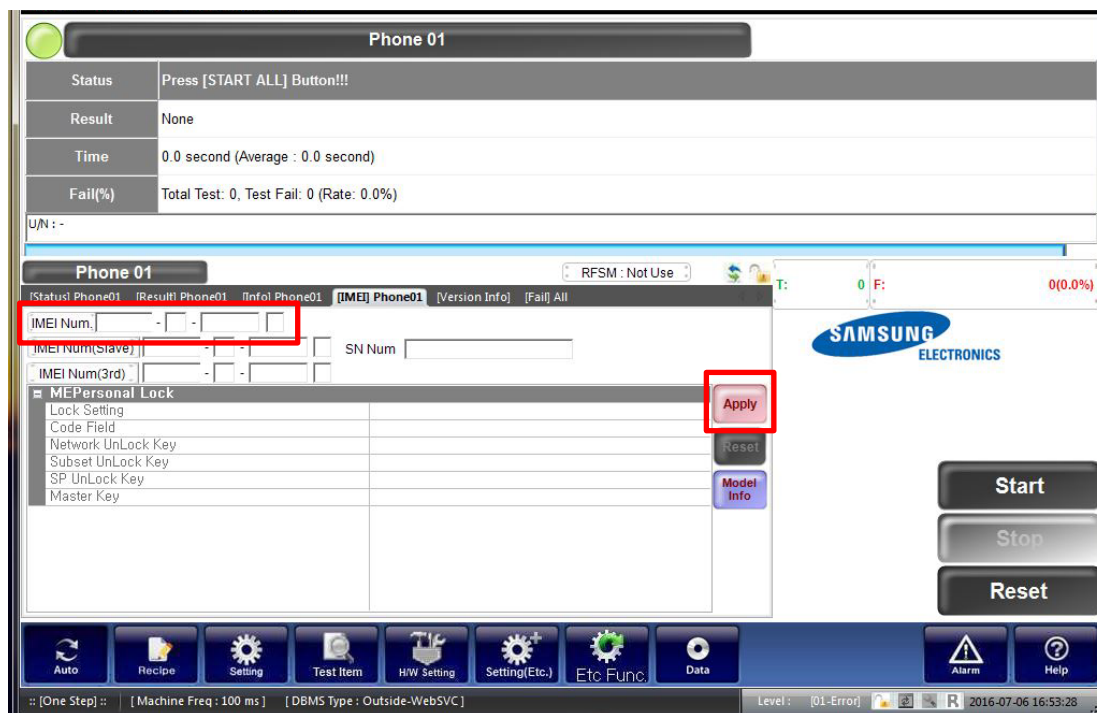
## 6. Level 1 Repair

14. Input SKU\_CODE and BUYER, then click Save button.

✳ Refer to HHPsvc→IMEI Review to check SKU Code and buyer

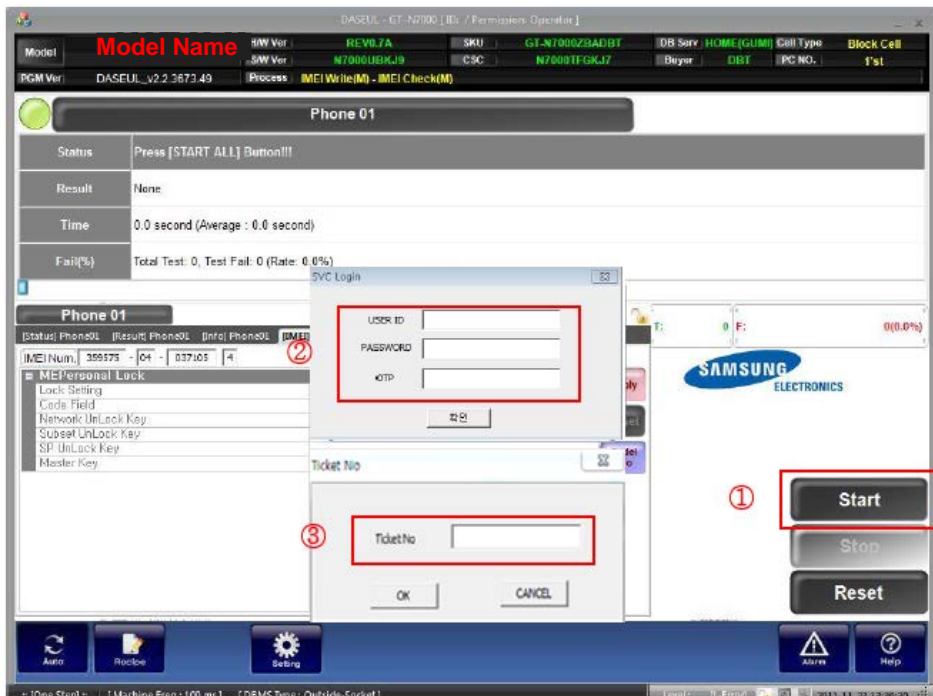


15. Input IMEI Number and click Apply



## 6. Level 1 Repair

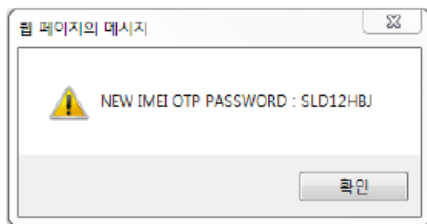
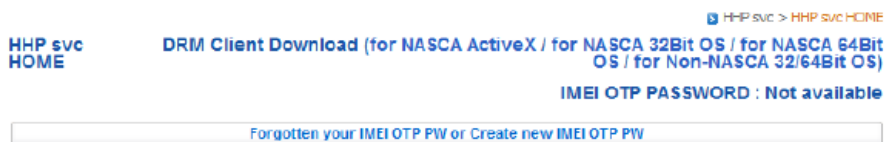
16. ① Click Start → ② Input IMEI writing ID and Password & OTP → ③ Input Ticket No



※ OTP(One time Password) : OTP is valid for 6 hours.

After that, you can get new OTP by click the “Forgotten your IMEI OTP PW or Create new IMEI OTP PW” button.

☞ OTP Location : GSPN → Knowledge → HHP svc → Home





## 6. Level 1 Repair

### 17. Connect the phone to Anyway JIG

- ✧ When you connect the phone, the phone should be turned off.  
After connecting the phone, the phone will be booted automatically.

### 18. IMEI Writing Proceeding

Phone 01

Status: Factory/Reset Poll

Result: <OK> : [WR\_Proc] Total Memory Size Compare

Time: 56.8 second (Average : 0.0 second)

Fail(%): Total Test: 0, Test Fail: 0 (Rate: 0.0%)

| Test Item | Measure                   | Low      | High        | P/F  | Sec    |
|-----------|---------------------------|----------|-------------|------|--------|
| WR_Proc   | IMEI Address Read         | 00000000 | 00000000    | PASS | 47.609 |
| WR_Proc   | Serial Number Write       | R0B0A0   | R0B0A0      | PASS | 48.864 |
| WR_Proc   | CSC Data Write            | 0B7      | 0           | PASS | 48.111 |
| WR_Proc   | Level 0 Lock Read         | 0        | 0           | PASS | 50.388 |
| WR_Proc   | MCK Write                 | *****    | *****       | PASS | 52.347 |
| WR_Proc   | NCK Write                 | *****    | *****       | PASS | 52.347 |
| WR_Proc   | SCK Write                 | *****    | *****       | PASS | 52.347 |
| WR_Proc   | CPCK Write                | *****    | *****       | PASS | 52.347 |
| WR_Proc   | Keystring Block Write     | *****    | *****       | PASS | 53.066 |
| WR_Proc   | HDCP2.0 Key Write         | *****    | *****       | PASS | 53.005 |
| WR_Proc   | Total Memory Size Compare | 11330    | 10461 12529 | PASS | 53.914 |

### 19. IMEI Writing Success

Phone 01

Status: [TEST END]

Result: <Test Pass> : 837195

Time: 215.0 second (Average : 215.6 second)

Fail(%): Total Test: 1, Test Fail: 0 (Rate: 0.0%)

| Test Item | Measure                 | Low     | High    | P/F  | Sec     |
|-----------|-------------------------|---------|---------|------|---------|
| CH_Proc   | AK Authenticate Check   | 3995701 | 3995701 | PASS | 213.519 |
| CH_Proc   | IMEI Compare            | 3995701 | 3995701 | PASS | 213.561 |
| CH_Proc   | Brwathwh 0 Compare      | 3995701 | 3995701 | PASS | 214.029 |
| CH_Proc   | Serial Number Compare   | R0B0A0  | R0B0A0  | PASS | 214.345 |
| CH_Proc   | MCK Compare             | *****   | *****   | PASS | 214.455 |
| CH_Proc   | NCK Compare             | *****   | *****   | PASS | 214.455 |
| CH_Proc   | SCK Compare             | *****   | *****   | PASS | 214.455 |
| CH_Proc   | CPCK Compare            | *****   | *****   | PASS | 214.455 |
| CH_Proc   | Keystring Compare       | *****   | *****   | PASS | 214.625 |
| CH_Proc   | Keystring Block Compare | ON      | ON      | PASS | 214.502 |
| CH_Proc   | HDCP2.0 Key Check       | OK      | OK      | PASS | 214.673 |

## 6. Level 1 Repair

### 6-4. RF Calibration






#### 6-4-1. Required items in order to calibrate RF

- Installation program: RF Calibration Program
- Daseul\_Launcher\_vx.x.xx.exe
- Daseul\_CAL\_ALL\_Runtime\_x.x.xxx.x.CAB
- Model File
- : **Model Name\_OPEN\_CALIBRATION\_Ver\_x.x.xxx.x.CAB**

※ **It is required to use the latest program.**

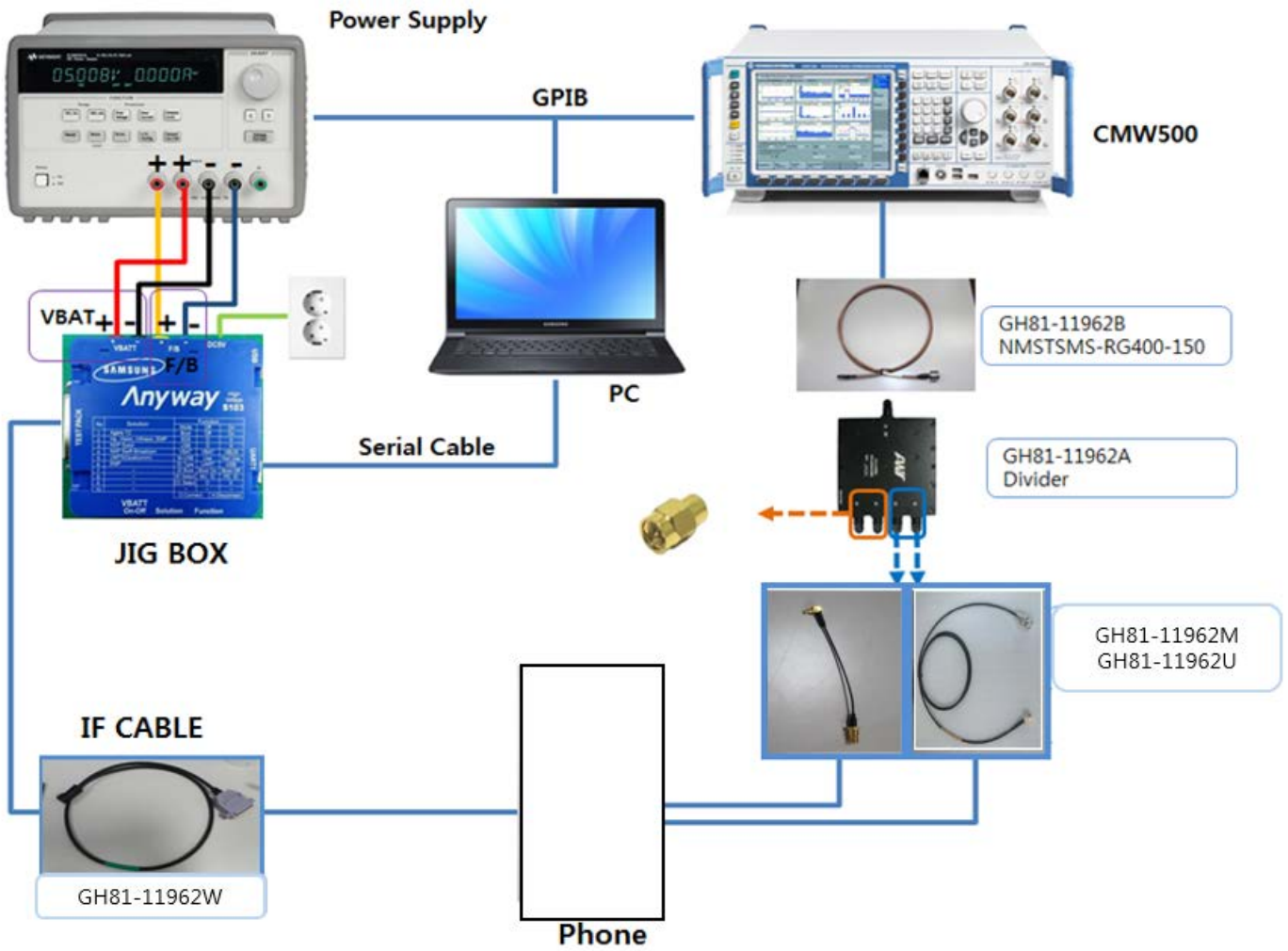
- Mobile Phone
- R&S CMW500
- E3632A Power Supply
- GPIB Cable (2ea)
- JIG BOX (S103)
- Adapter
- UART Serial Cable
- IF Cable (GH81-11962W)

#### ❖ Table of test cables

|                      |                                                                                                    |                                                                                                       |                                                                                                         |
|----------------------|----------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------|
| RF Cable<br>(Manual) | <b>GH81-11962M<br/>(2ea)</b>                                                                       | <b>GH81-11962U<br/>(2ea)</b>                                                                          |                                                                                                         |
|                      | 1.2T, 102mm<br> | 1.2T, 102mm<br>   |                                                                                                         |
| 4 Port Divider       | <b>GH81-11962A</b>                                                                                 | <b>GH81-11962B</b>                                                                                    | <b>GH81-11962E</b>                                                                                      |
|                      | Divider<br>     | Divider Cable<br> | 50Ω terminator<br> |

## 6. Level 1 Repair

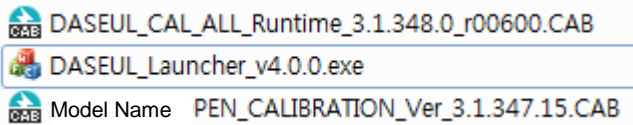
### ❖ Setting



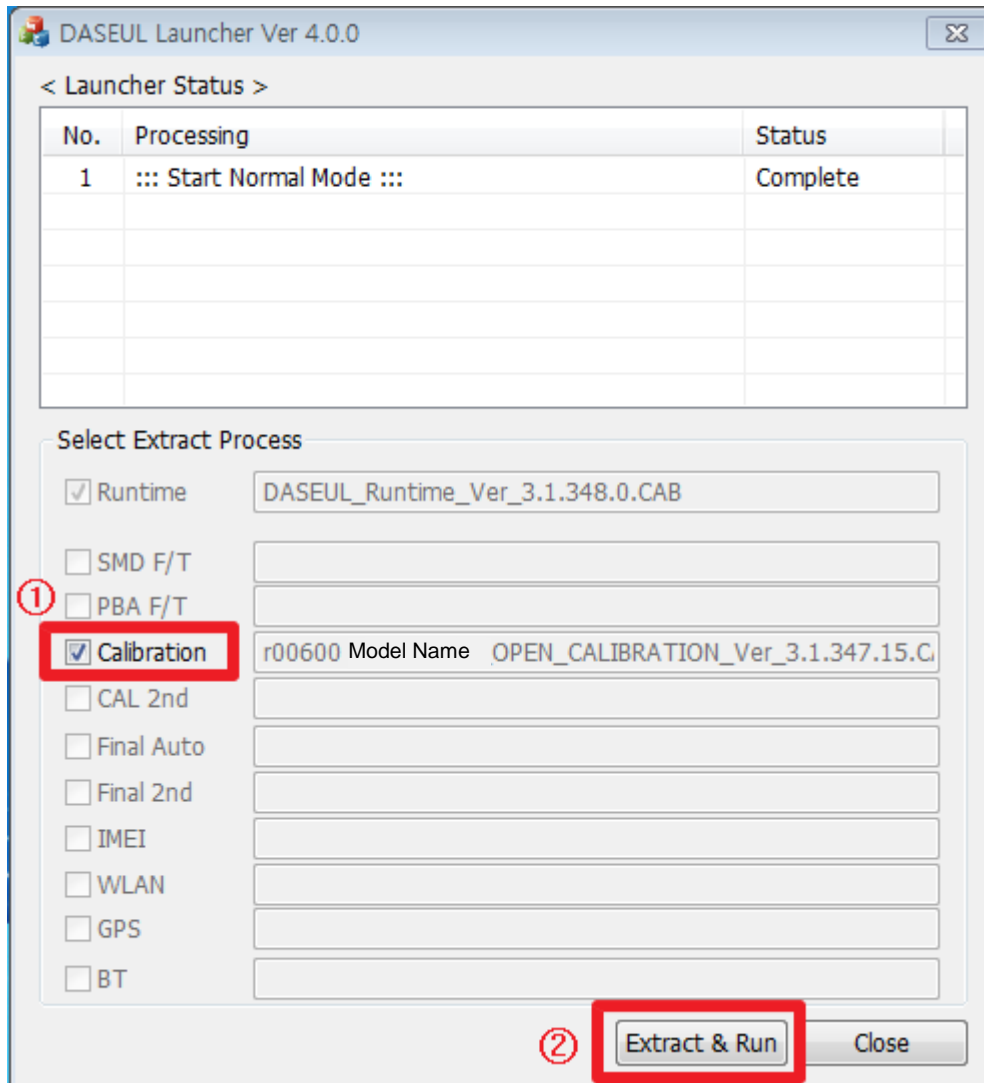
## 6. Level 1 Repair

### 6-4-2. RF Calibration Program

1. Run the RF Calibration Program Launcher, 'DASEUL\_Launcher\_vx.x.xx.exe'.

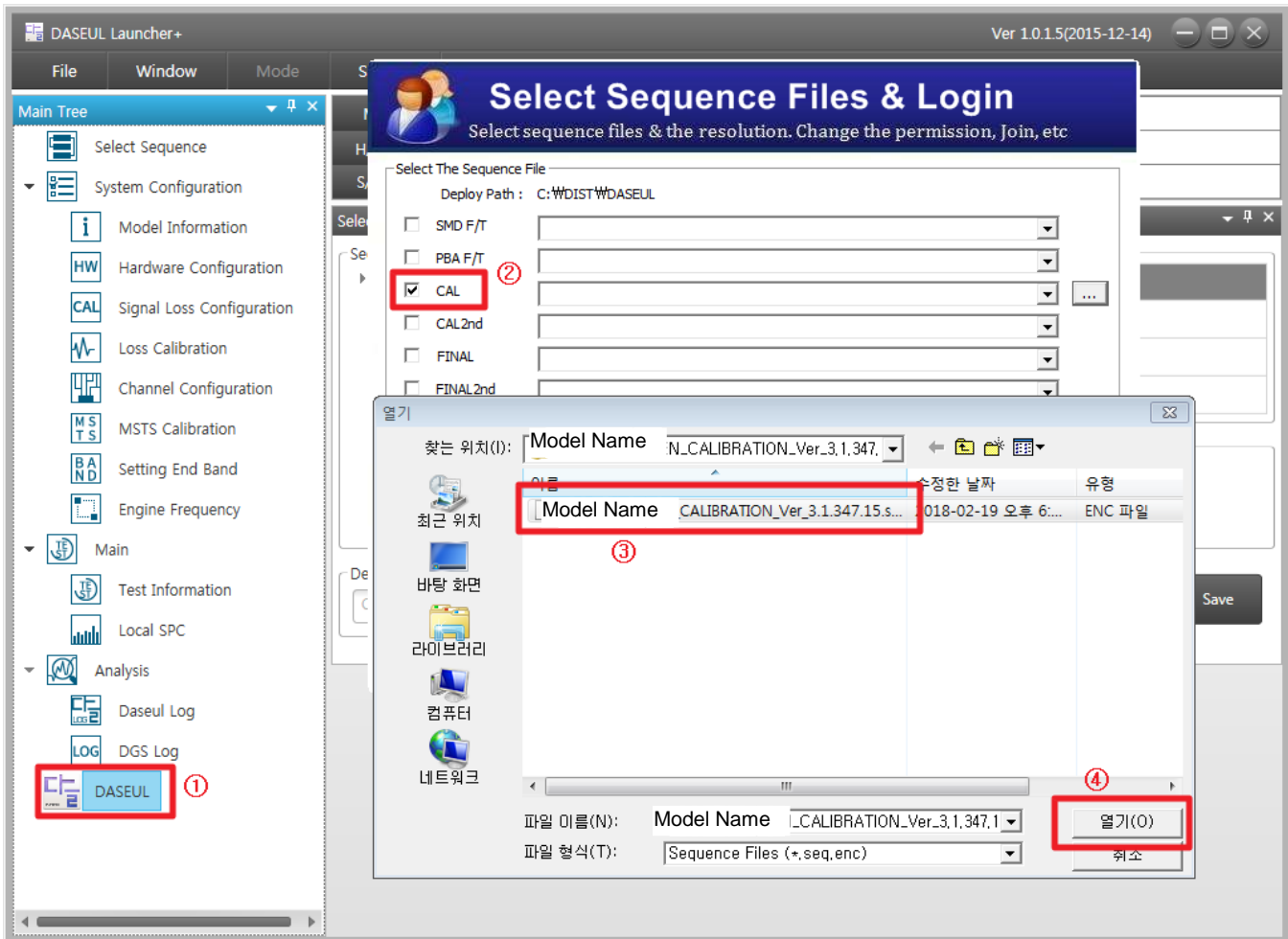


2. Check the 'Calibration' option and Click 'Extract & Run'.



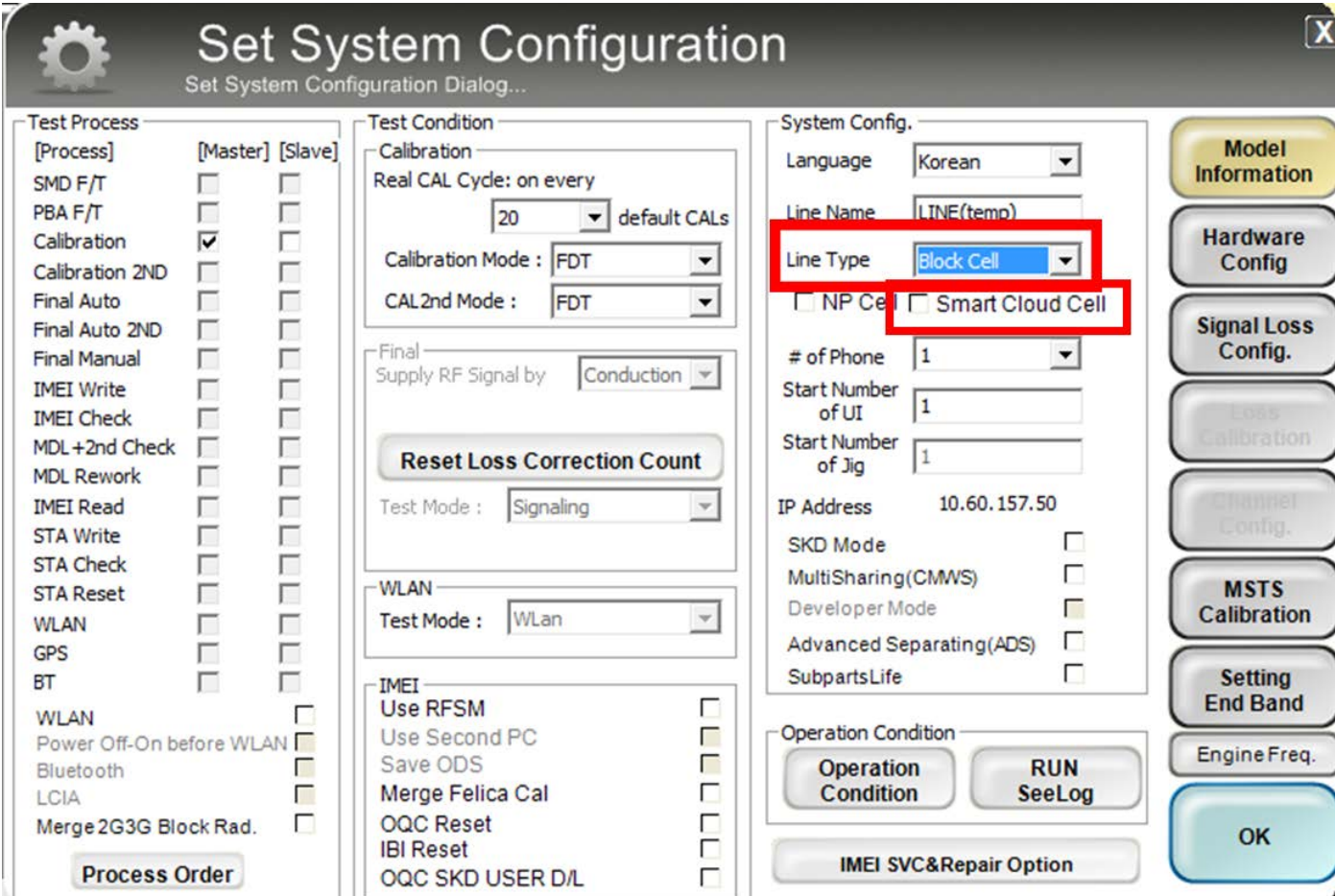
## 6. Level 1 Repair

3. Check the 'CAL' and open the [model file](#), then select 'Start' button.



## 6. Level 1 Repair

4. Change the Line Type to 'Block Cell' and disable 'Smart Cloud Cell'.



**Set System Configuration**  
Set System Configuration Dialog...

**Test Process**

| [Process]                | [Master]                            | [Slave]                  |
|--------------------------|-------------------------------------|--------------------------|
| SMD F/T                  | <input type="checkbox"/>            | <input type="checkbox"/> |
| PBA F/T                  | <input type="checkbox"/>            | <input type="checkbox"/> |
| Calibration              | <input checked="" type="checkbox"/> | <input type="checkbox"/> |
| Calibration 2ND          | <input type="checkbox"/>            | <input type="checkbox"/> |
| Final Auto               | <input type="checkbox"/>            | <input type="checkbox"/> |
| Final Auto 2ND           | <input type="checkbox"/>            | <input type="checkbox"/> |
| Final Manual             | <input type="checkbox"/>            | <input type="checkbox"/> |
| IMEI Write               | <input type="checkbox"/>            | <input type="checkbox"/> |
| IMEI Check               | <input type="checkbox"/>            | <input type="checkbox"/> |
| MDL +2nd Check           | <input type="checkbox"/>            | <input type="checkbox"/> |
| MDL Rework               | <input type="checkbox"/>            | <input type="checkbox"/> |
| IMEI Read                | <input type="checkbox"/>            | <input type="checkbox"/> |
| STA Write                | <input type="checkbox"/>            | <input type="checkbox"/> |
| STA Check                | <input type="checkbox"/>            | <input type="checkbox"/> |
| STA Reset                | <input type="checkbox"/>            | <input type="checkbox"/> |
| WLAN                     | <input type="checkbox"/>            | <input type="checkbox"/> |
| GPS                      | <input type="checkbox"/>            | <input type="checkbox"/> |
| BT                       | <input type="checkbox"/>            | <input type="checkbox"/> |
| WLAN                     | <input type="checkbox"/>            | <input type="checkbox"/> |
| Power Off-On before WLAN | <input type="checkbox"/>            | <input type="checkbox"/> |
| Bluetooth                | <input type="checkbox"/>            | <input type="checkbox"/> |
| LCIA                     | <input type="checkbox"/>            | <input type="checkbox"/> |
| Merge 2G3G Block Rad.    | <input type="checkbox"/>            | <input type="checkbox"/> |

**Test Condition**

Calibration  
Real CAL Cycle: on every  
20 default CALs  
Calibration Mode : FDT  
CAL2nd Mode : FDT

Final  
Supply RF Signal by: Conduction  
**Reset Loss Correction Count**  
Test Mode : Signaling

WLAN  
Test Mode : WLAN

IMEI  
Use RFSM   
Use Second PC   
Save ODS   
Merge Felica Cal   
OQC Reset   
IBI Reset   
OQC SKD USER D/L

**System Config.**

Language: Korean  
Line Name: LINE(temp)  
**Line Type: Block Cell**  
 NP Cell  Smart Cloud Cell  
# of Phone: 1  
Start Number of UI: 1  
Start Number of Jig: 1  
IP Address: 10.60.157.50  
SKD Mode   
MultiSharing(CMWS)   
Developer Mode   
Advanced Separating(ADS)   
SubpartsLife

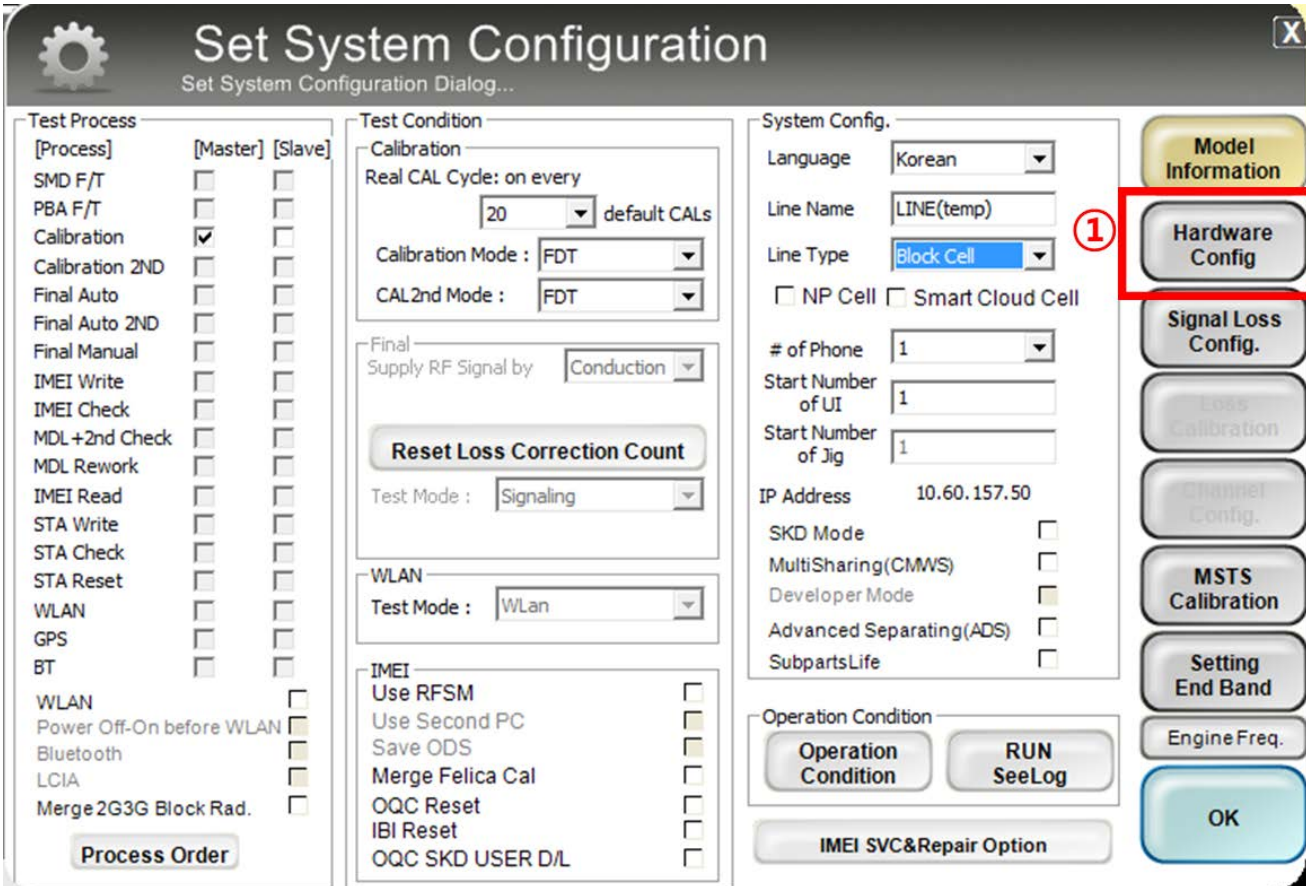
**Operation Condition**  
Operation Condition RUN SeeLog  
IMEI SVC&Repair Option

**Model Information**  
Hardware Config.  
Signal Loss Config.  
Loss Calibration  
Channel Config.  
MSTS Calibration  
Setting End Band  
Engine Freq.  
OK



## 6. Level 1 Repair

5. Set the GPIB address of MSTS(CMW500) and Power Supply(E3632A) to enter 'Hardware Config' and 'Save'. (Check the GPIB address of equipments in advance)



**Set System Configuration**  
Set System Configuration Dialog...

**Test Process**

| [Process]                | [Master]                            | [Slave]                  |
|--------------------------|-------------------------------------|--------------------------|
| SMD F/T                  | <input type="checkbox"/>            | <input type="checkbox"/> |
| PBA F/T                  | <input type="checkbox"/>            | <input type="checkbox"/> |
| Calibration              | <input checked="" type="checkbox"/> | <input type="checkbox"/> |
| Calibration 2ND          | <input type="checkbox"/>            | <input type="checkbox"/> |
| Final Auto               | <input type="checkbox"/>            | <input type="checkbox"/> |
| Final Auto 2ND           | <input type="checkbox"/>            | <input type="checkbox"/> |
| Final Manual             | <input type="checkbox"/>            | <input type="checkbox"/> |
| IMEI Write               | <input type="checkbox"/>            | <input type="checkbox"/> |
| IMEI Check               | <input type="checkbox"/>            | <input type="checkbox"/> |
| MDL +2nd Check           | <input type="checkbox"/>            | <input type="checkbox"/> |
| MDL Rework               | <input type="checkbox"/>            | <input type="checkbox"/> |
| IMEI Read                | <input type="checkbox"/>            | <input type="checkbox"/> |
| STA Write                | <input type="checkbox"/>            | <input type="checkbox"/> |
| STA Check                | <input type="checkbox"/>            | <input type="checkbox"/> |
| STA Reset                | <input type="checkbox"/>            | <input type="checkbox"/> |
| WLAN                     | <input type="checkbox"/>            | <input type="checkbox"/> |
| GPS                      | <input type="checkbox"/>            | <input type="checkbox"/> |
| BT                       | <input type="checkbox"/>            | <input type="checkbox"/> |
| WLAN                     | <input type="checkbox"/>            | <input type="checkbox"/> |
| Power Off-On before WLAN | <input type="checkbox"/>            | <input type="checkbox"/> |
| Bluetooth                | <input type="checkbox"/>            | <input type="checkbox"/> |
| LCIA                     | <input type="checkbox"/>            | <input type="checkbox"/> |
| Merge 2G3G Block Rad.    | <input type="checkbox"/>            | <input type="checkbox"/> |

**Test Condition**

Calibration  
Real CAL Cycle: on every 20 default CALs

Calibration Mode : FDT  
CAL2nd Mode : FDT

Final Supply RF Signal by: Conduction

Reset Loss Correction Count

Test Mode : Signaling

WLAN  
Test Mode : WLAN

IMEI  
Use RFSM  
Use Second PC  
Save ODS  
Merge Felica Cal  
OQC Reset  
IBI Reset  
OQC SKD USER DL

**System Config.**

Language: Korean  
Line Name: LINE(temp)  
Line Type: Block Cell  
 NP Cell  Smart Cloud Cell

# of Phone: 1  
Start Number of UI: 1  
Start Number of Jig: 1  
IP Address: 10.60.157.50

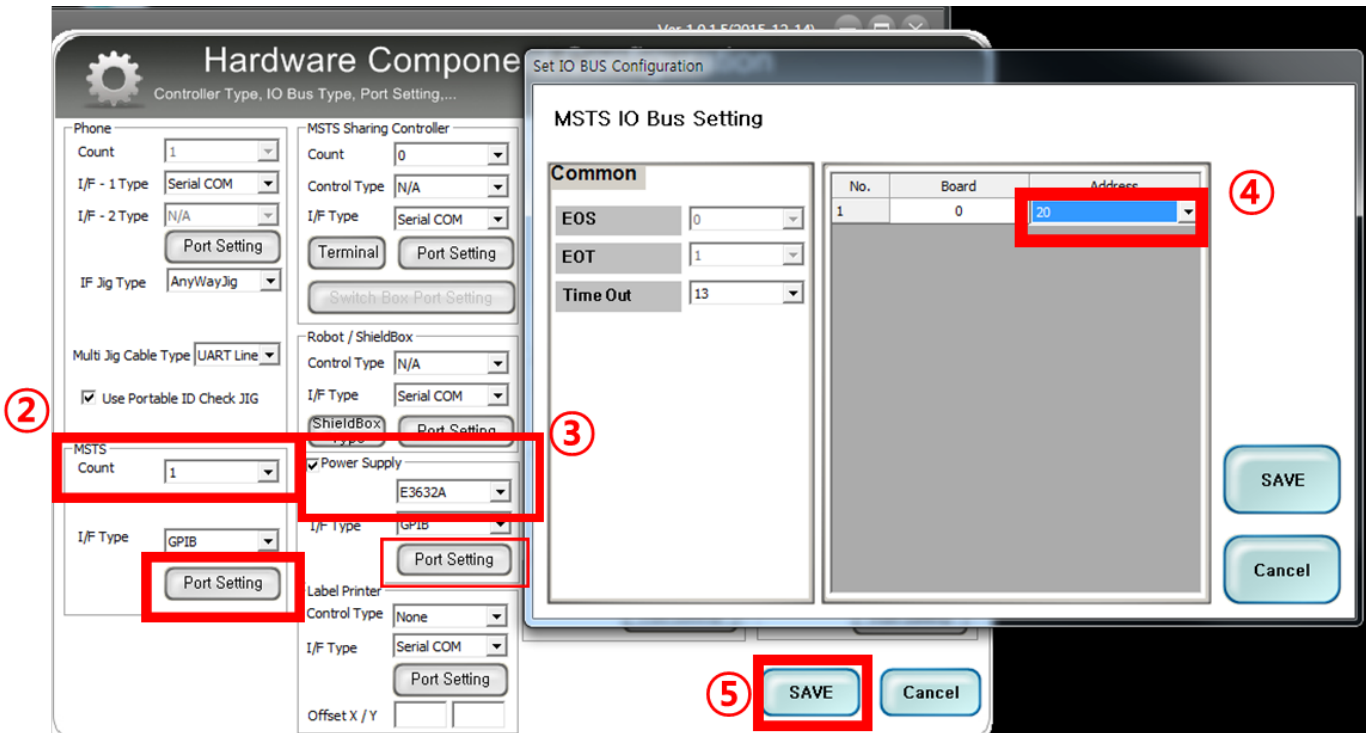
SKD Mode   
MultiSharing(CMWS)   
Developer Mode   
Advanced Separating(ADS)   
SubpartsLife

Operation Condition  
Operation Condition RUN SeeLog

IMEI SVC&Repair Option

**Model Information**

Hardware Config  
Signal Loss Config.  
Loss Calibration  
Channel Config.  
MSTS Calibration  
Setting End Band  
Engine Freq.  
OK



**Hardware Component**  
Controller Type, IO Bus Type, Port Setting...

Phone  
Count: 1  
I/F - 1 Type: Serial COM  
I/F - 2 Type: N/A  
IF Jig Type: AnyWayJig

MSTS Sharing Controller  
Count: 0  
Control Type: N/A  
I/F Type: Serial COM

Robot / ShieldBox  
Control Type: N/A  
I/F Type: Serial COM

ShieldBox  
I/F Type: Serial COM

Power Supply  
E3632A  
I/F Type: GPIB

Label Printer  
Control Type: None  
I/F Type: Serial COM

Offset X / Y

**MSTS IO Bus Setting**

Common

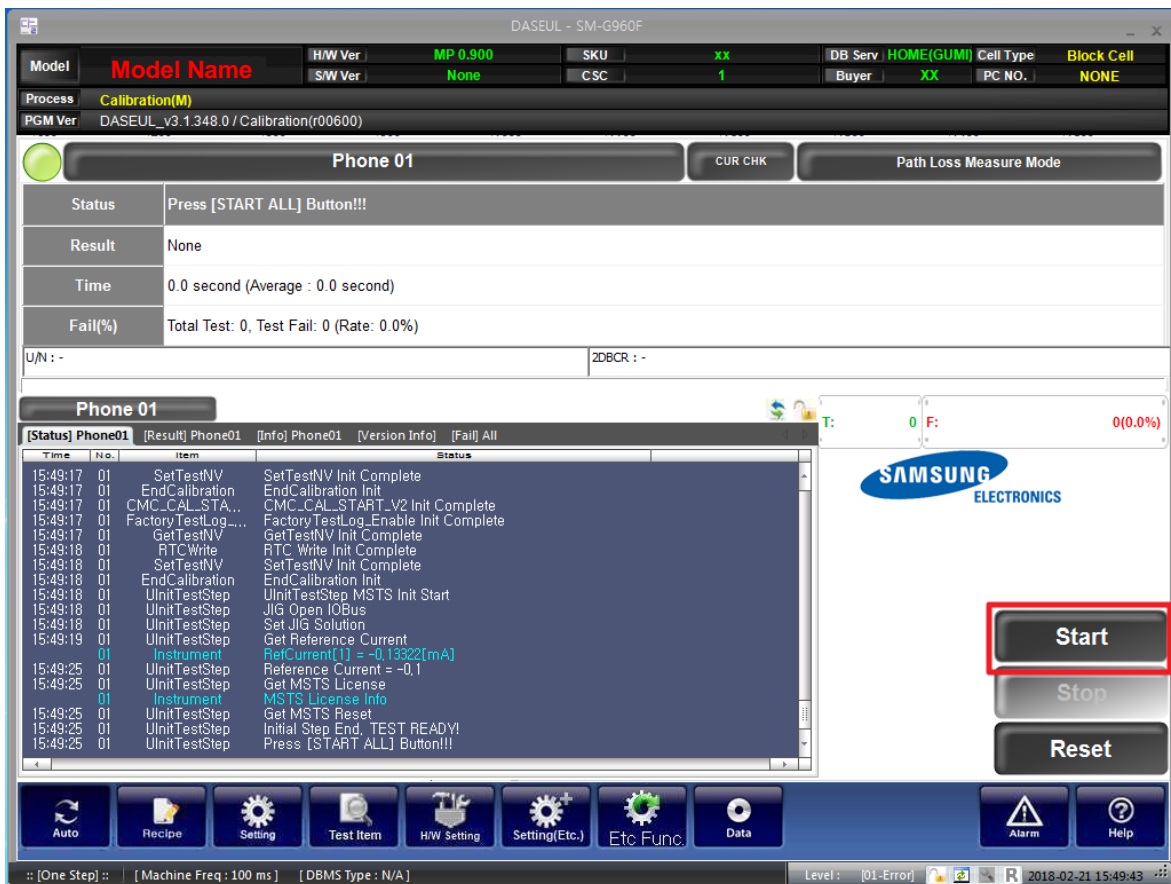
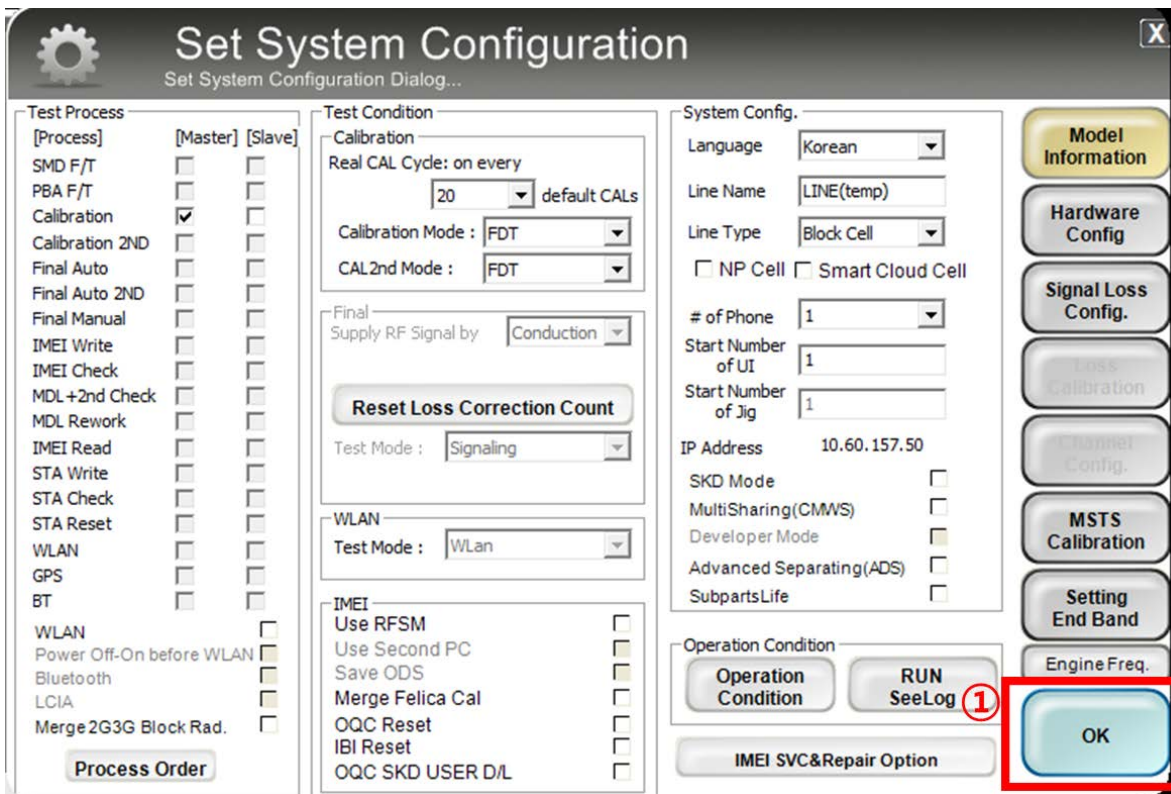
| No. | Board | Address |
|-----|-------|---------|
| 1   | 0     | 20      |

EOS: 0  
EOT: 1  
Time Out: 13

SAVE Cancel

## 6. Level 1 Repair

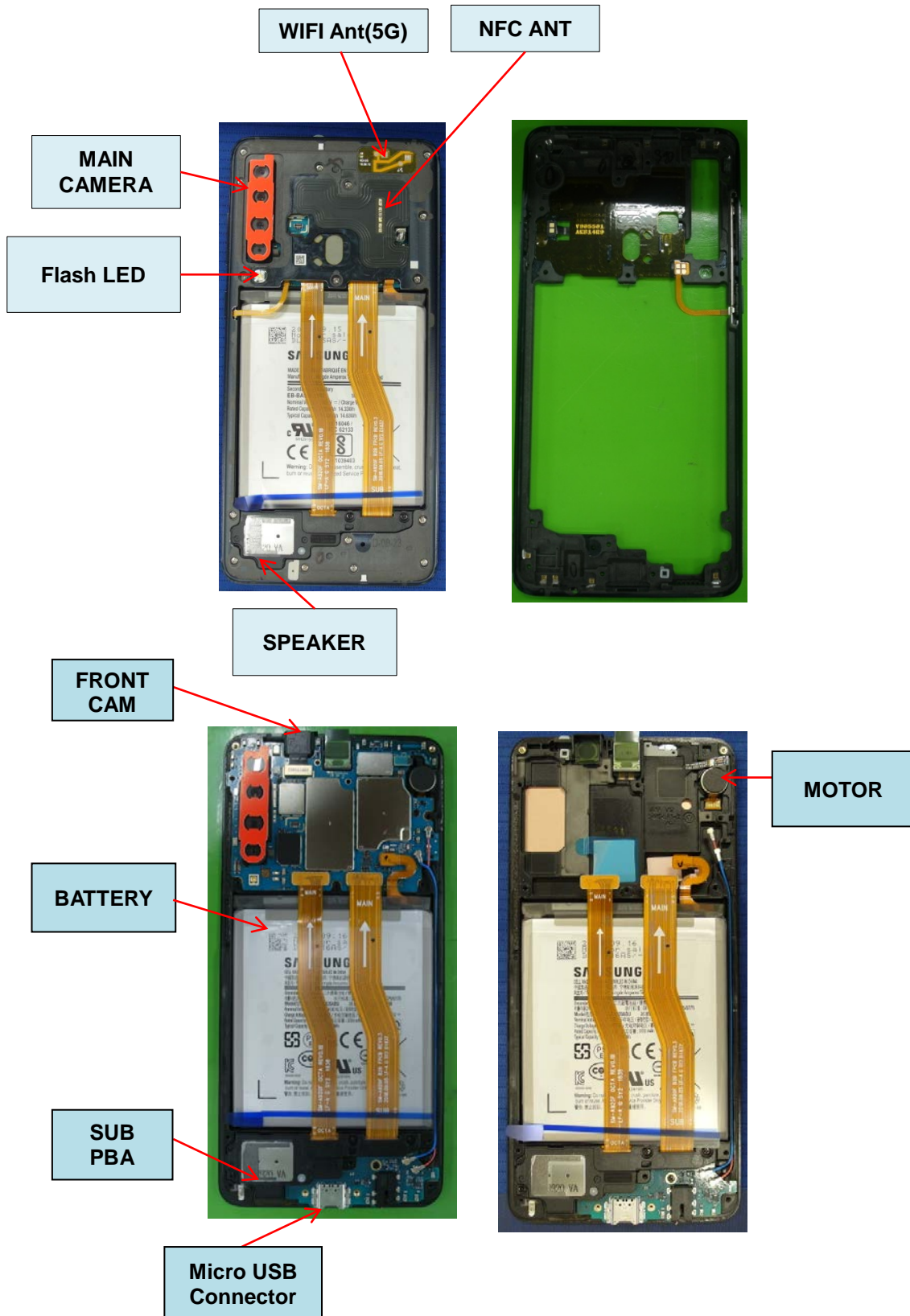
6. Press 'OK' to start RF Calibration after completing all settings.










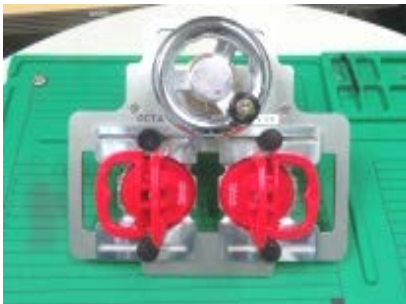


## 7. Level 2 Repair

### 7-1 Components on the Rear/Front Case




## 7. Level 2 Repair

### 7-2. Pre-requisite

|                                                                                     |                                                                                      |
|-------------------------------------------------------------------------------------|--------------------------------------------------------------------------------------|
|    |   |
| <p><b>Tweezers / Disass'y Sticks / Screw Driver</b></p>                             | <p><b>Anti-static Gloves</b></p>                                                     |
|    |    |
| <p><b>Anti-static Mat</b></p>                                                       | <p><b>Hot Plate</b></p>                                                              |
|  |  |
| <p><b>A OCTA Disassembly Holder</b></p>                                             | <p><b>OCTA Disassembly Upper</b></p>                                                 |
|  |  |
| <p><b>Ethyl Alcohol</b></p>                                                         | <p><b>Cotton Swab</b></p>                                                            |

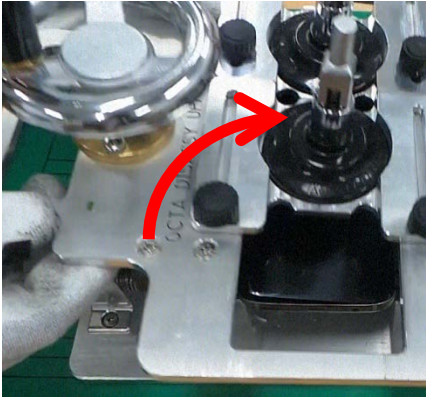
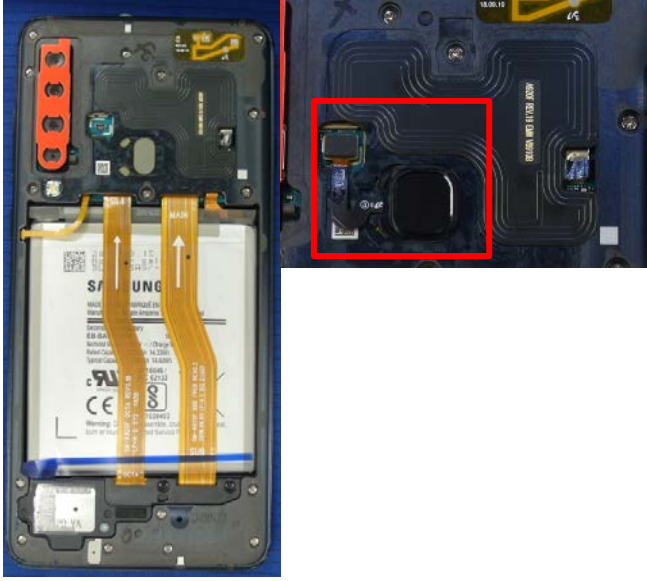


## 7. Level 2 Repair

### 7-3 Parts which must be changed after repair

| BOM description & part code                            | Image                                                                             | Remarks                                                       |
|--------------------------------------------------------|-----------------------------------------------------------------------------------|---------------------------------------------------------------|
| <p>Backglass Outside Rework Tape<br/>[GH81-16332A]</p> |  | <p>Whenever the Backglass is disassembled and reassembled</p> |

## 7. Level 2 Repair

### 7-4. Disassembly

|                                                                                                                                                                                                                                                                                                                                                            |                                                                                                                                                                                                                                                           |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| <p><b>1</b></p> <p>1) Put the device in the chamber as following below heating condition<br/>         - SOC 68%↓: 70 °C/10~20 minute<br/>         - SOC 68%↑: 70 °C/10~20 minute<br/>         ※ Please confirm the heating condition released lastly, and follow it.</p>  | <p><b>2</b></p> <p>Detach the Back Glass. And Finger sensor<br/>         1) Detach the left side of Back glass<br/>         2) Detach the Finger sensor connector</p>  |
| <p>※ <b>Caution</b><br/>         1) Be care of scratch</p>                                                                                                                                                                                                                                                                                                 | <p>※ <b>Caution</b><br/>         1) Be care of scratch</p>                                                                                                                                                                                                |
| <p><b>3</b></p> <p>Unscrew 16 Point and disassemble SIM Tray from device</p>                                                                                                                                                                                            | <p><b>4</b></p> <p>Disassemble Rear.</p>                                                                                                                              |
| <p>※ <b>Caution</b><br/>         1) Be care of Rear damage</p>                                                                                                                                                                                                                                                                                             | <p>※ <b>Caution</b><br/>         1) Be care of scratch<br/>         2) Be care of Rear and connector damage</p>                                                                                                                                           |



## 7. Level 2 Repair

5

Unscrew PBA 1points.

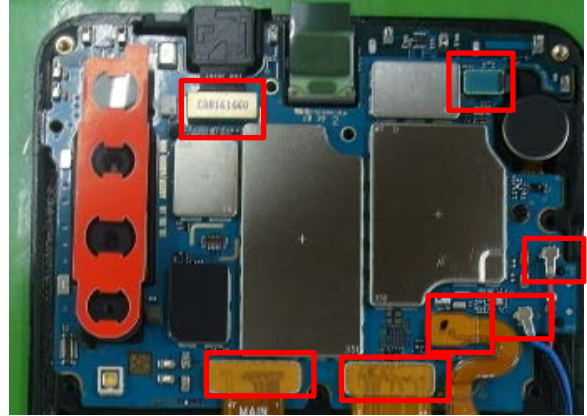


⚠ Caution

- 1) Be care of scratch
- 2) Be care of Front and connector damage
- 3) Be careful not to damage the PBA

6

Detach 2 coaxial cable, Battery connect and the other connectors.



⚠ Caution

- 1) Be careful not to damage the PBA

7

- 1) Disassemble Front CAM
- 2) Disassemble PBA

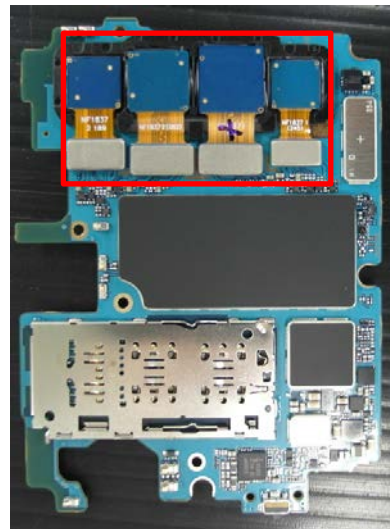


⚠ Caution

- 1) Be care of scratch
- 2) Be care of connector/cable damage

8

Detach other components.(Main CAM)



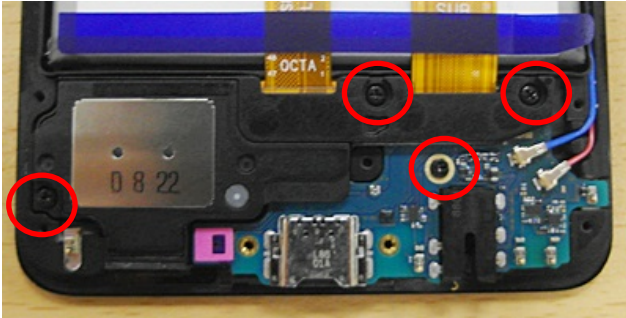
⚠ Caution

- 1) Be care of FPCB damage

## 7. Level 2 Repair

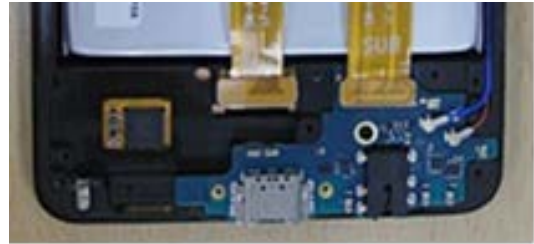
9

Unscrew SUB PBA and spk 4points



10

Detach SPK  
Detach SUB PBA



✘ Caution

1) Be care of several kinds of damage

✘ Caution

1) Be careful not to damage the SUB PBA

## 7. Level 2 Repair

### 7-5. Assembly

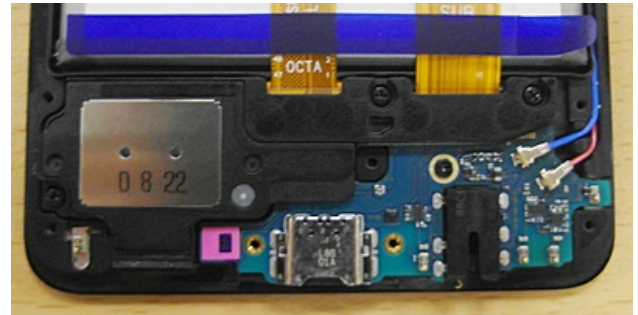
1

1) Attach components on Front.  
(RCV module, Sensor FPCB, Motor and SUB PBA)  
2) Attach OCTA and SUB PBA Connector



2

Attach 2 coaxial cable, Screw 4point in SUB PBA.



※ **Caution**

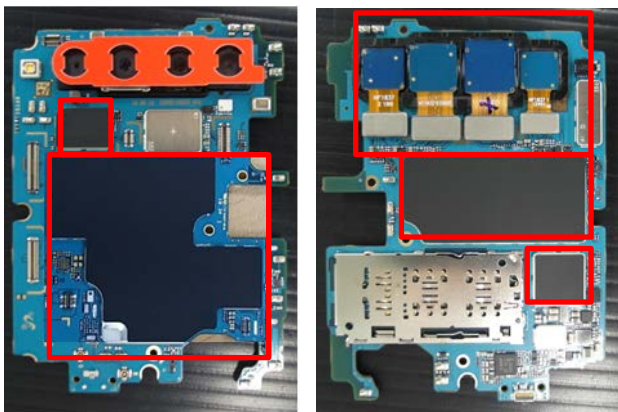
1) Be care of coaxial cable damage

※ **Caution**

1) Be care of chip damage nearby screw point.

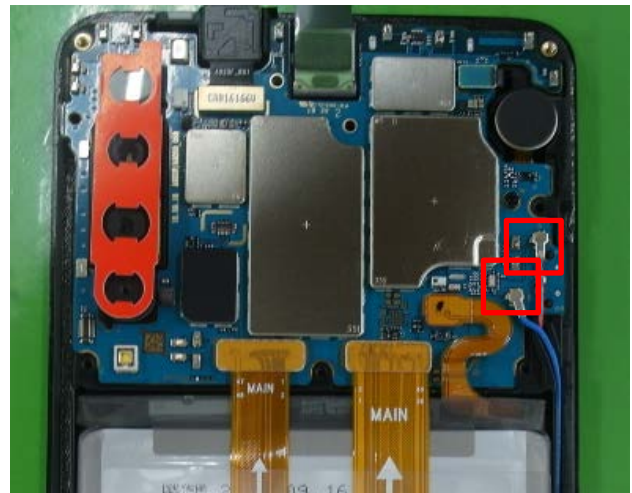
3

Attach EMI Tape(4), Flooding label and Main CAM in PBA



4

Assembly the PBA at the front.  
And attach 2 coaxial cables.



※ **Caution**

1) Be care of FPCB damage and tilt  
2) Be care of press power/time

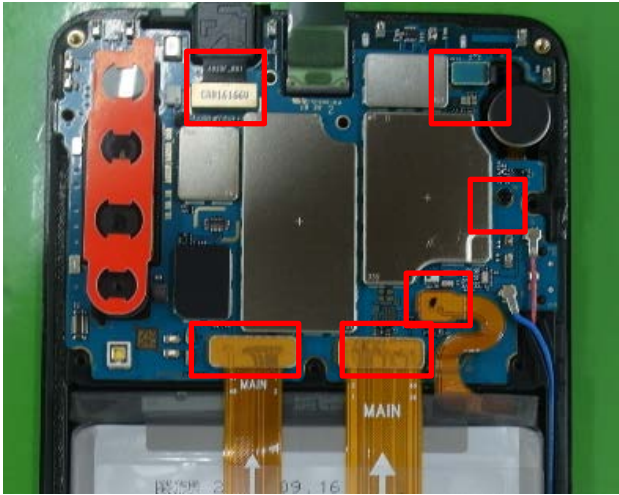
※ **Caution**

1) Be care of components FPCB.

## 7. Level 2 Repair

5

1) Attach Battery ,Front CAM, Sensor FPCB, SUB PBA ,OCTA Connector  
Screw 1 point in PBA



6

Assemble the REAR.



※ Caution

1) Be care of press power/time

※ Caution

1) Be care of FPCB and Y-OCTA damage

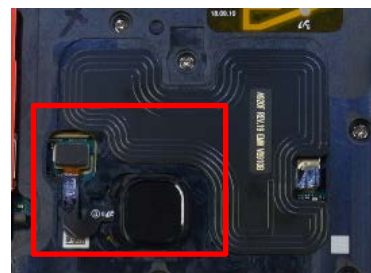
7

Screw 16 Point and assemble SIM Tray.  
\* Torque value : 1.2 N · m



8

Attach the finger sensor on the REAR and  
Assemble the finger sensor on the PBA



※ Caution

1) Be care of scratch and REAR damage

※ Caution

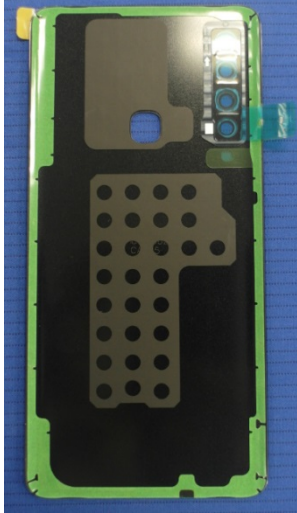
1) Be care of scratch and REAR damage



## 7. Level 2 Repair

9

Attach the back glass inner tape on the rear case



10

Attach the back glass on the REAR side.



※ Caution

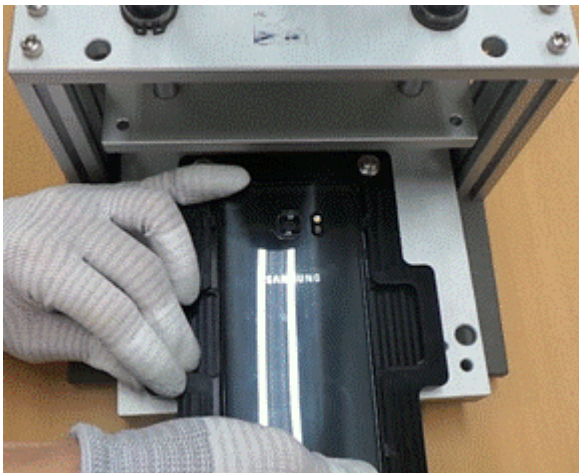
1) Be care of scratch and REAR damage

※ Caution

1) Be care of scratch and tilt.

11

Press Back Glass with pressing jig for SVC.  
Pressing force : 1N  
Pressing time : 1 minute

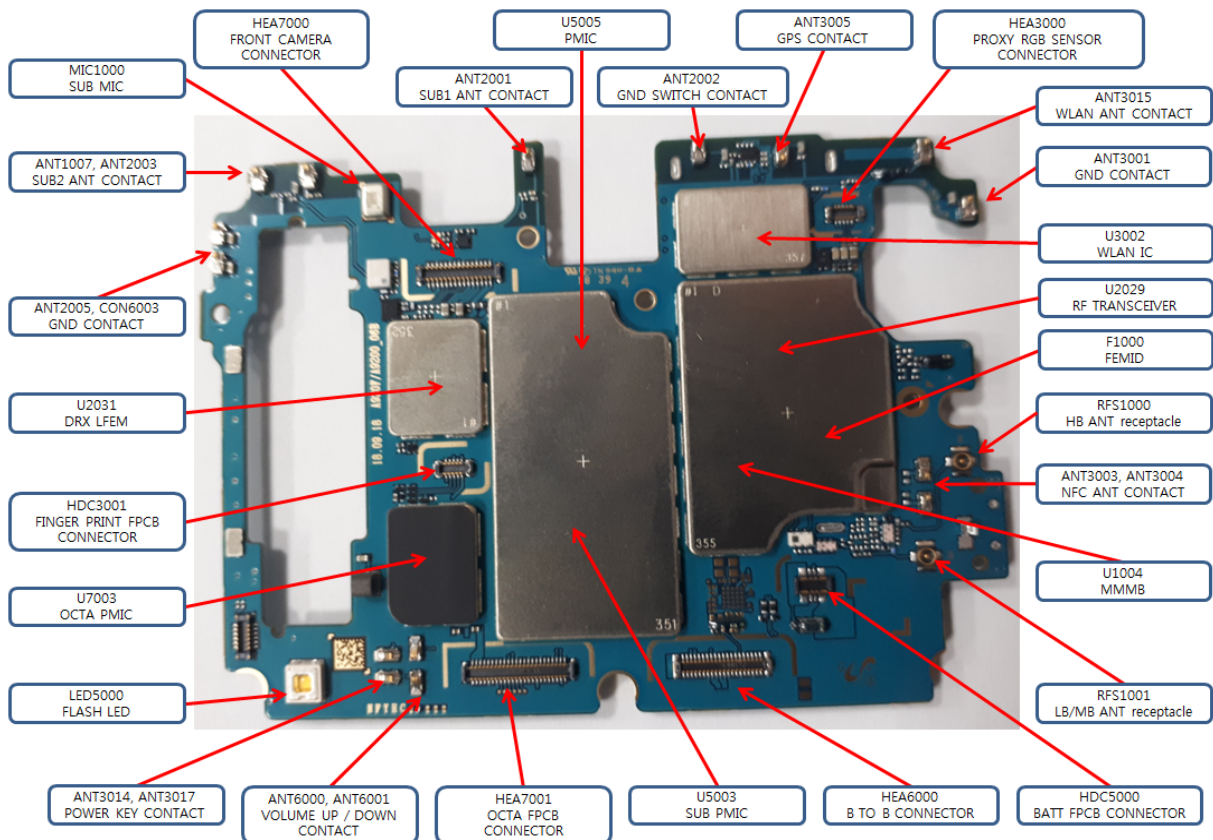
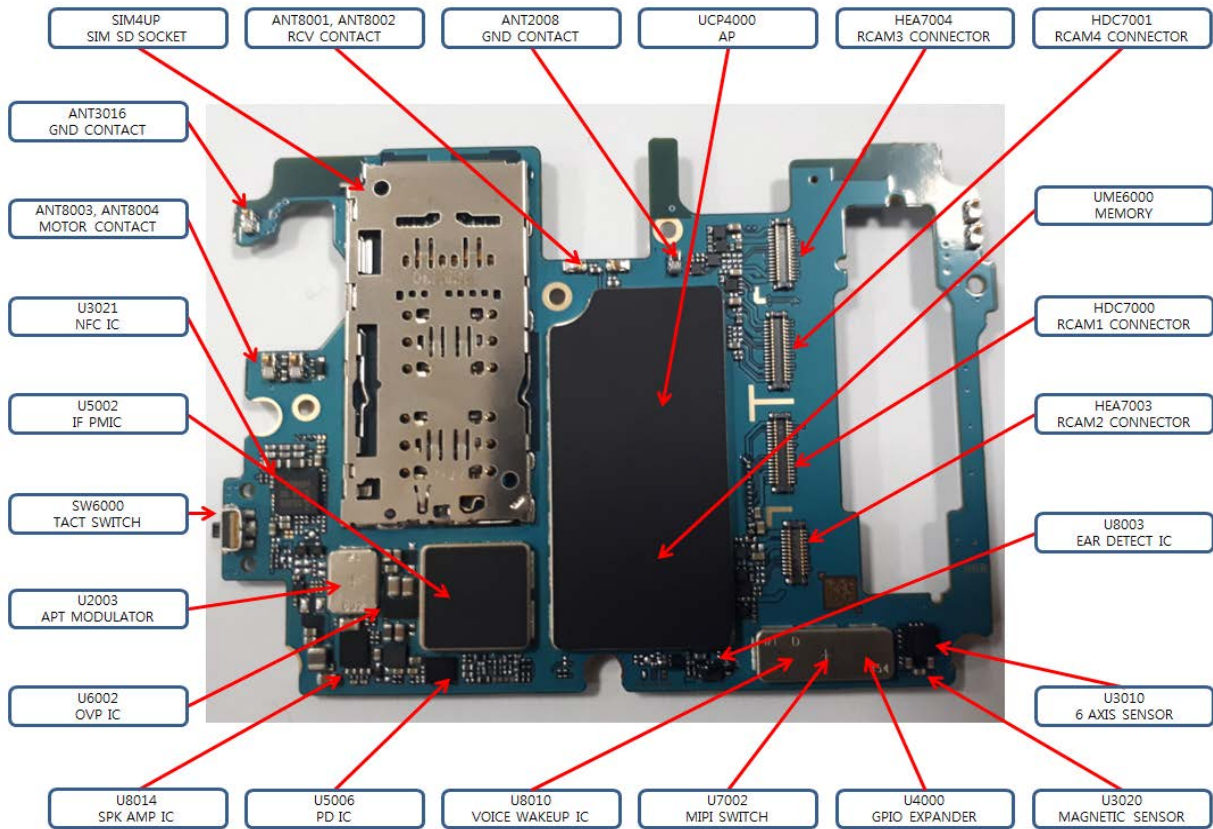


※ Caution

1) Be care of scratch and tilt.

# 8. Level 3 Repair

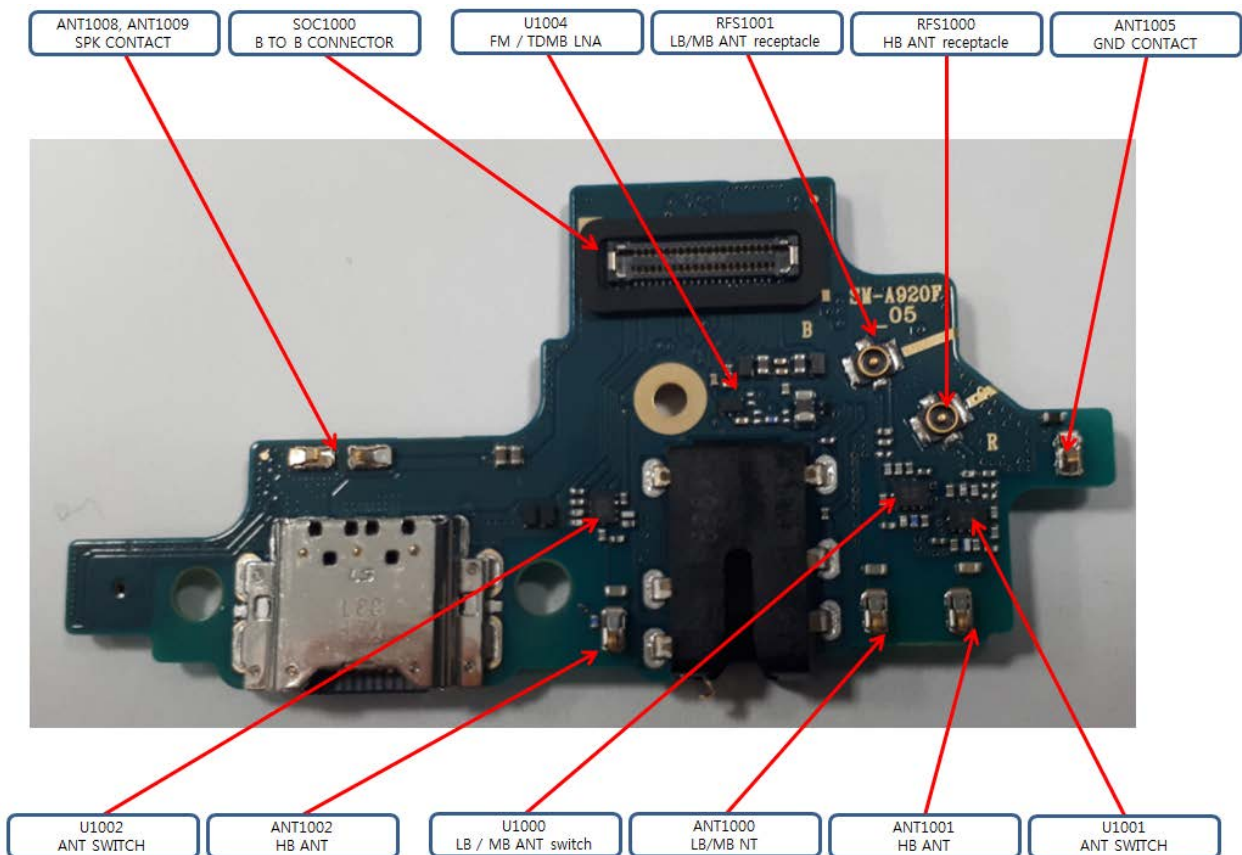
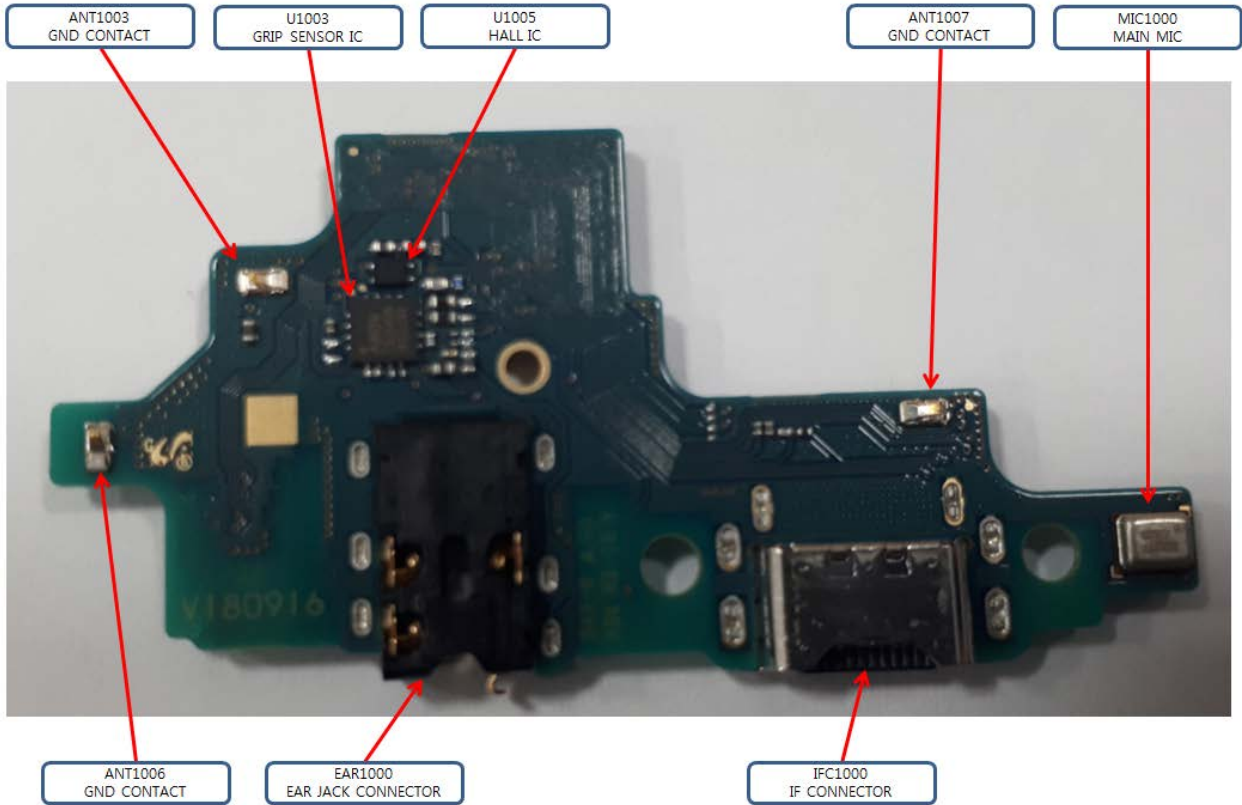
## 8-1. Components Layout



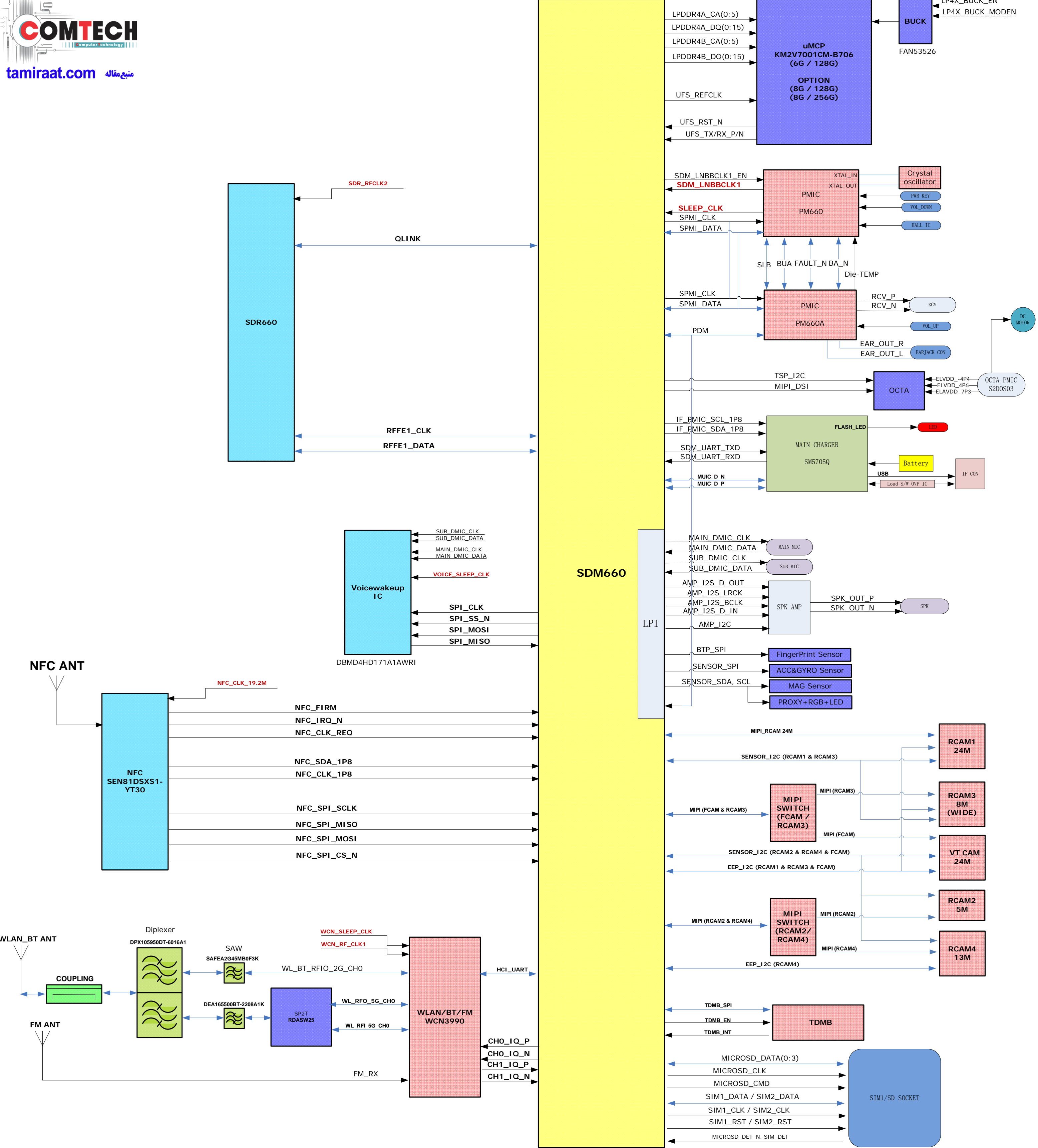
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## 8. Level 3 Repair



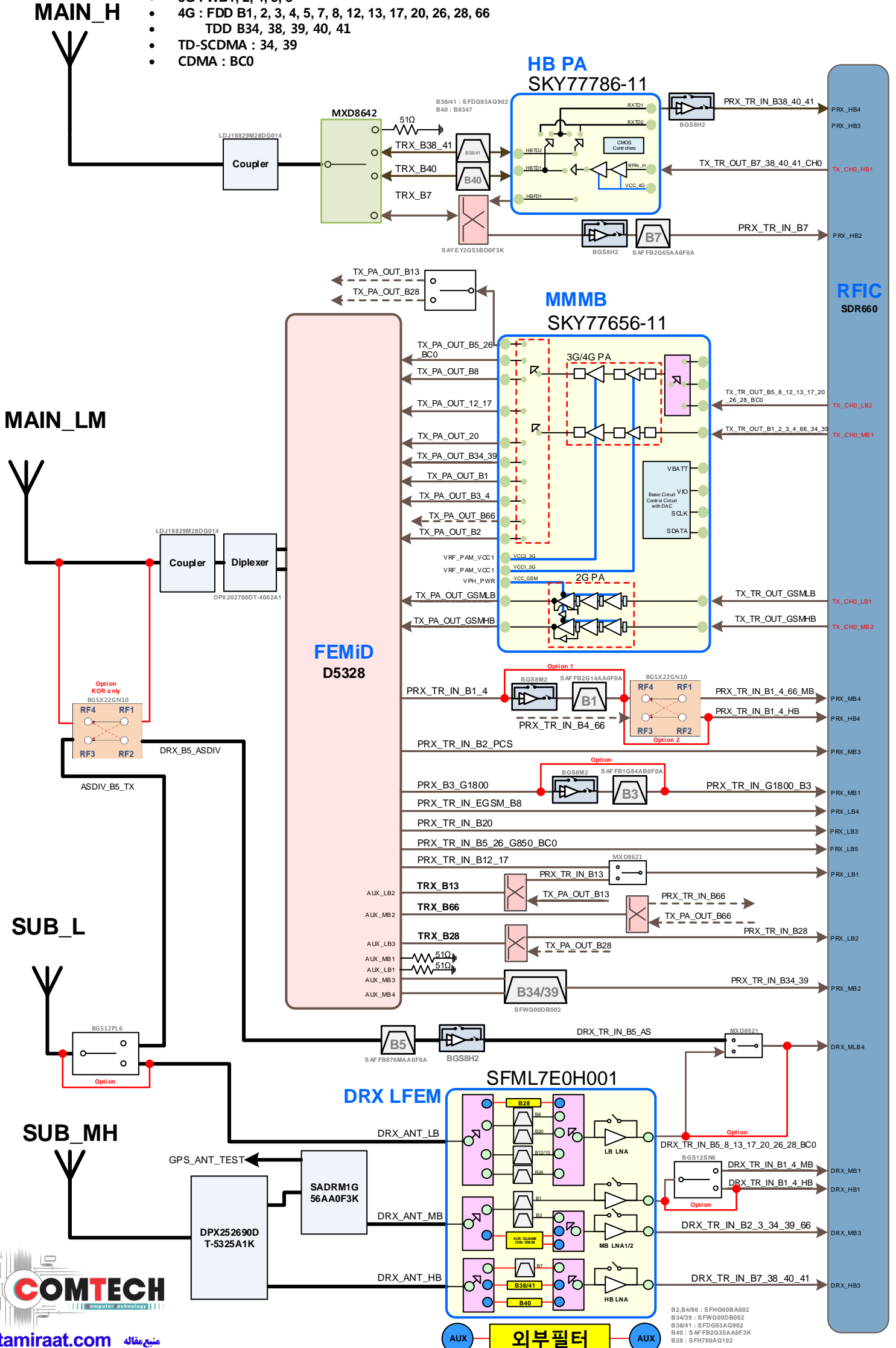




# SM-A920F RF Block Diagram REV00

[ 지원밴드 ]

- 2G : GSM850 / GSM900 / DCS1800 / PCS1900
- 3G : WB1, 2, 4, 5, 8
- 4G : FDD B1, 2, 3, 4, 5, 7, 8, 12, 13, 17, 20, 26, 28, 66
- TDD B34, 38, 39, 40, 41
- TD-SCDMA : 34, 39
- CDMA : BC0



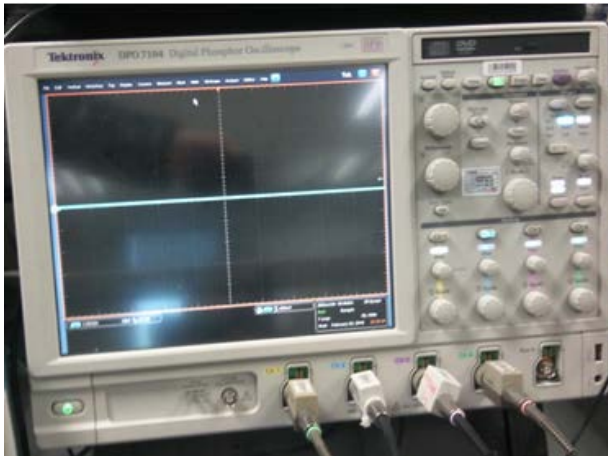






## 8. Level 3 Repair

### 8-3. Flow chart of Troubleshooting.



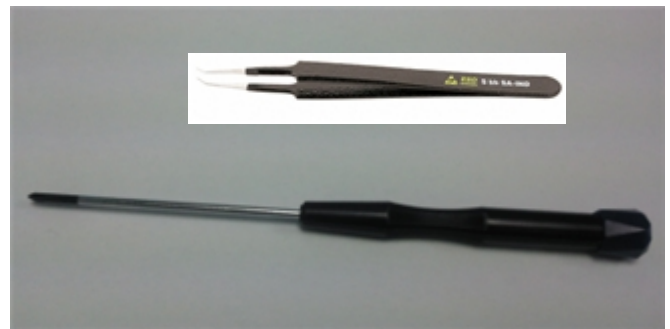
**Oscilloscope**



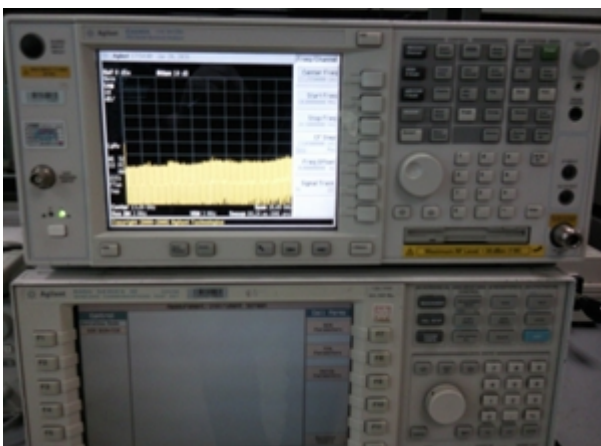
**Digital Multimeter**



**Power Supply**



**+ driver, ESD Safe Tweezer**



**8960 & Spectrum Analyzer**

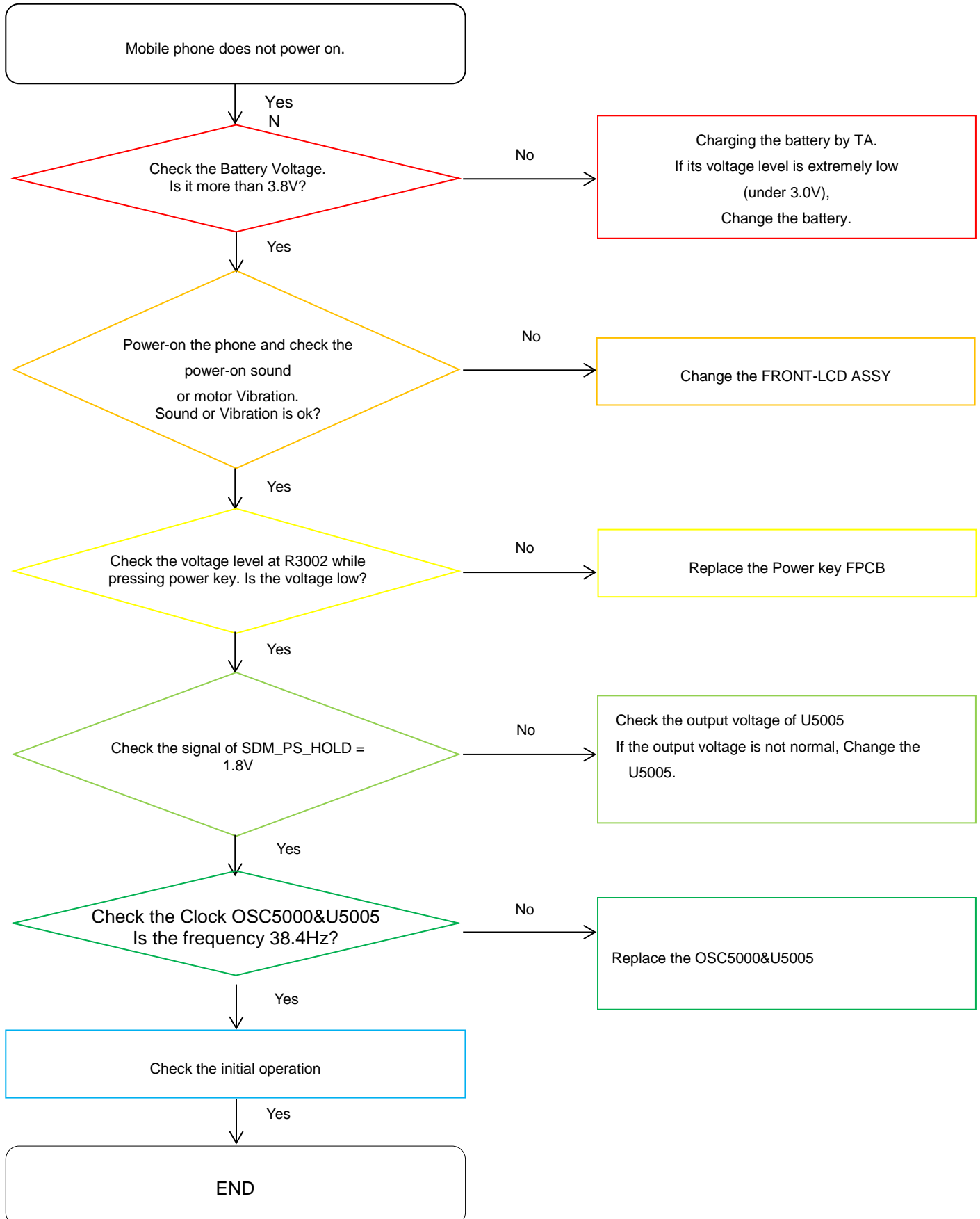


**Soldering iron**



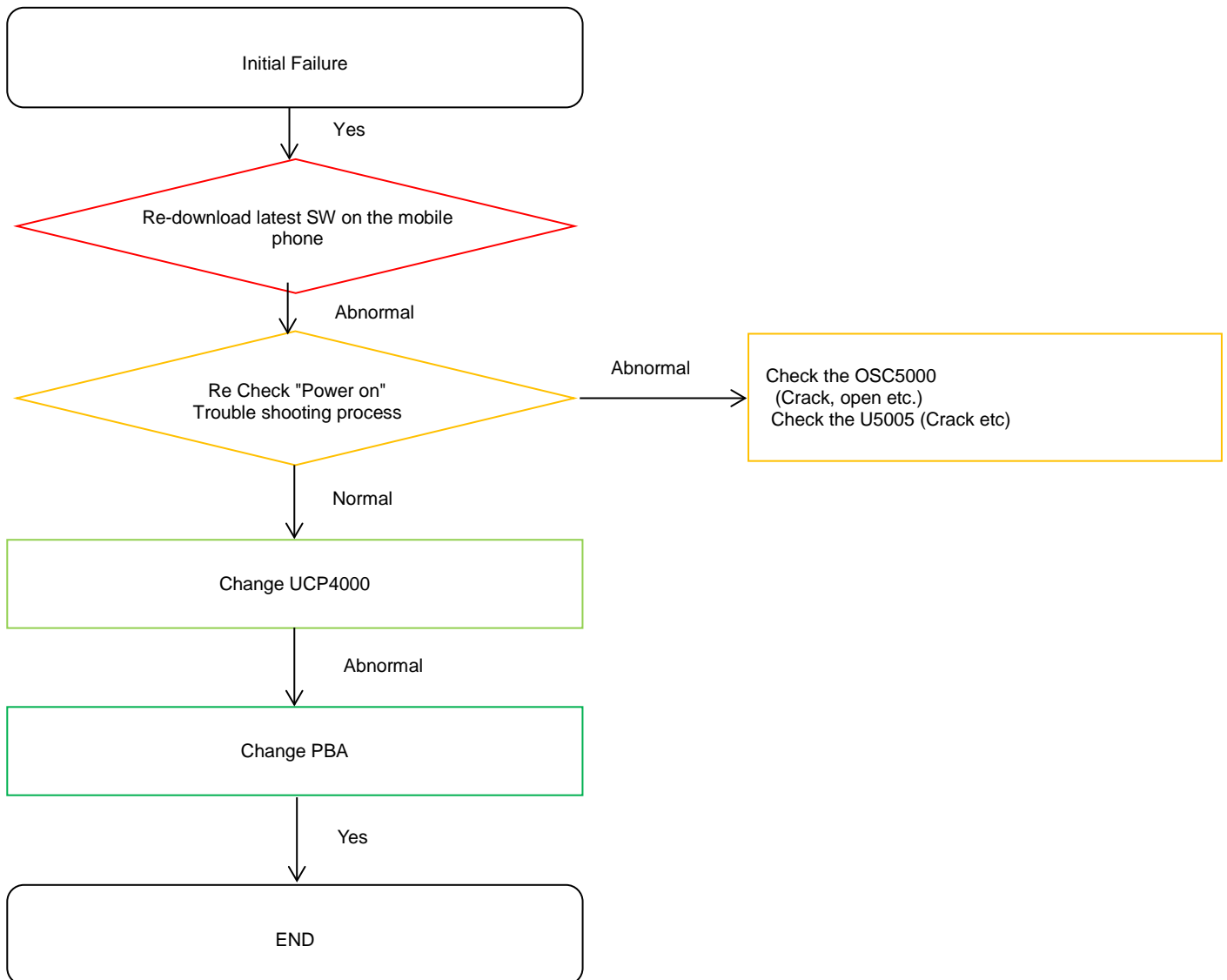
## 8. Level 3 Repair

### 8-4-1. Power On



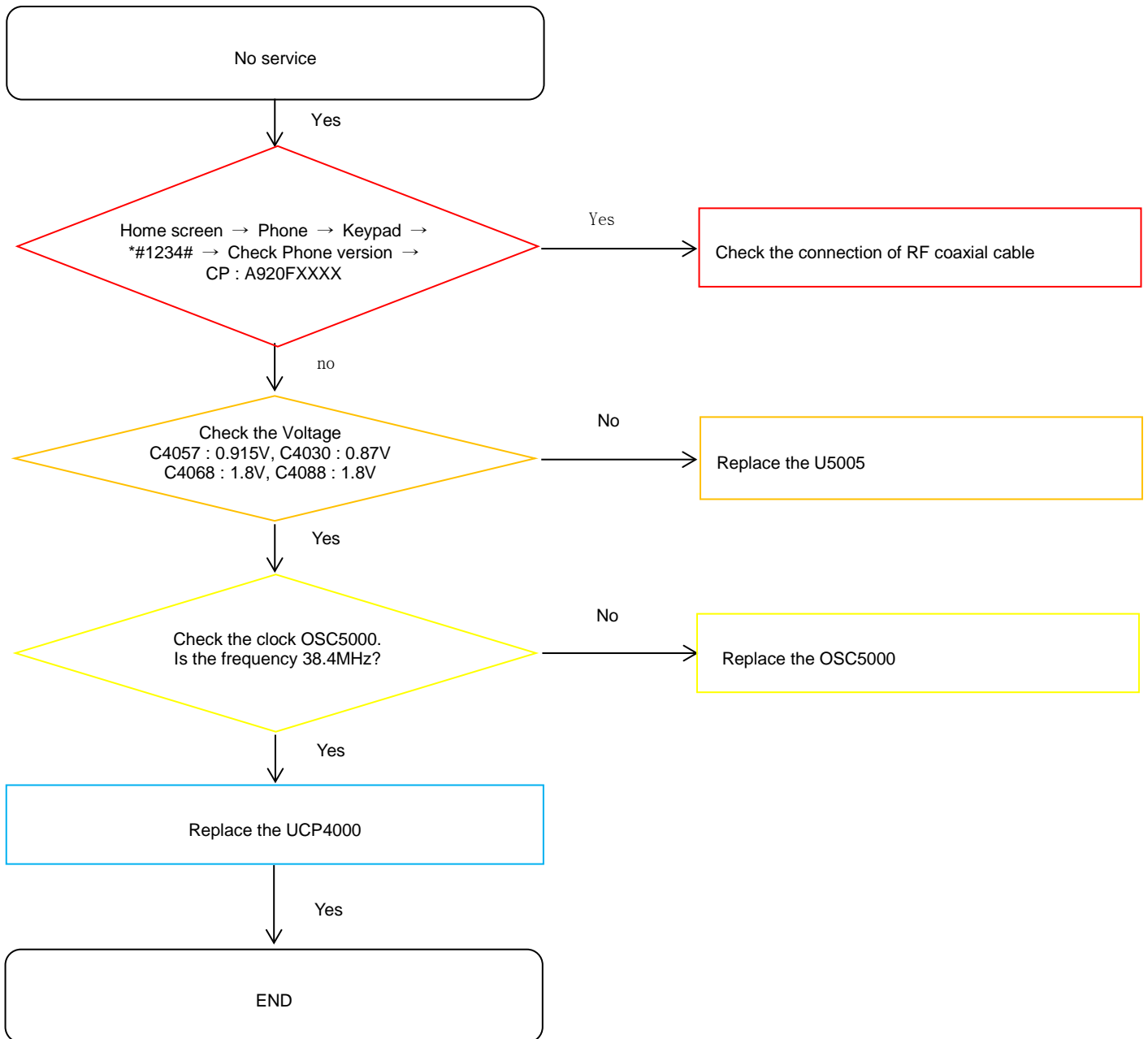
## 8. Level 3 Repair

### 8-4-2. Initial



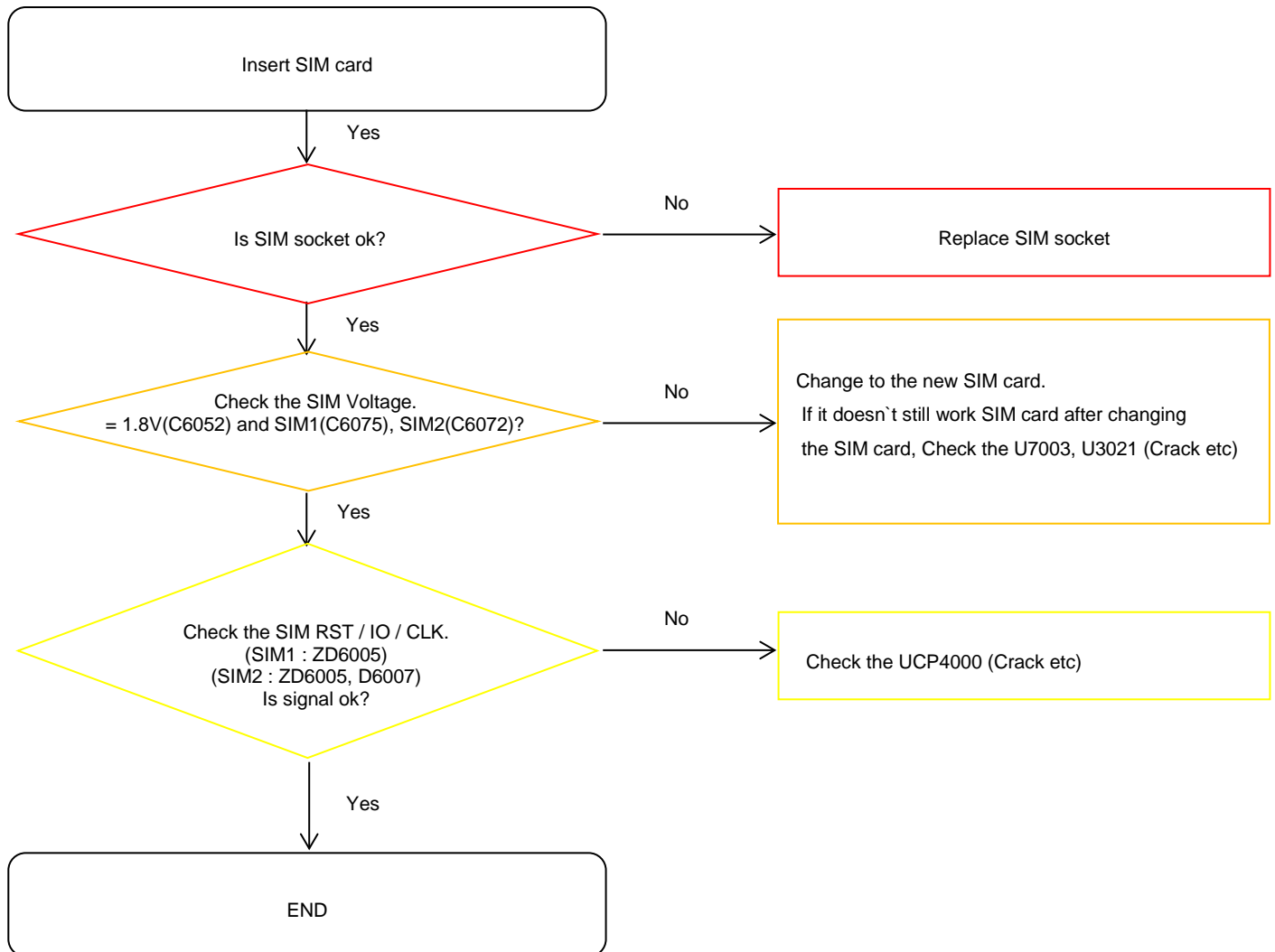
## 8. Level 3 Repair

### 8-4-3. No Service



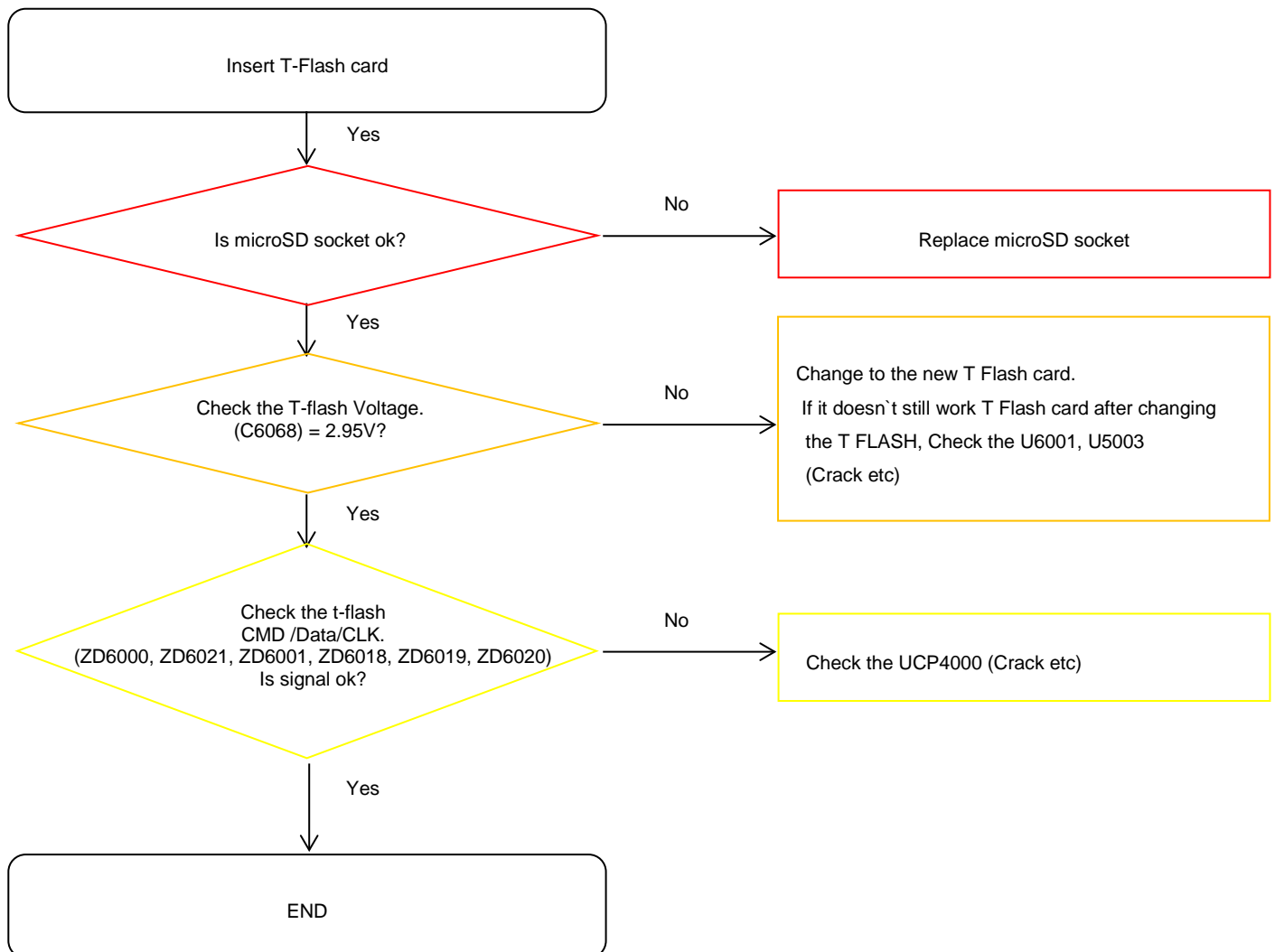
## 8. Level 3 Repair

### 8-4-4. SIM Part



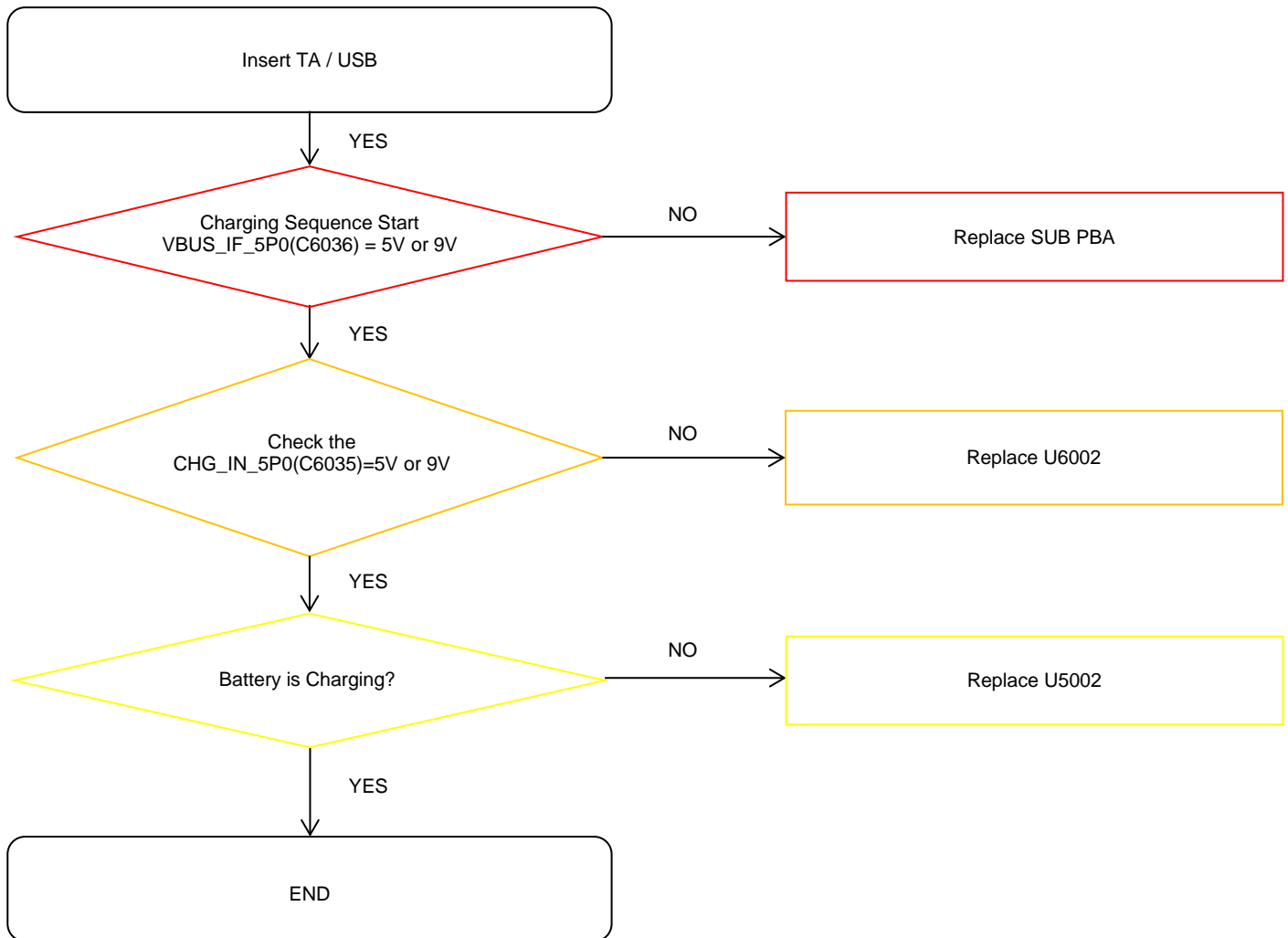
## 8. Level 3 Repair

### 8-4-5. T-Flash Part



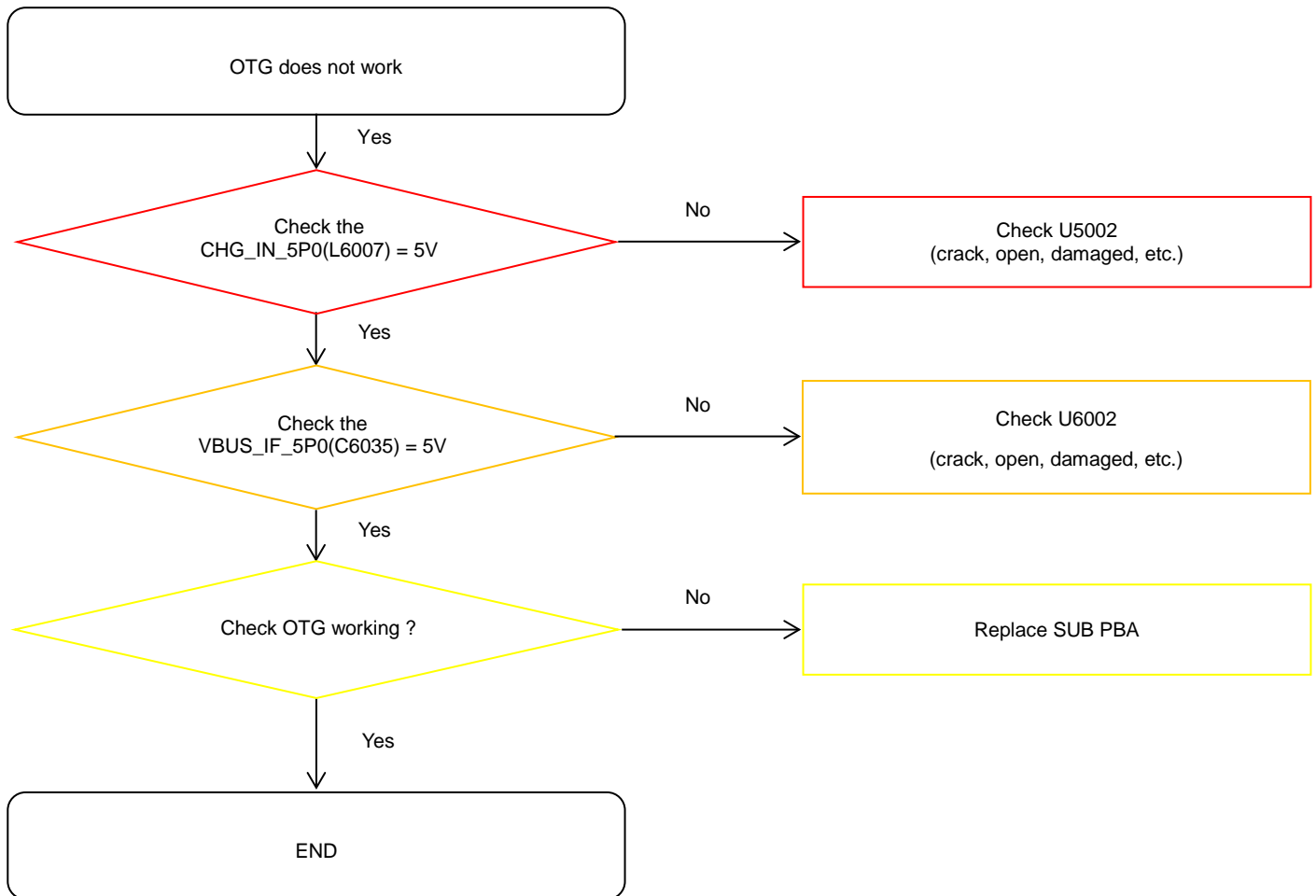
## 8. Level 3 Repair

### 8-4-6. Cable Charging Part (Normal/Fast)



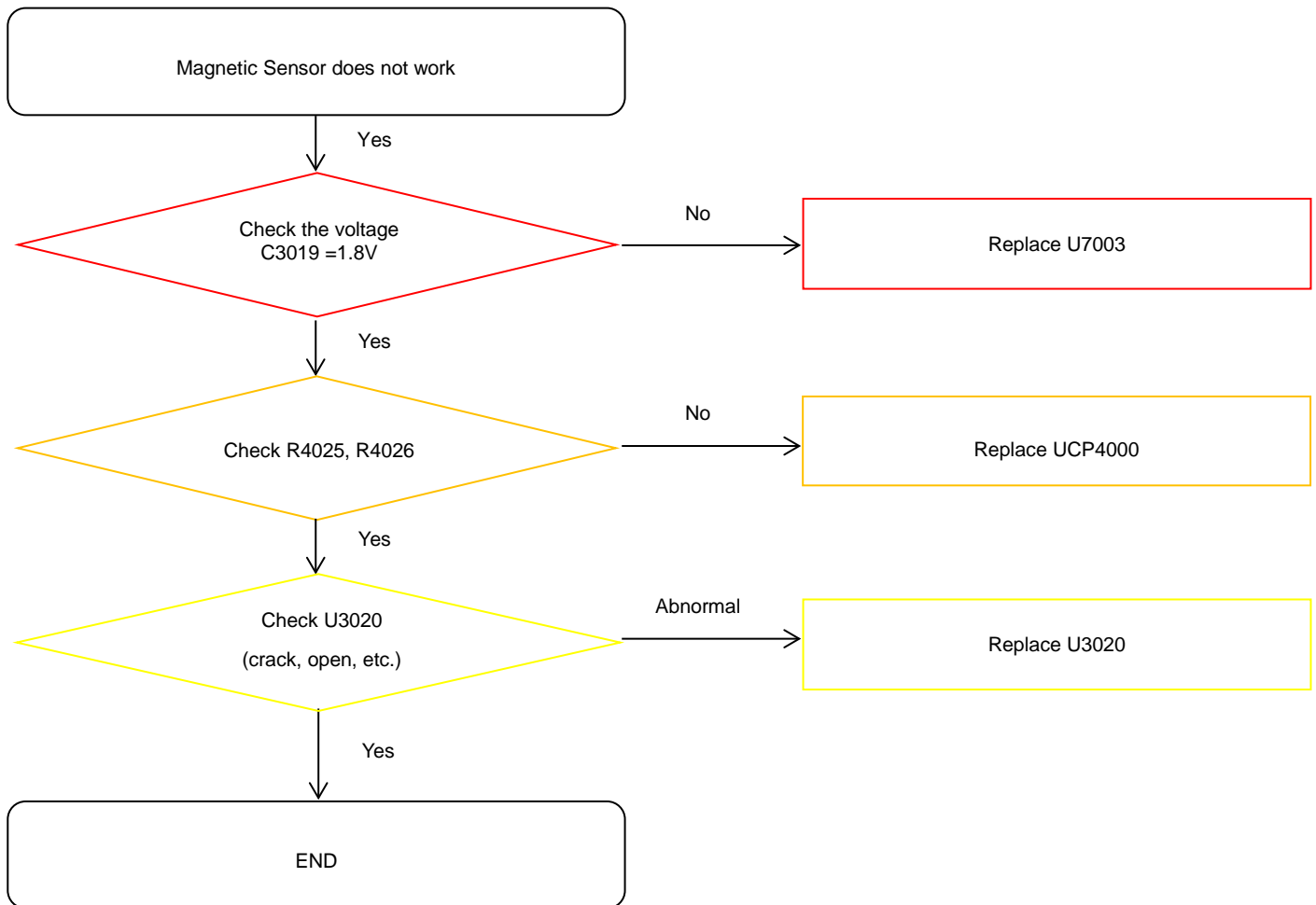
## 8. Level 3 Repair

### 8-4-7. OTG



## 8. Level 3 Repair

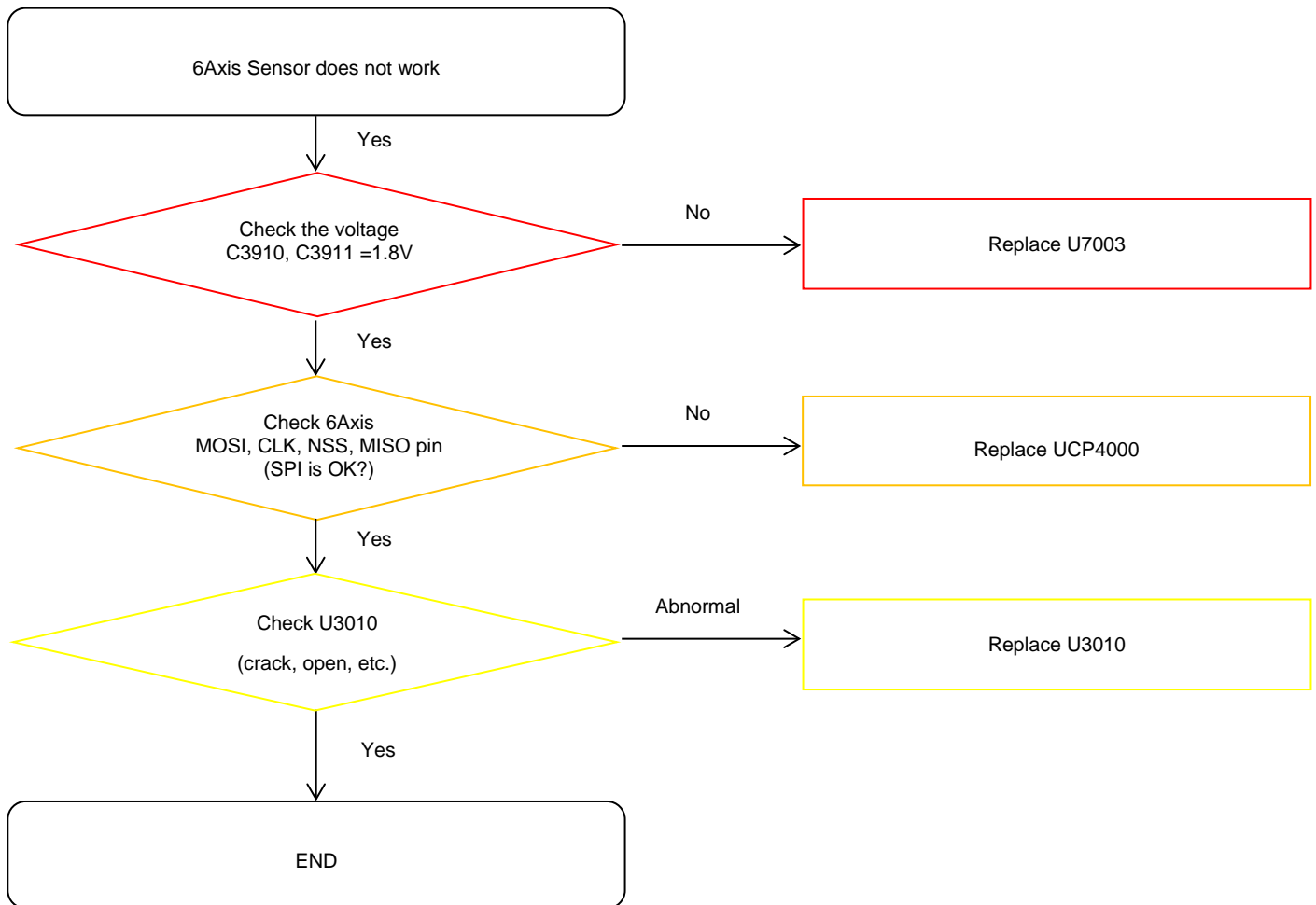
### 8-4-8-1. Magnetic Sensor





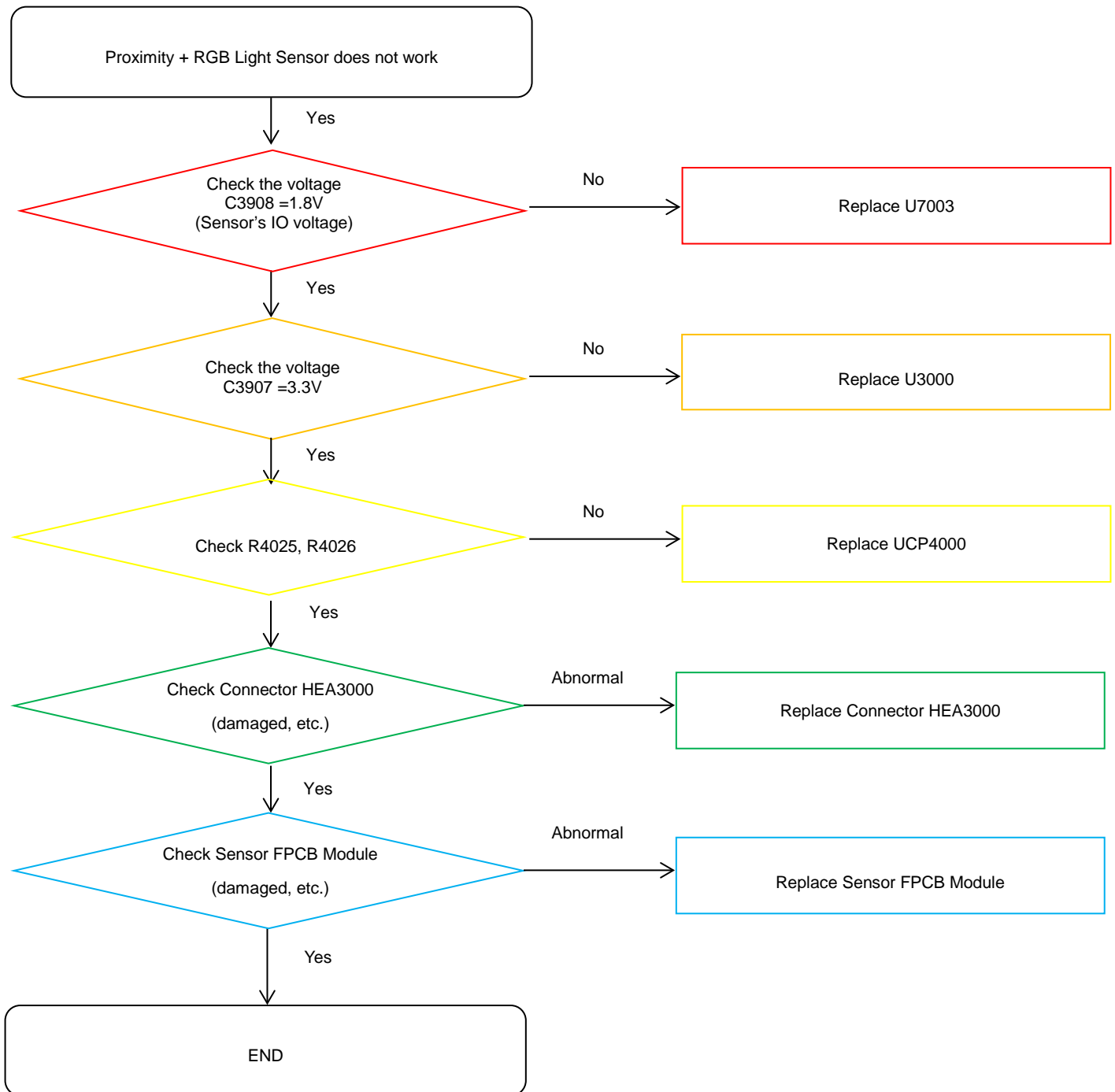
## 8. Level 3 Repair

### 8-4-8-2. 6Axis Sensor



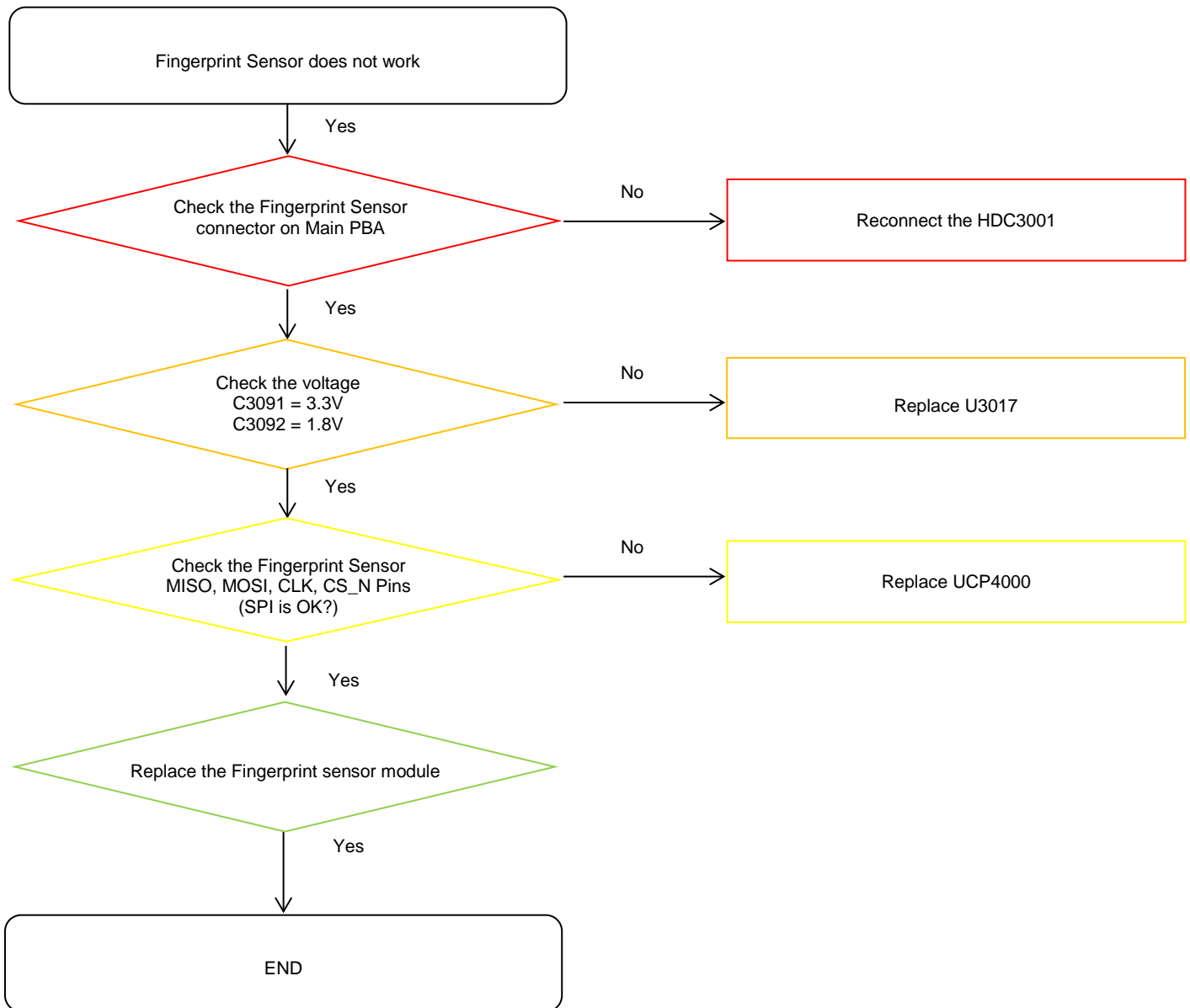
## 8. Level 3 Repair

### 8-4-8-3. Proximity + RGB Light sensor



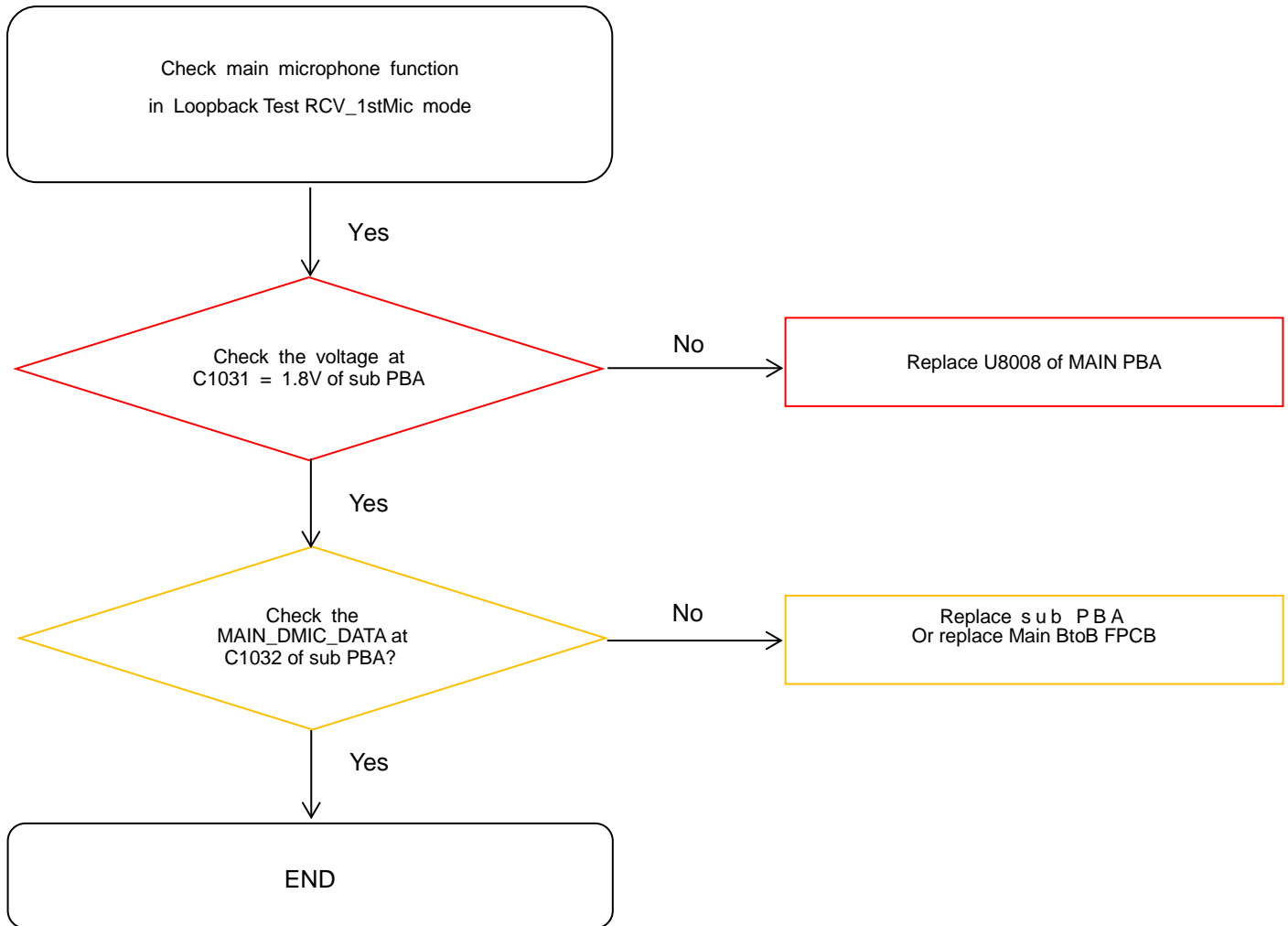
## 8. Level 3 Repair

### 8-4-8-4. Fingerprint Sensor



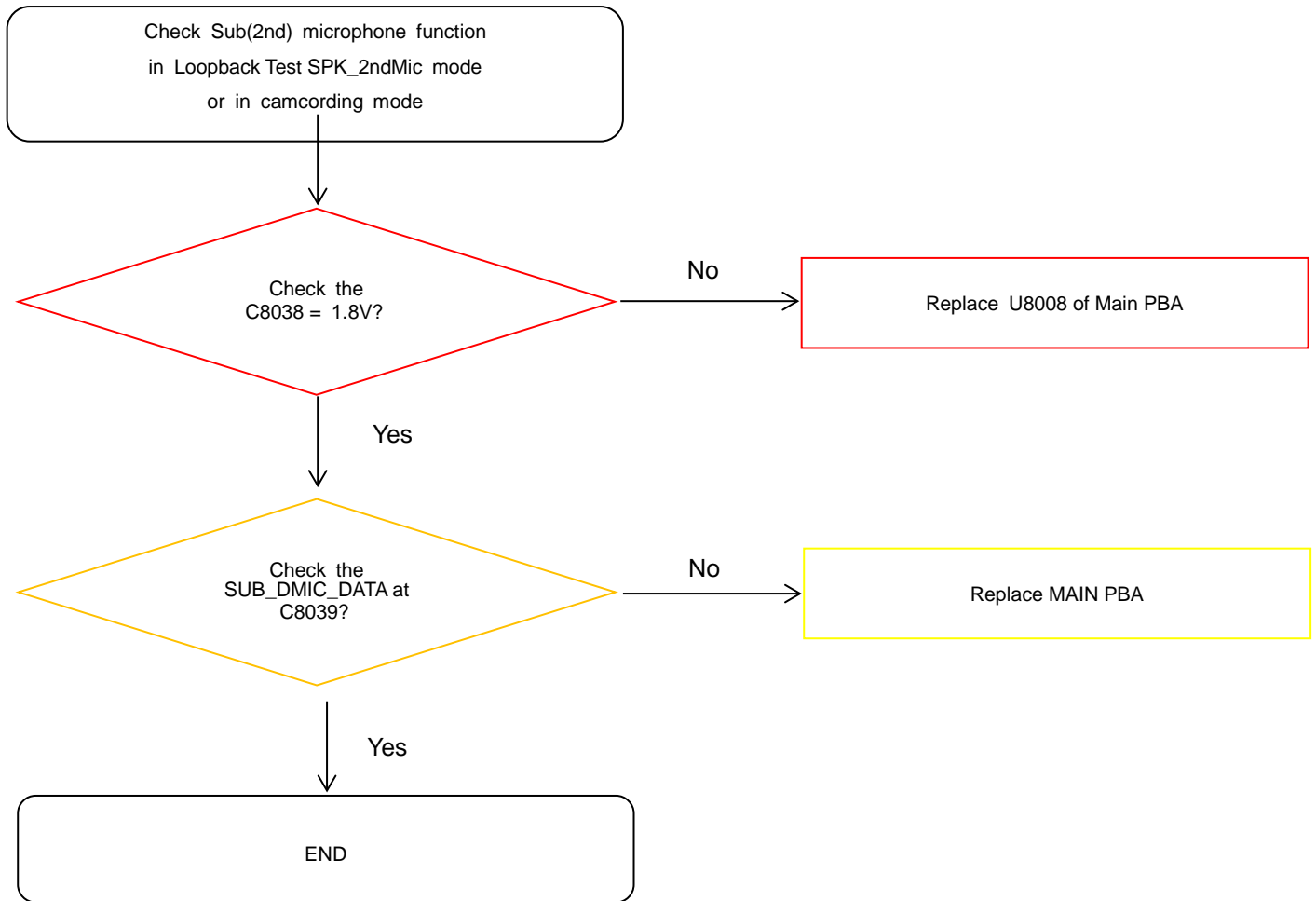
## 8. Level 3 Repair

### 8-4-9-1. Microphone Part - Main MIC



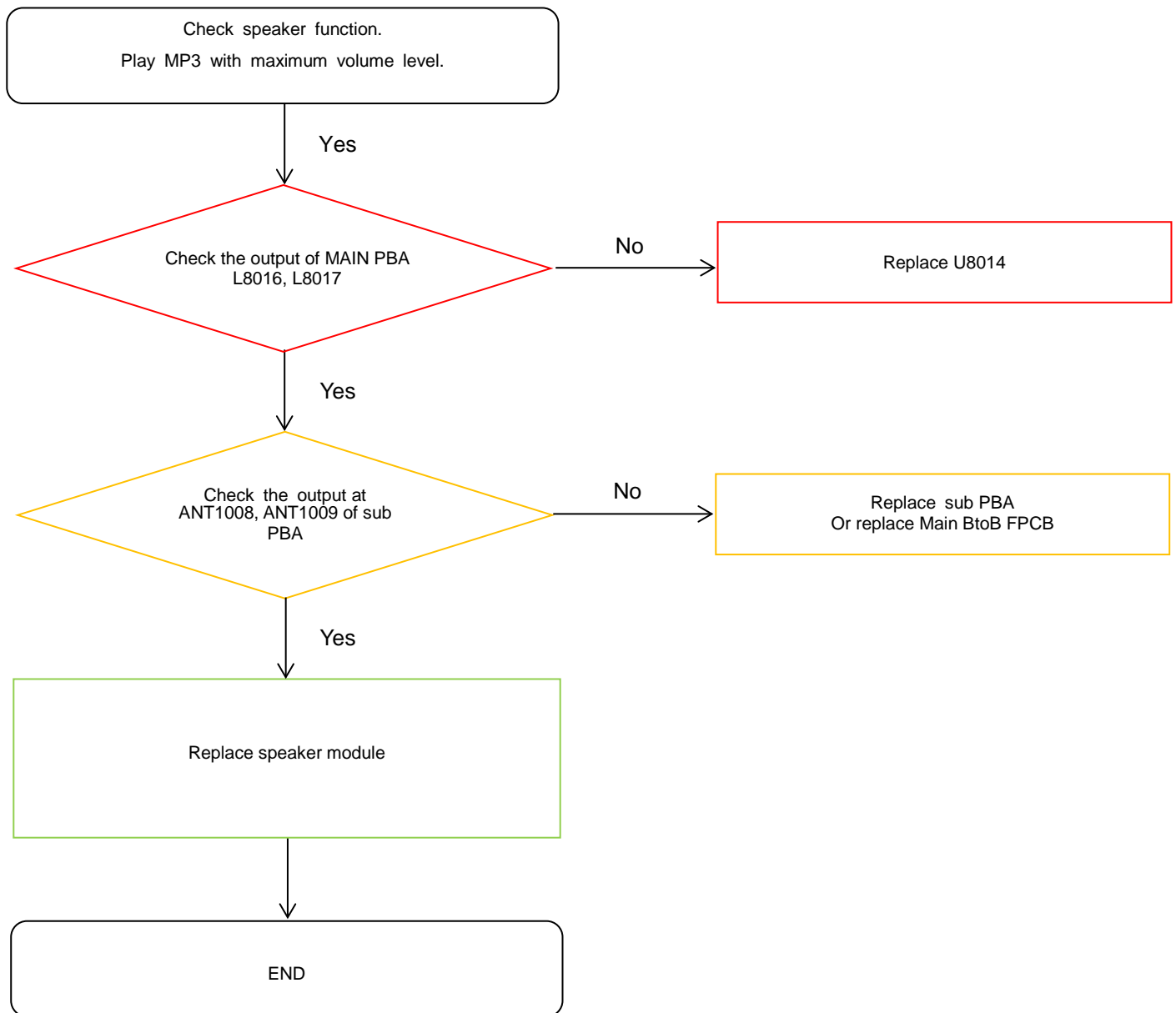
## 8. Level 3 Repair

### 8-4-9-2. Microphone Part - Sub(2nd) MIC



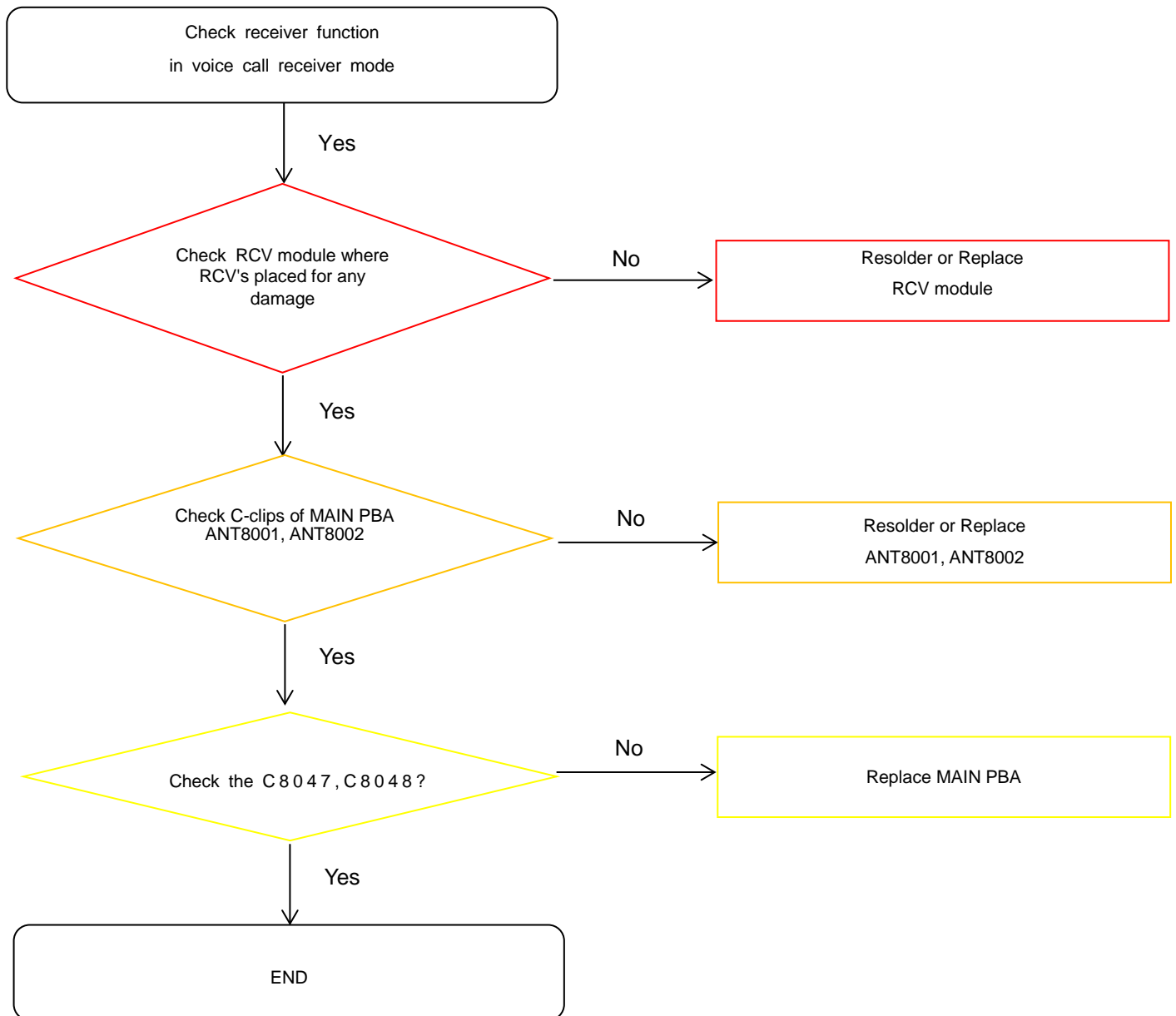
## 8. Level 3 Repair

### 8-4-10. Speaker Part



## 8. Level 3 Repair

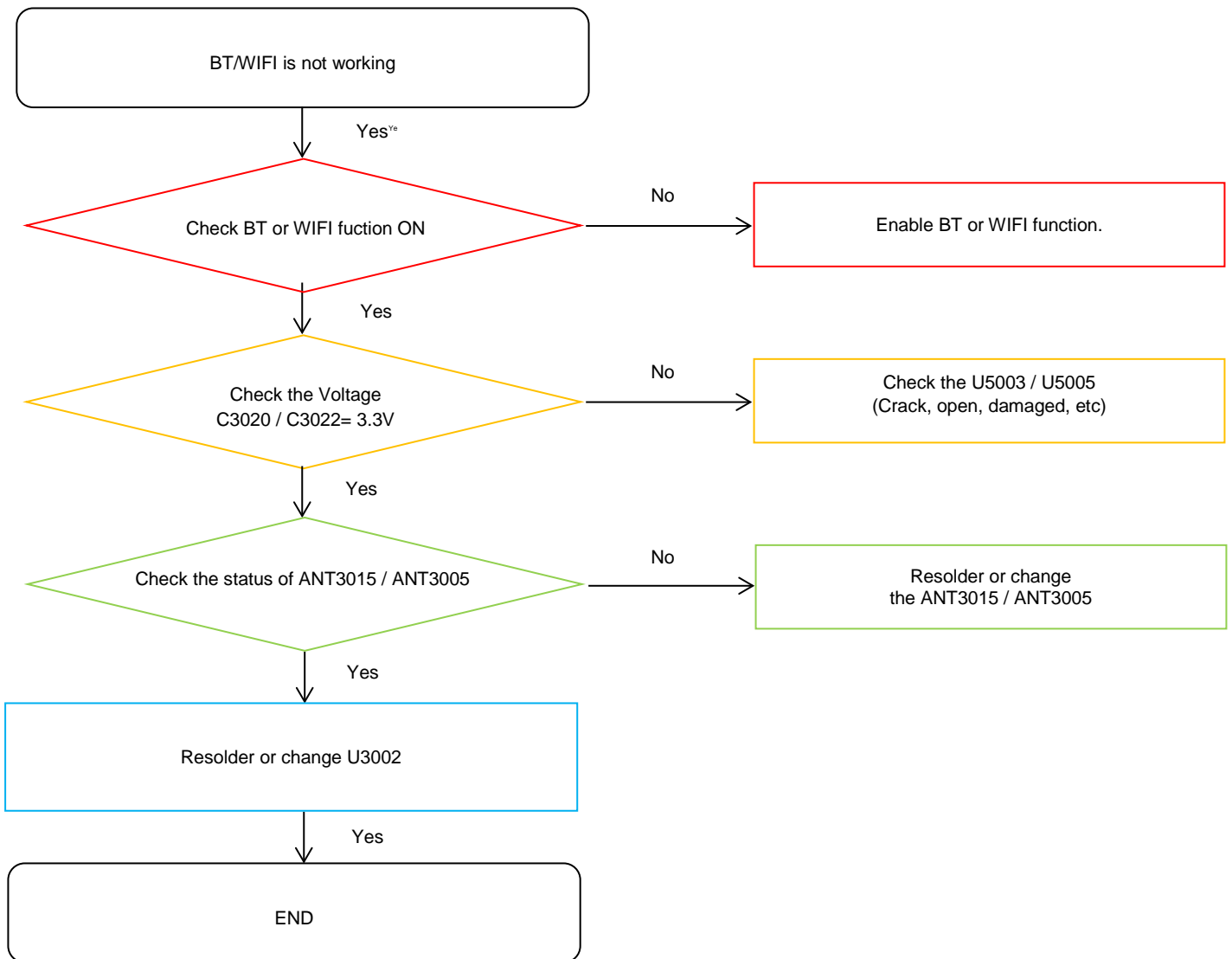
### 8-4-11. Receiver Part





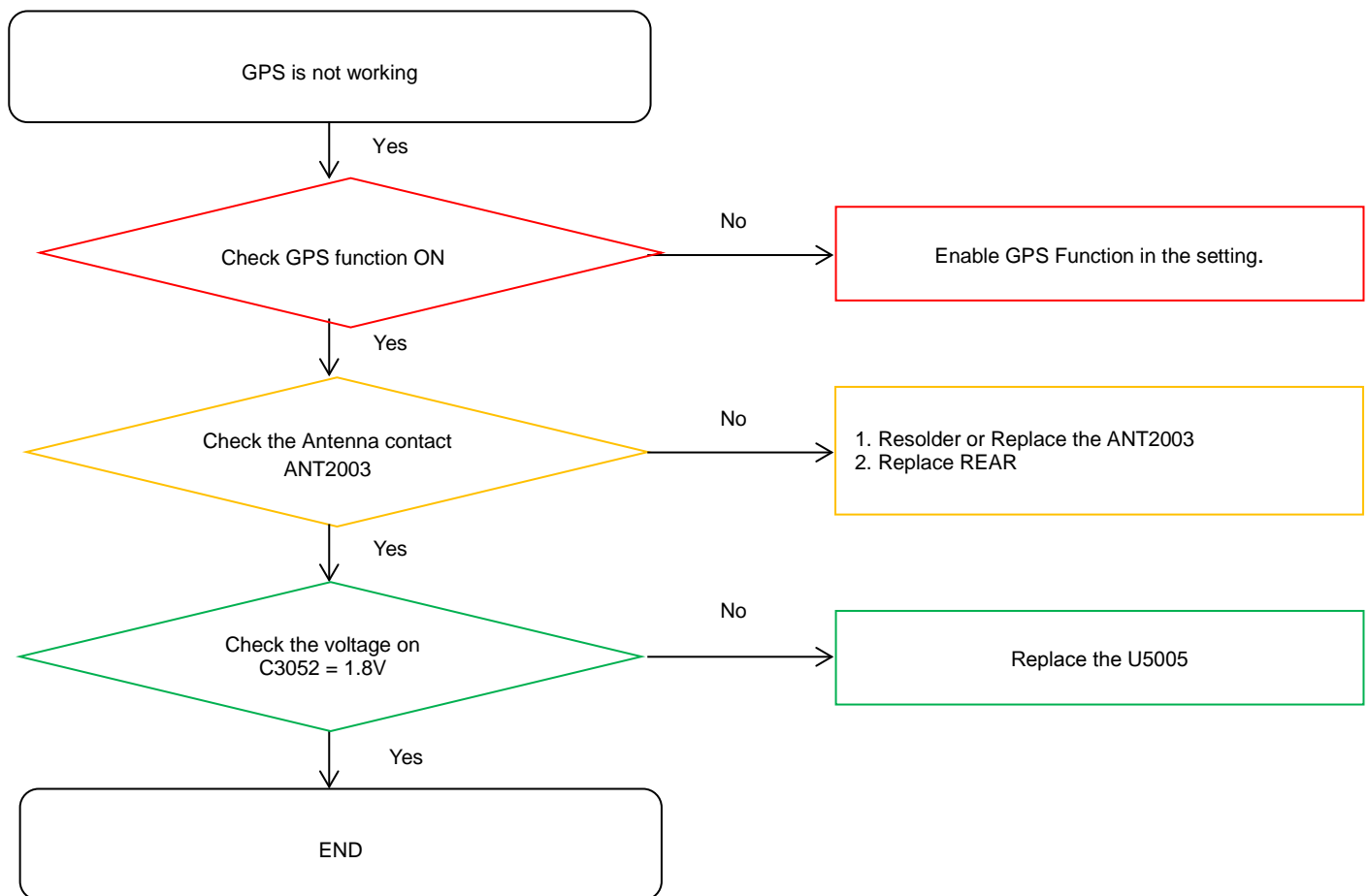
## 8. Level 3 Repair

### 8-4-12. BT/WIFI



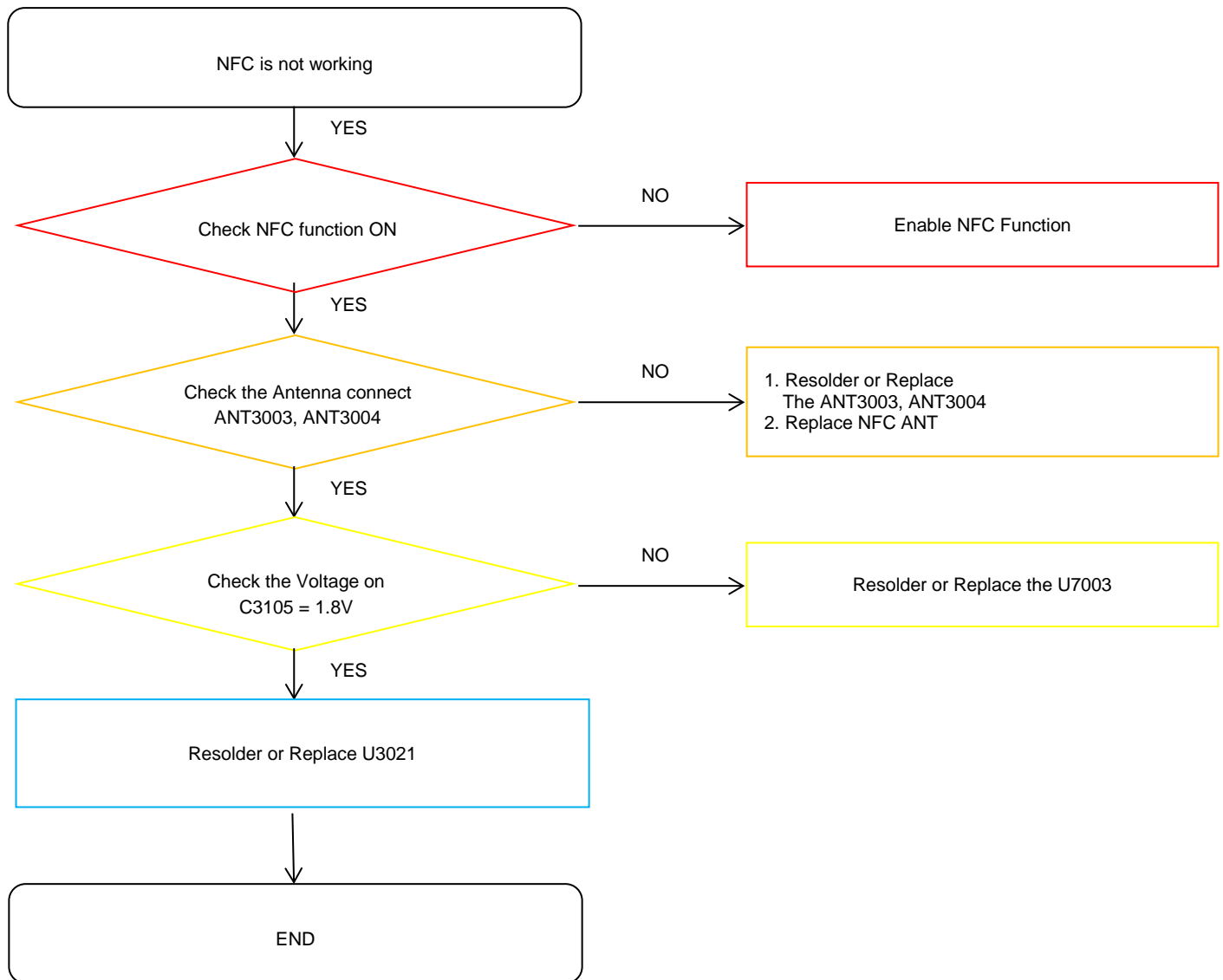
## 8. Level 3 Repair

### 8-4-13. GPS



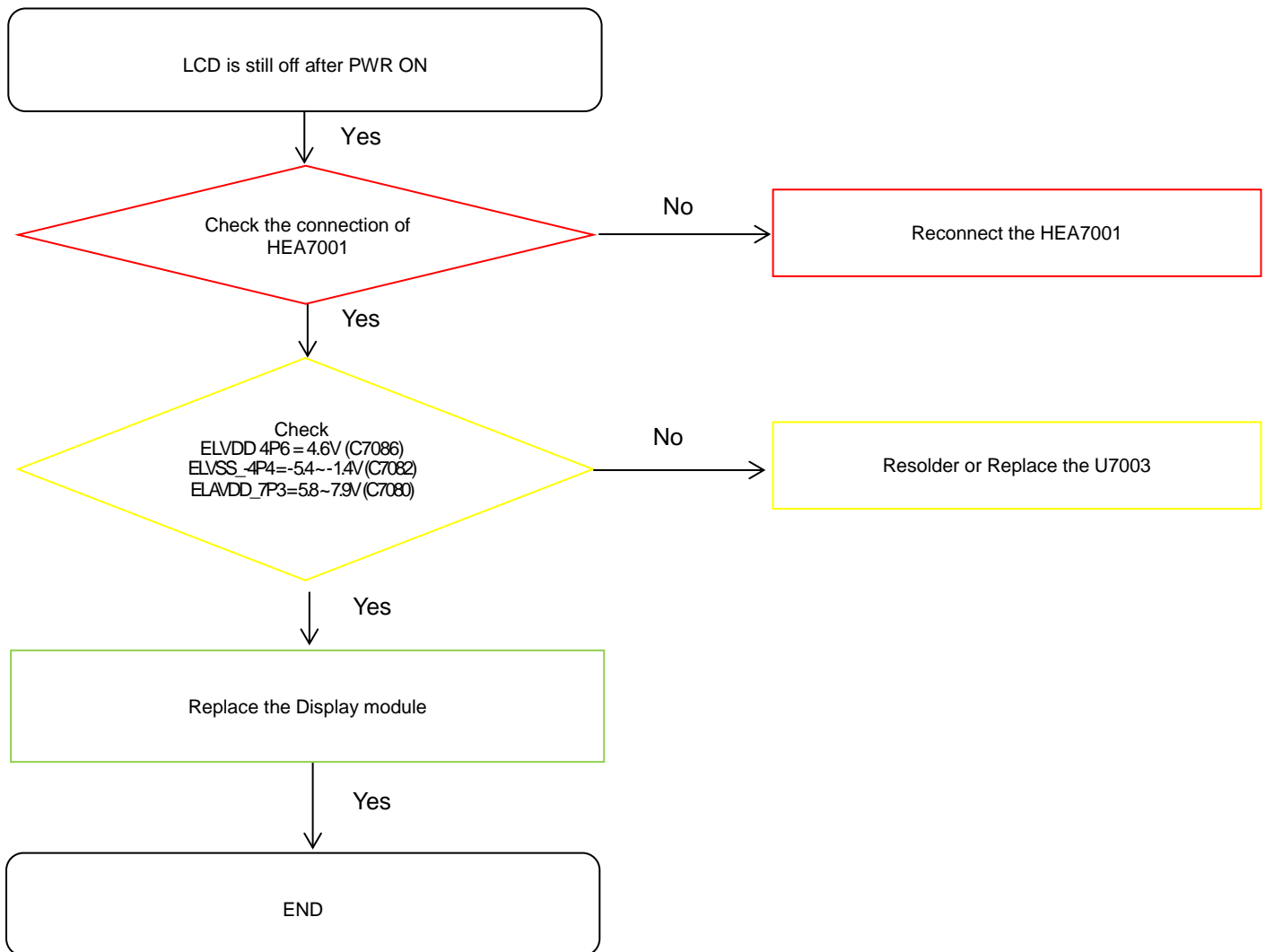
## 8. Level 3 Repair

### 8-4-14. NFC



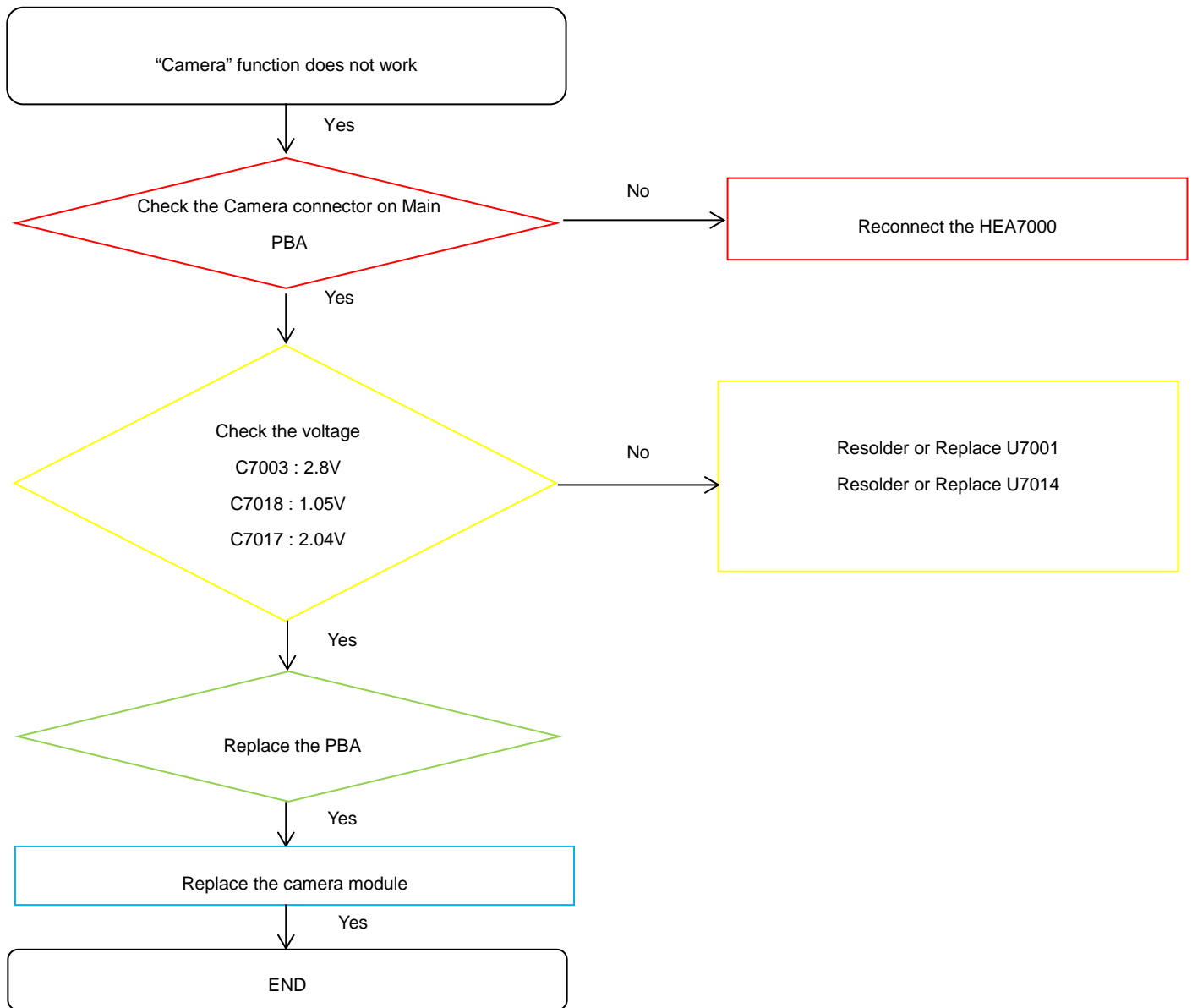
## 8. Level 3 Repair

### 8-4-15. Display



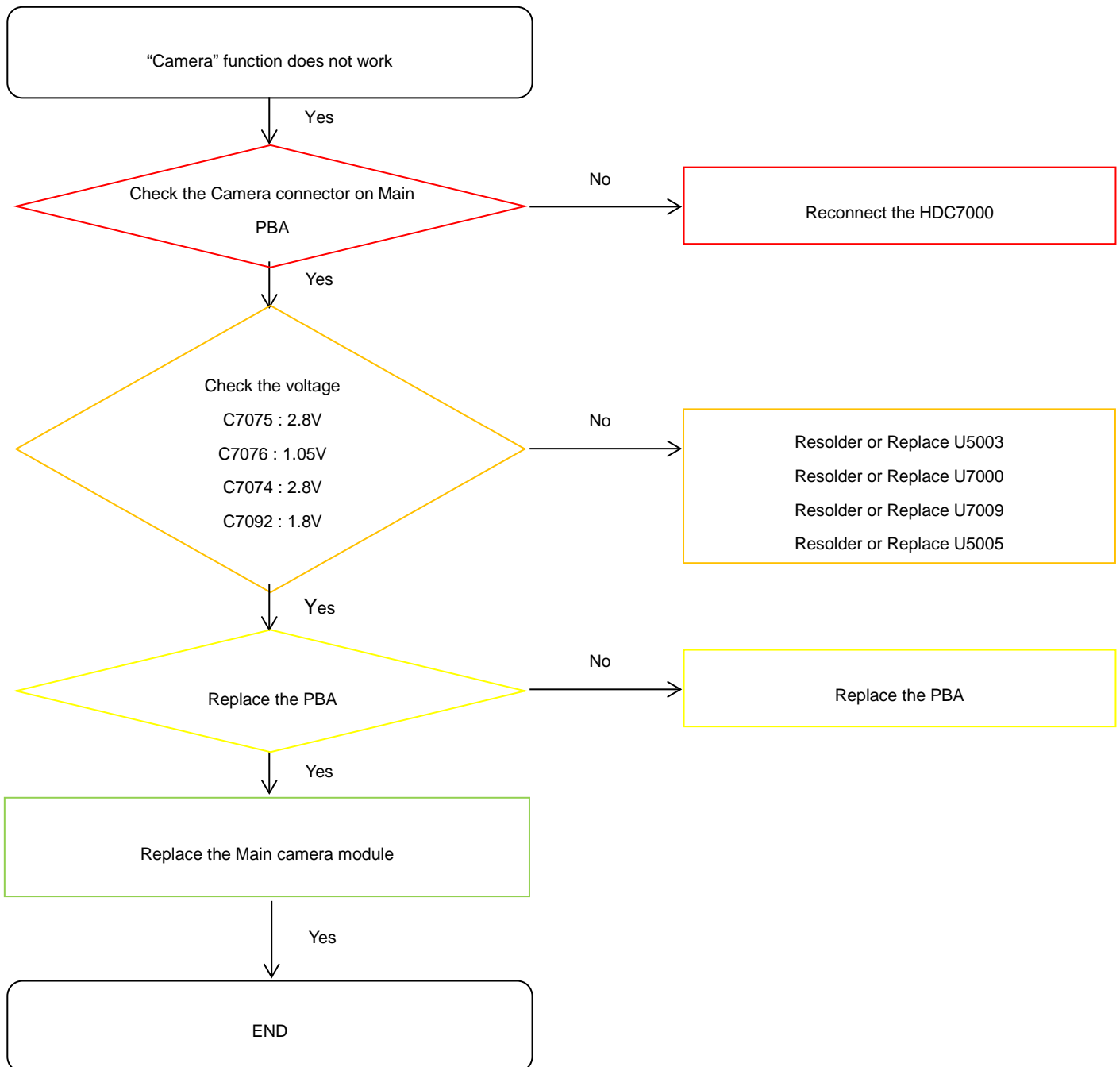
## 8. Level 3 Repair

### 8-4-16. 24M CAMERA(FRONT CAMERA)



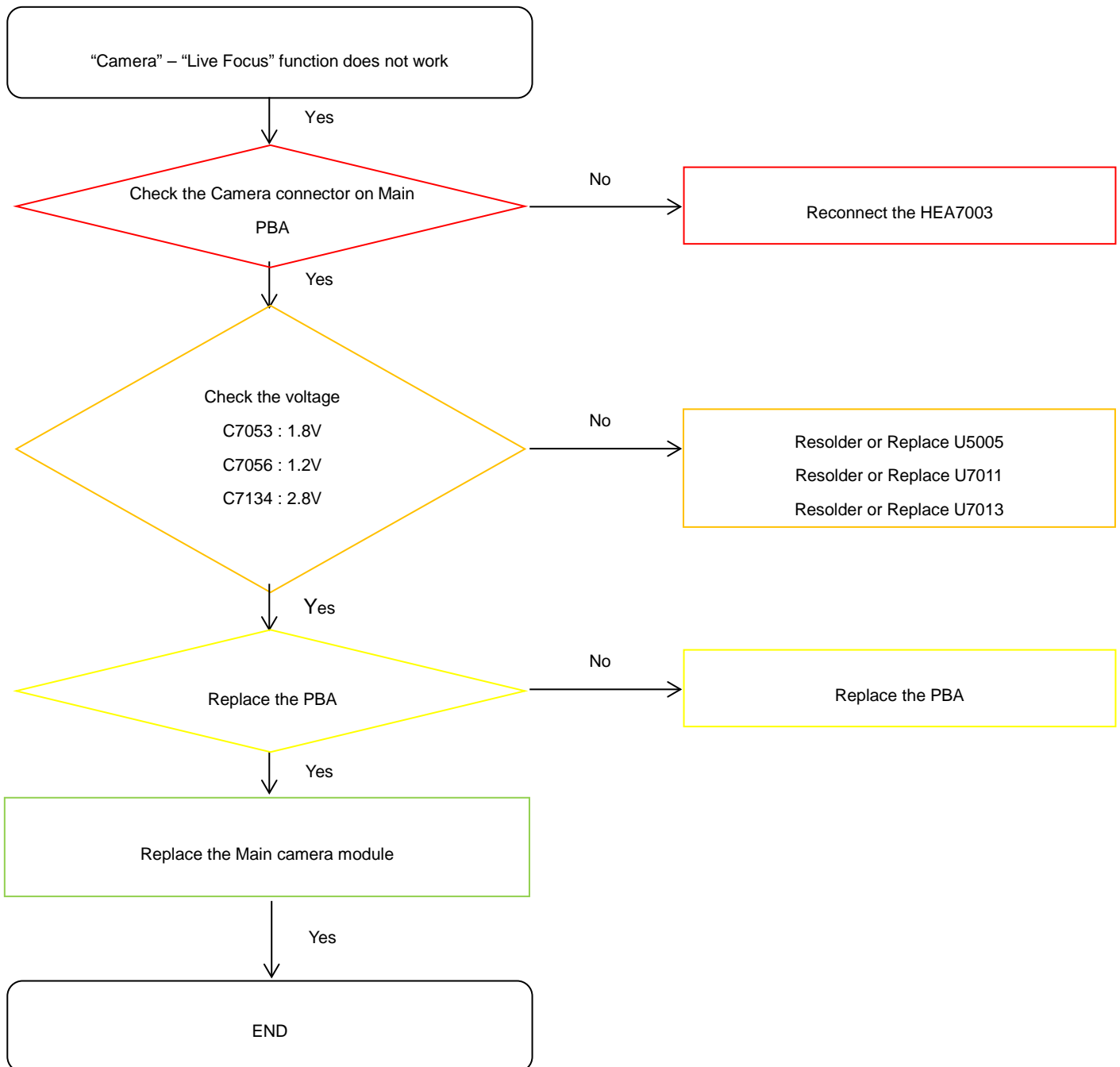
## 8. Level 3 Repair

### 8-4-17-1. QUAD CAMERA(REAR CAMERA, 24M, WIDE)



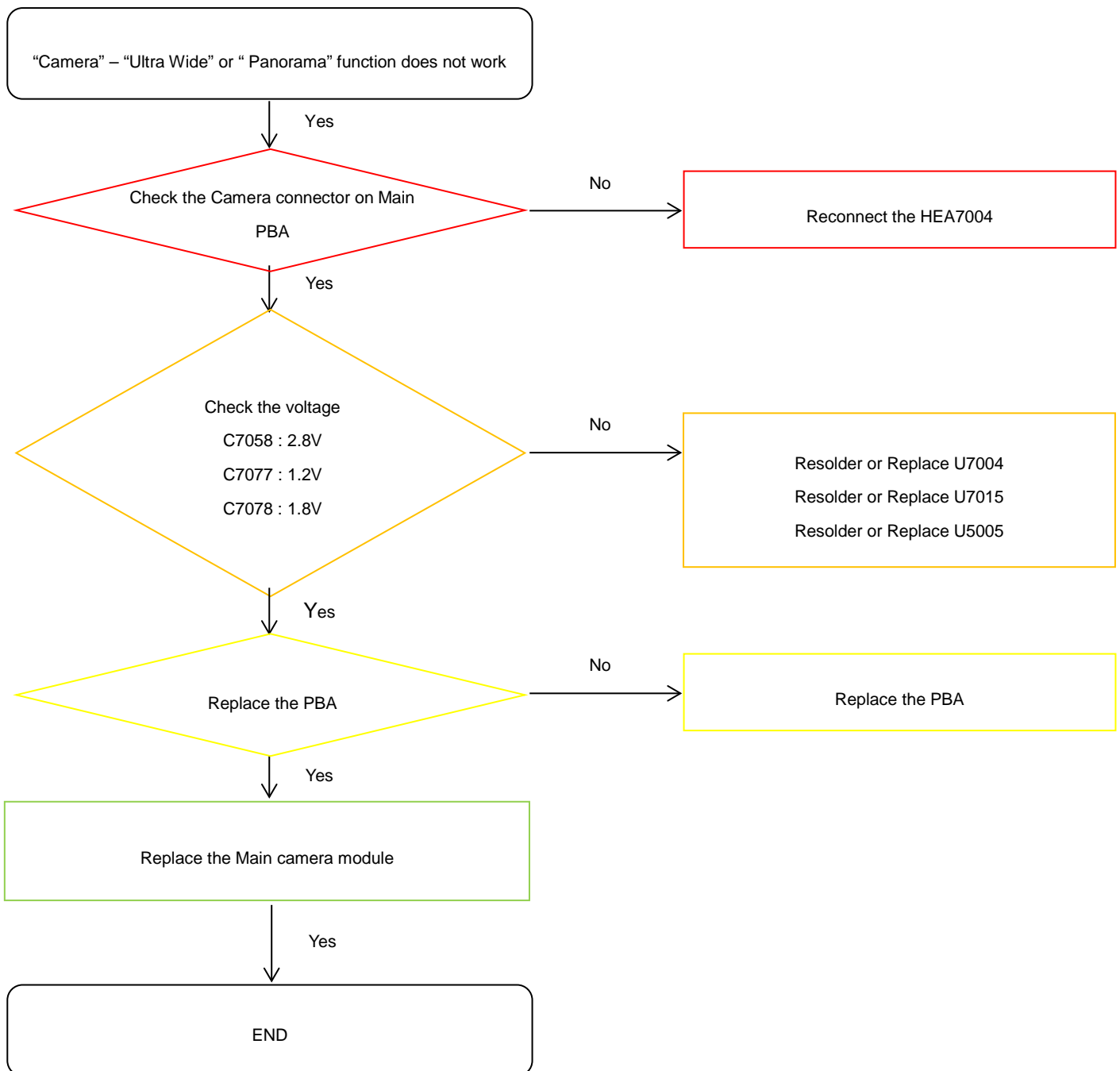
## 8. Level 3 Repair

### 8-4-17-2. QUAD CAMERA(REAR CAMERA, 5M, DEPTH)



## 8. Level 3 Repair

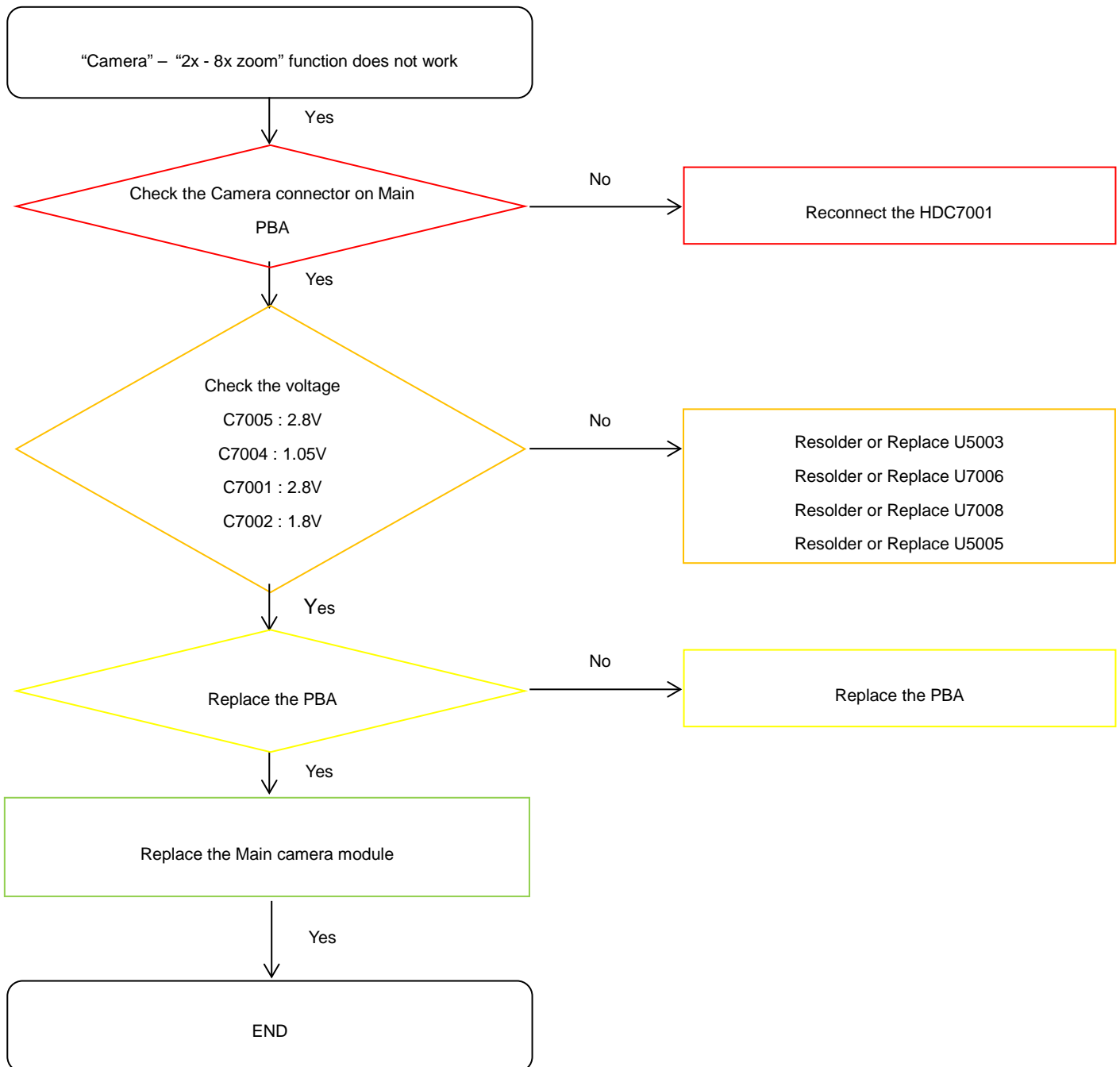
### 8-4-17-3. QUAD CAMERA(REAR CAMERA, 8M, ULTRA WIDE)





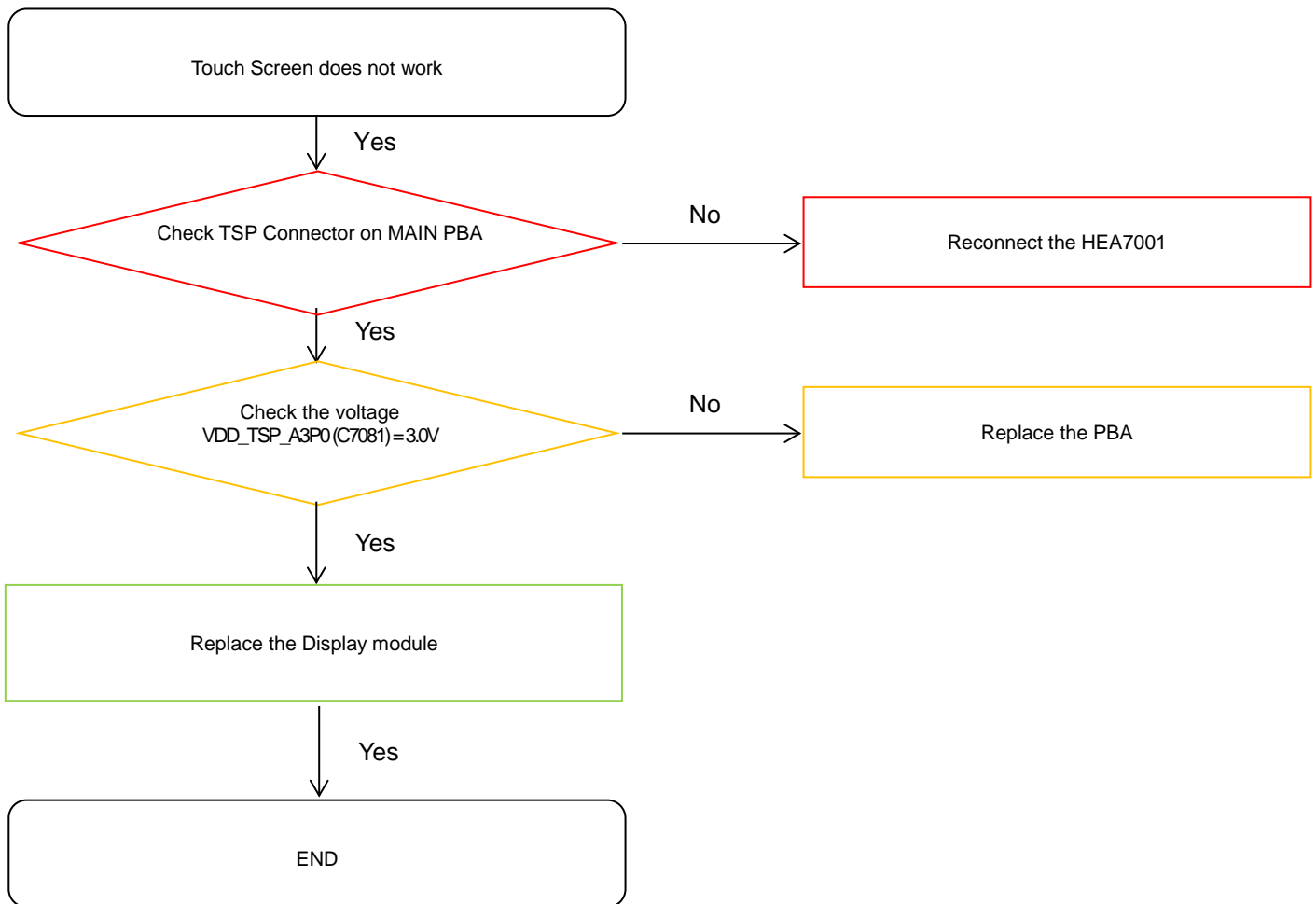
## 8. Level 3 Repair

### 8-4-17-4. QUAD CAMERA(REAR CAMERA, 10M, TELE)



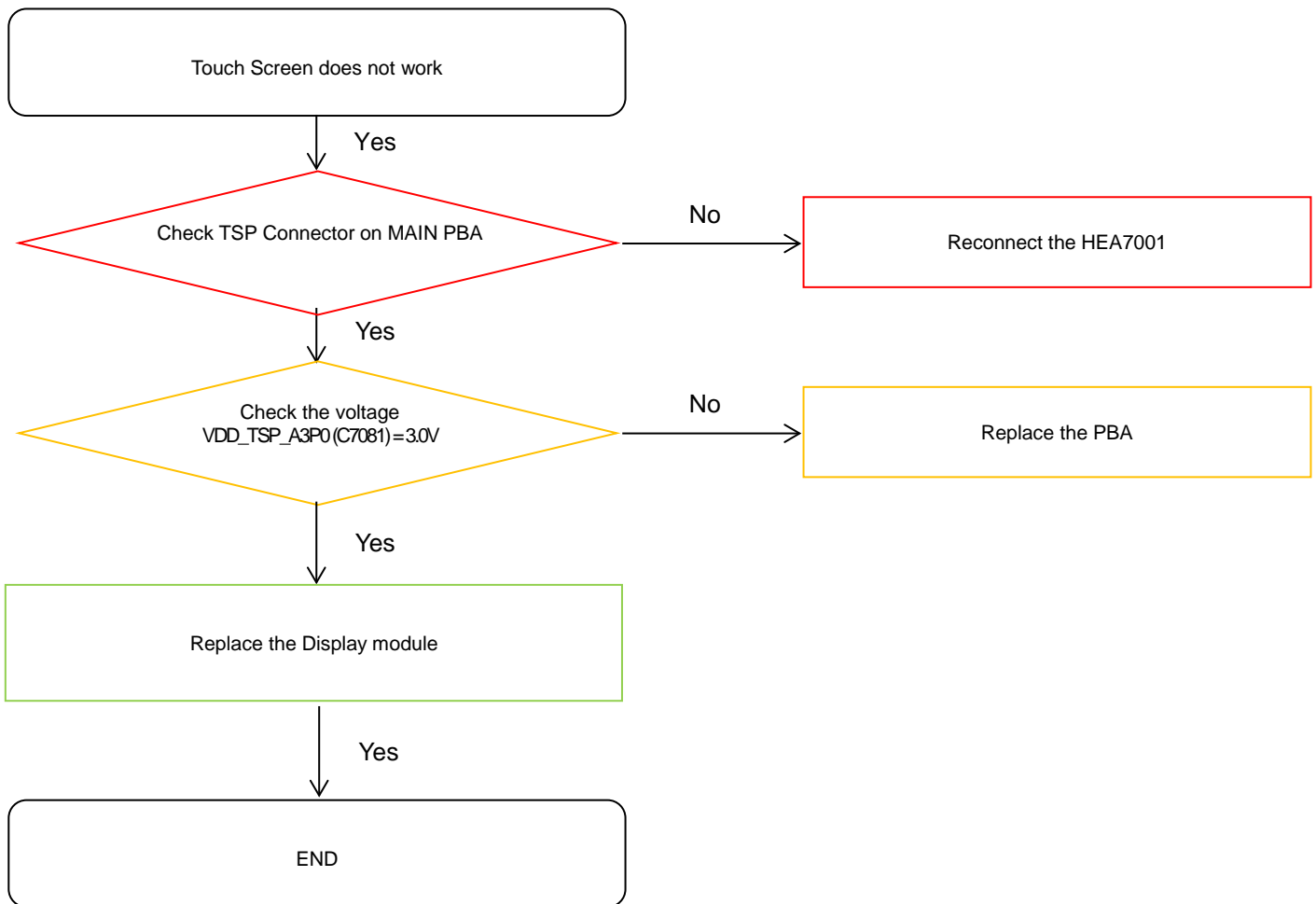
## 8. Level 3 Repair

### 8-4-18. TSP



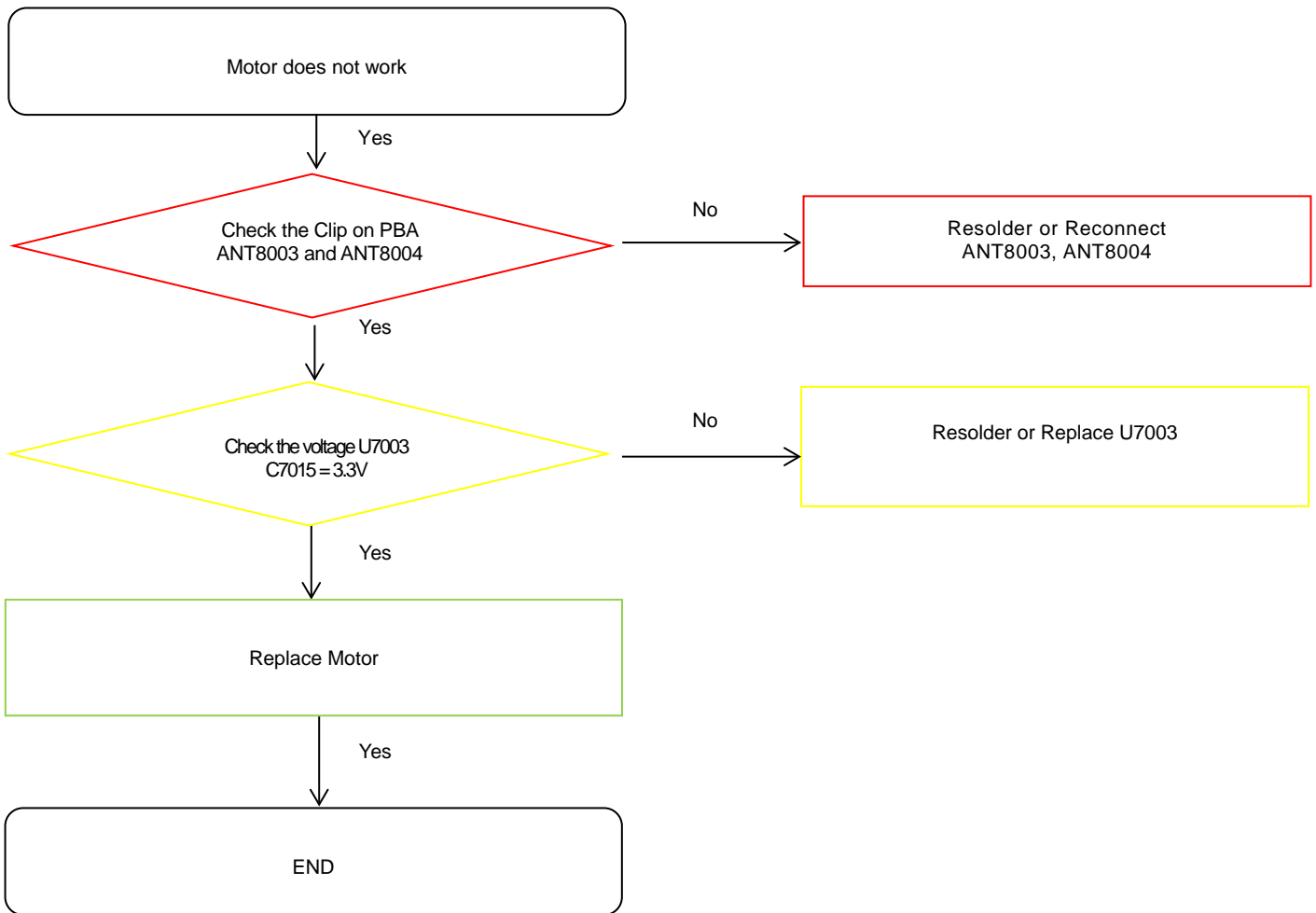
## 8. Level 3 Repair

### 8-4-19. Pressure Touch (Home Button function)



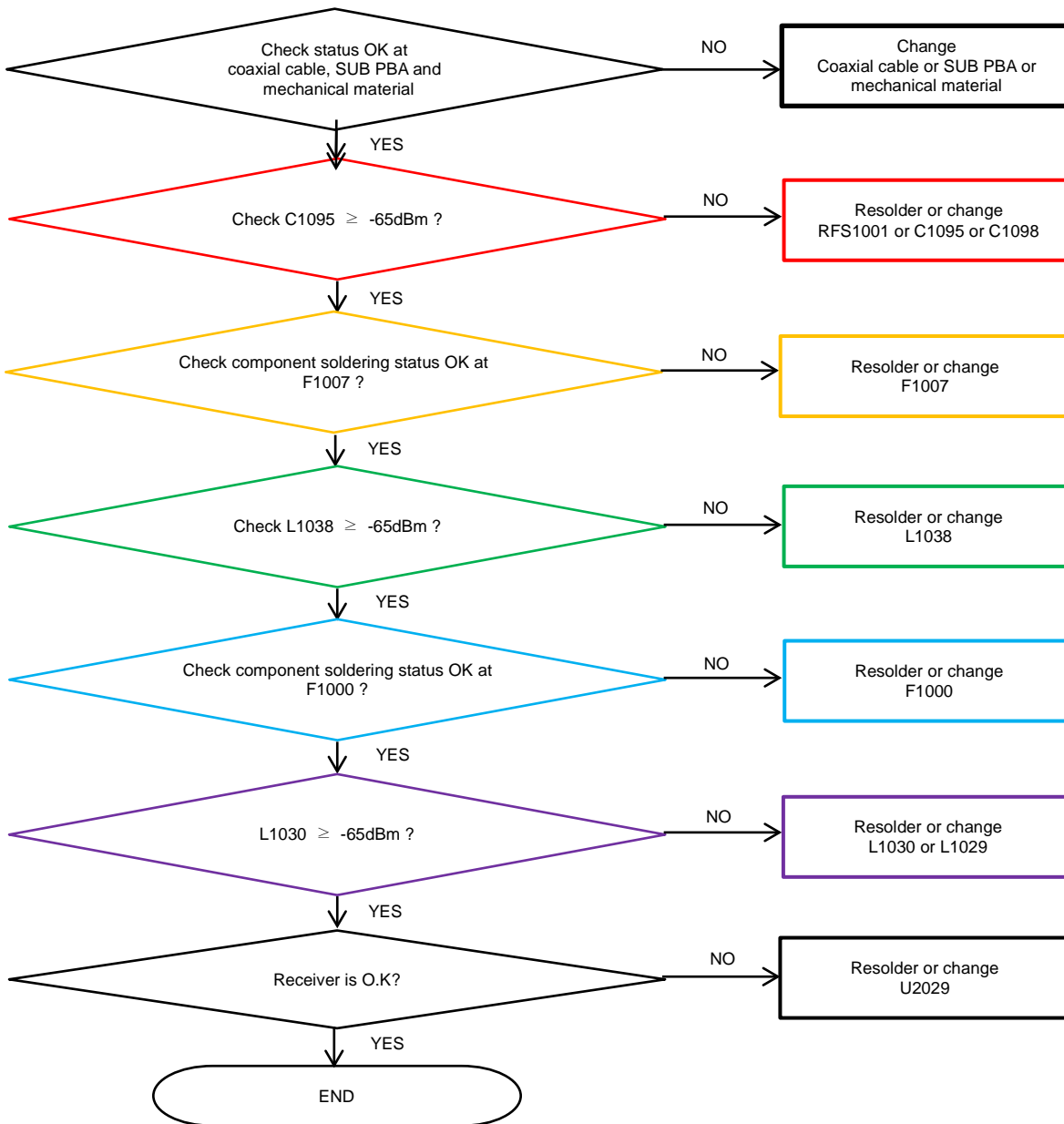
## 8. Level 3 Repair

### 8-4-20. Motor



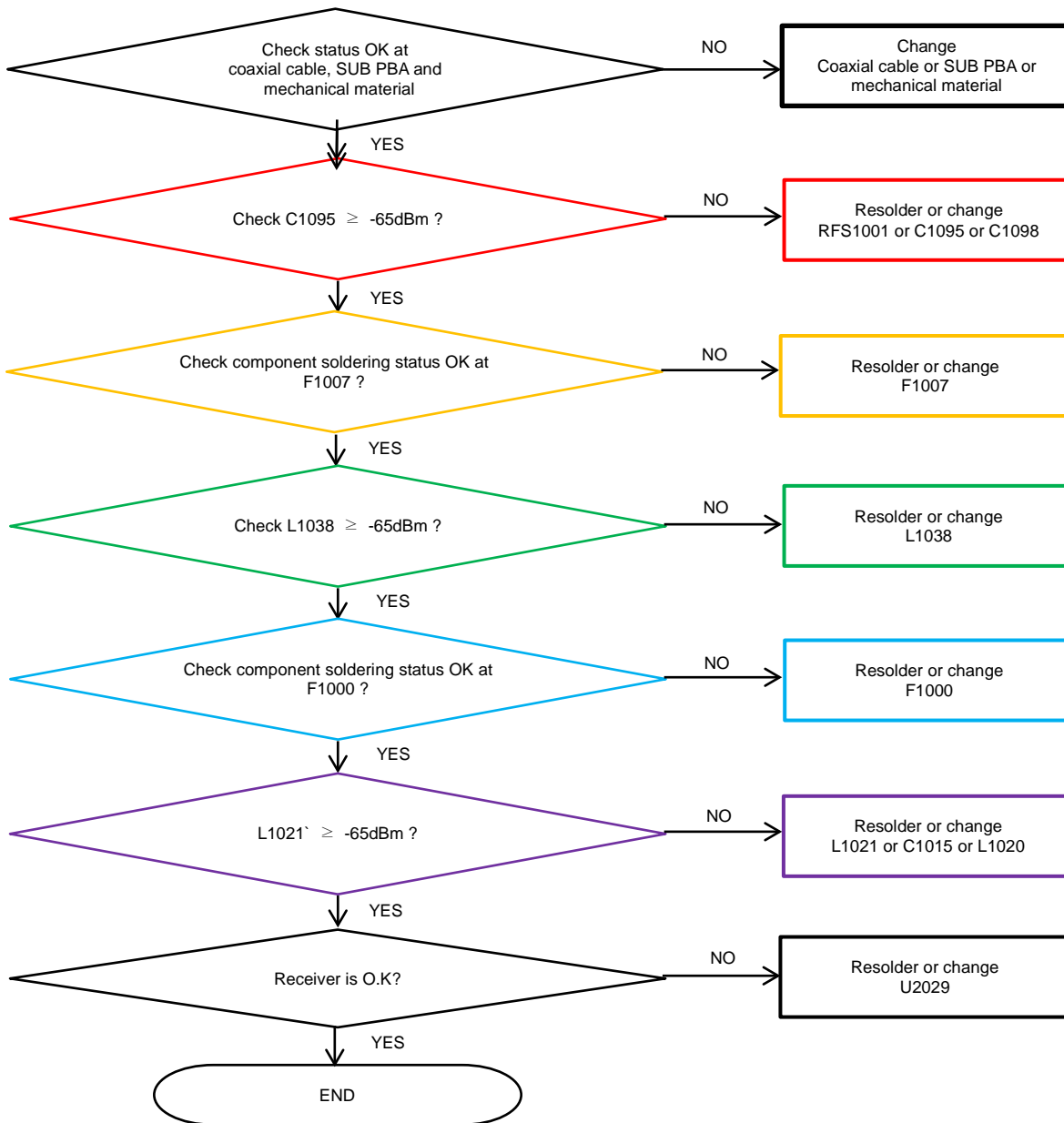
## 8. Level 3 Repair

### 8-4-21. GSM 850, WCDMA B5, LTE B5/26 Rx



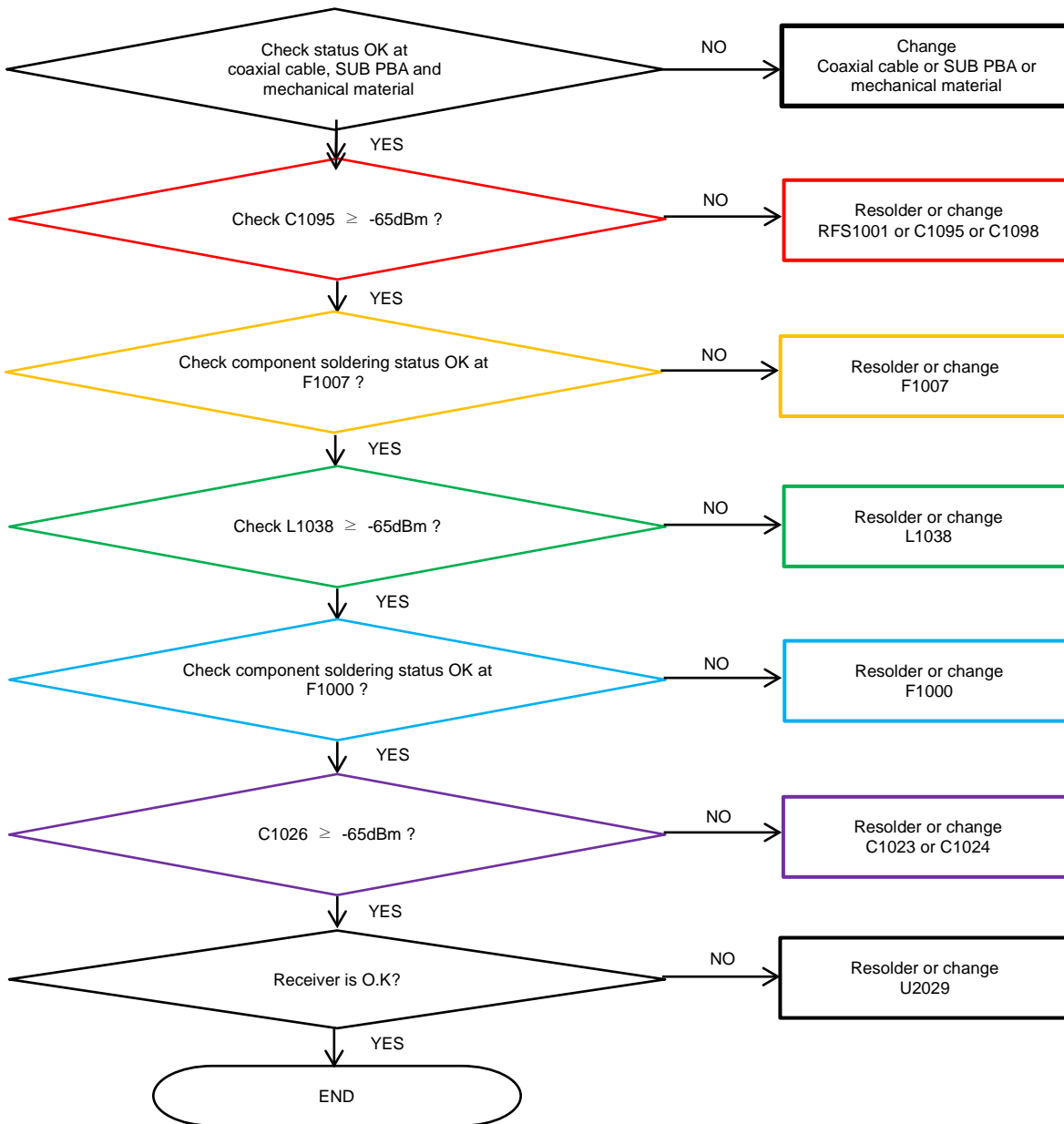
# 8. Level 3 Repair

## 8-4-22. LTE B12/17 Rx



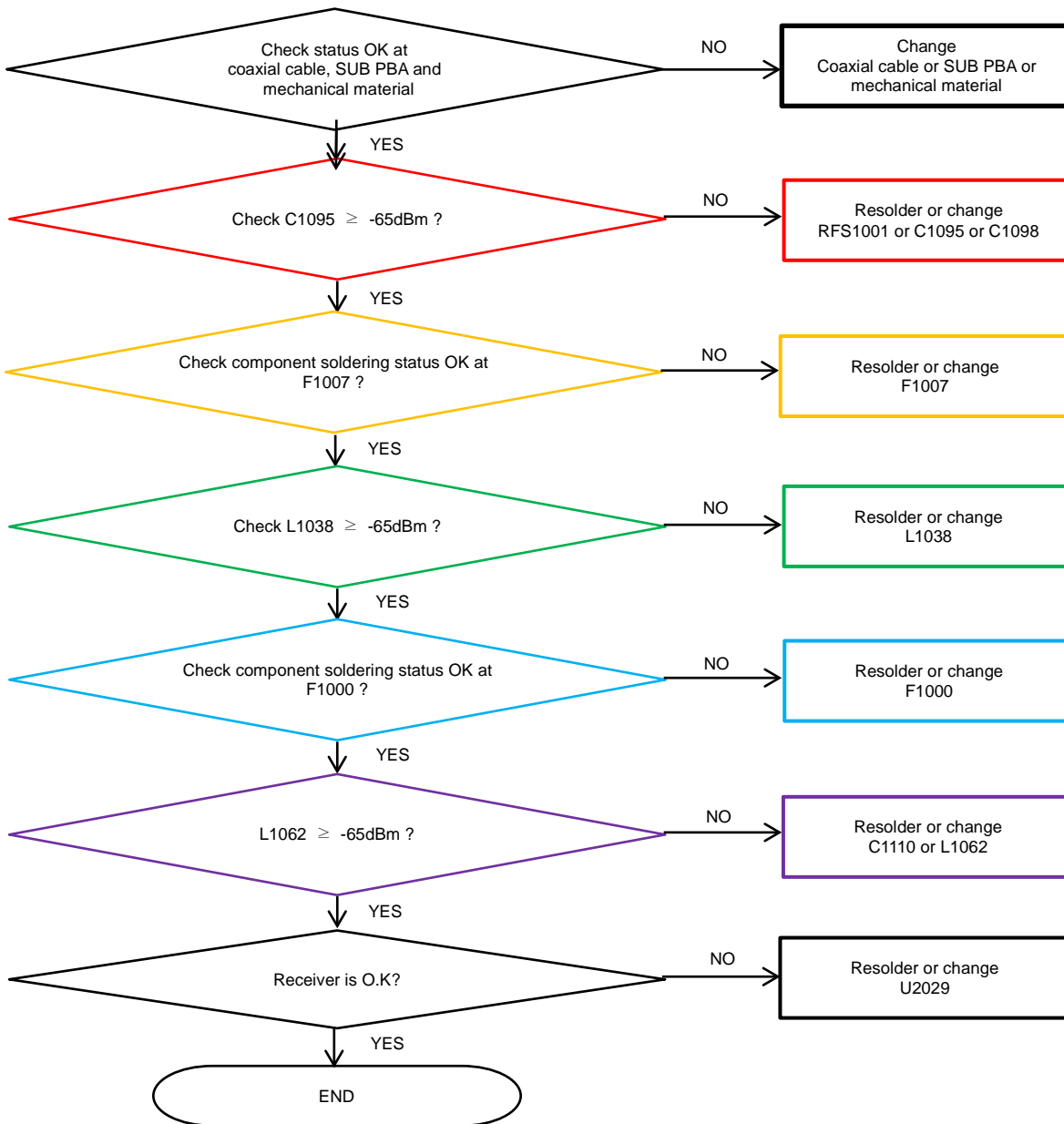
## 8. Level 3 Repair

### 8-4-23. LTE 20 Rx



## 8. Level 3 Repair

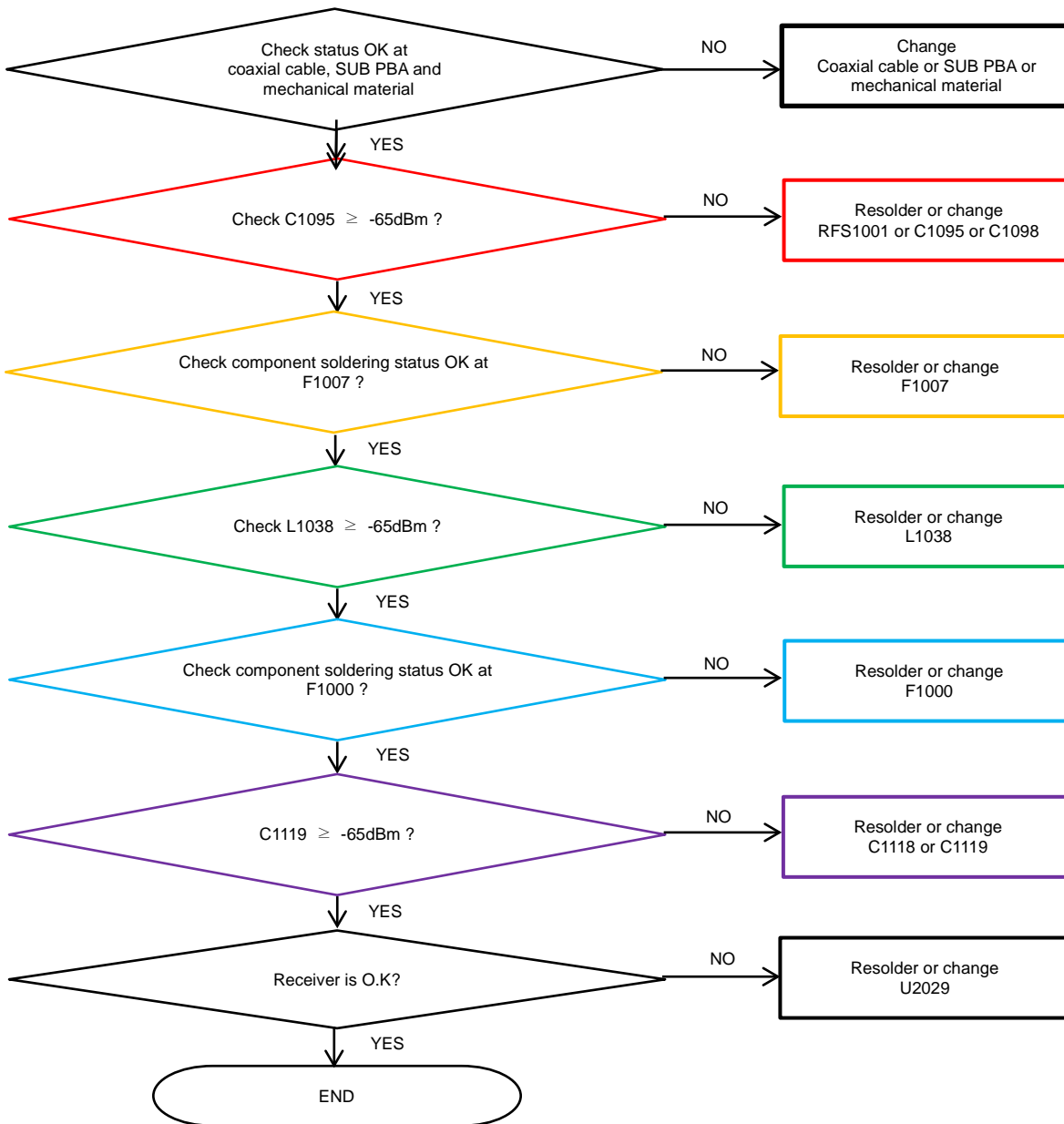
### 8-4-24. LTE 13 Rx





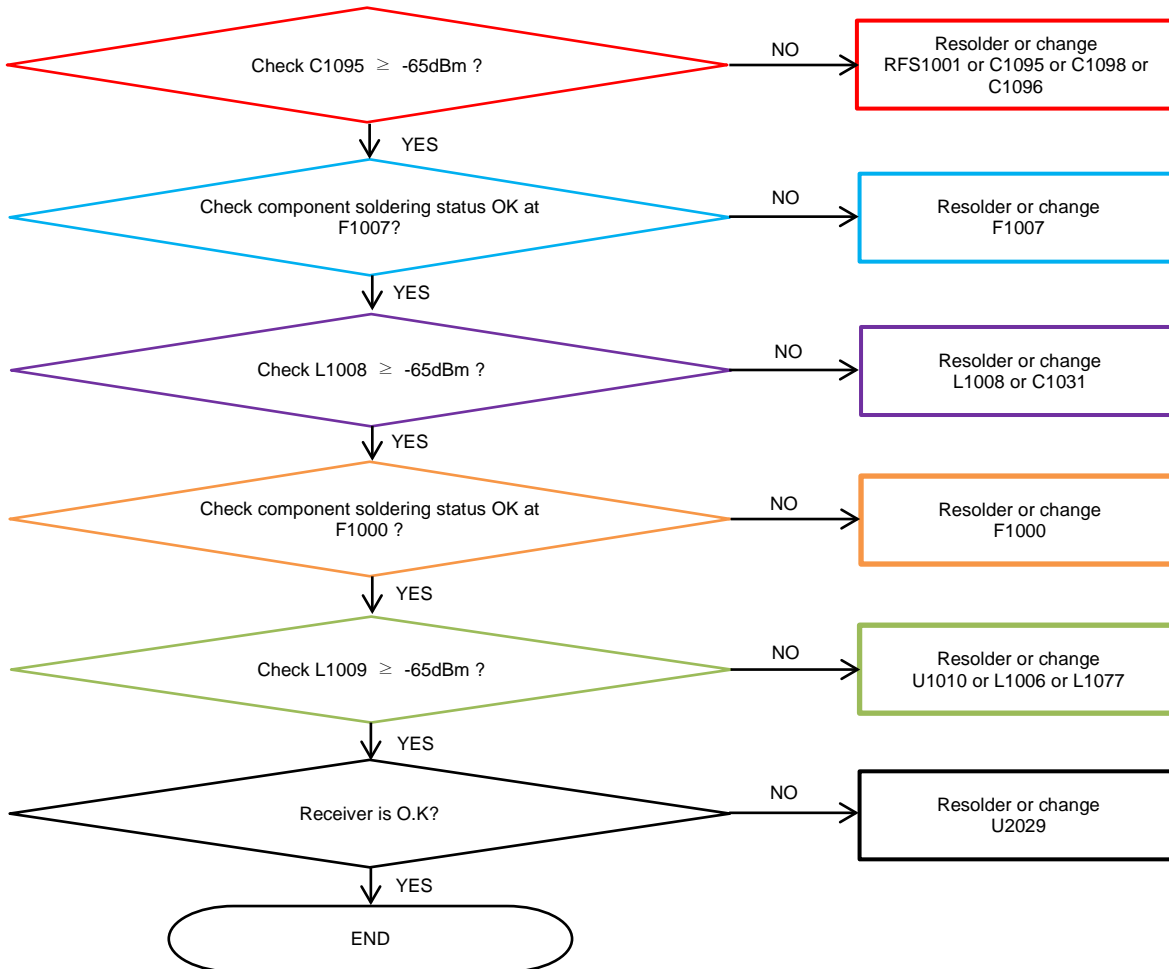
## 8. Level 3 Repair

### 8-4-25. LTE 28 Rx



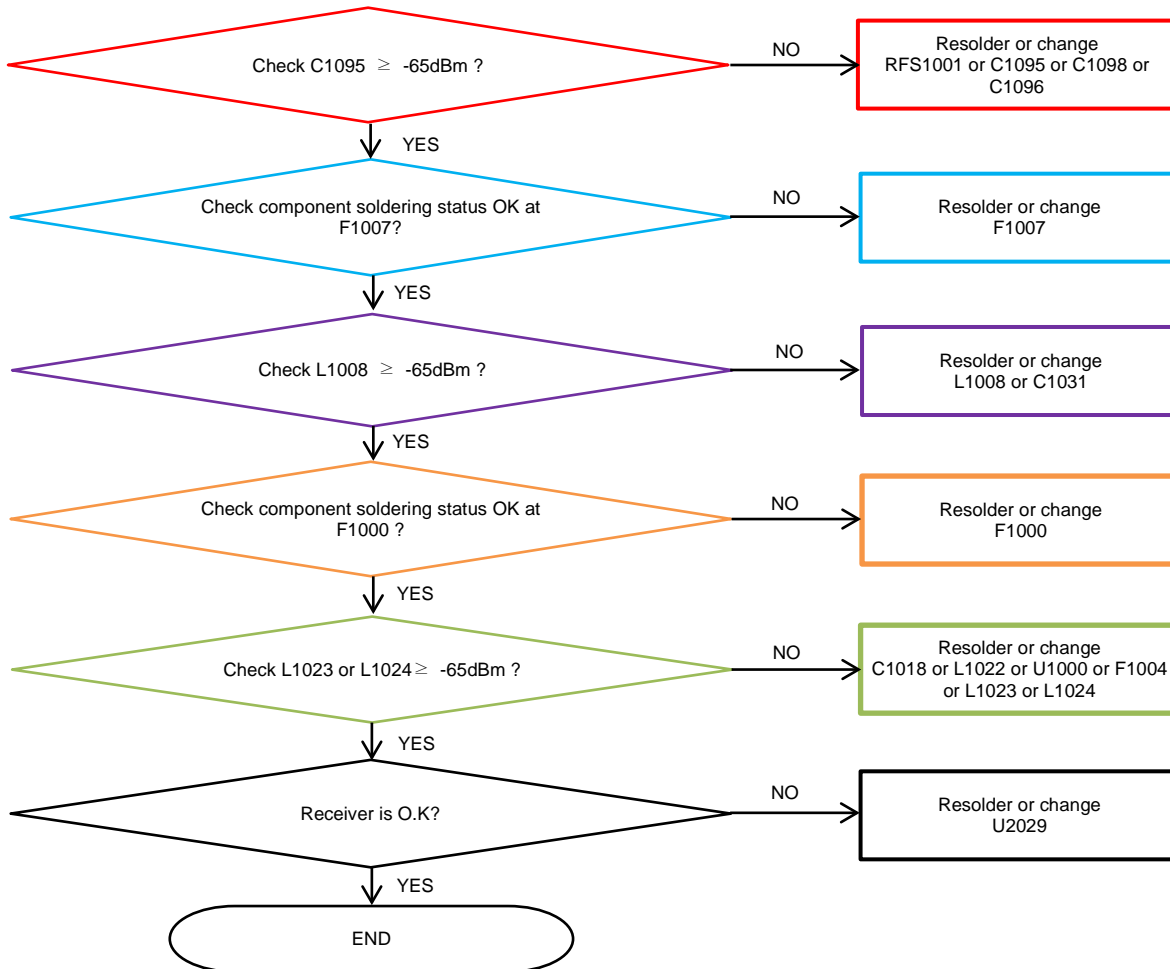
## 8. Level 3 Repair

### 8-4-26. WCDMA B1, LTE B1/4/66 Rx



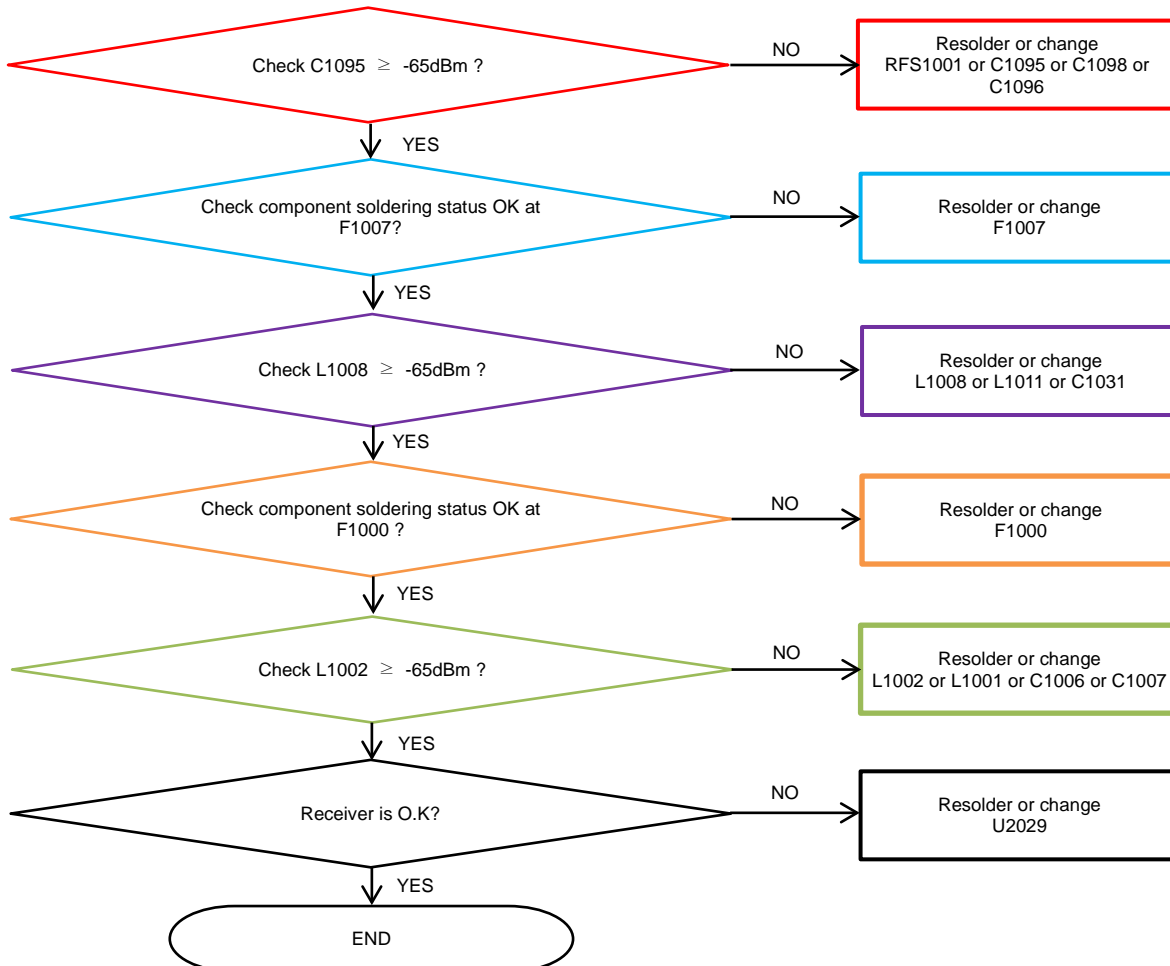
## 8. Level 3 Repair

### 8-4-27. DCS1800, LTE B3 Rx



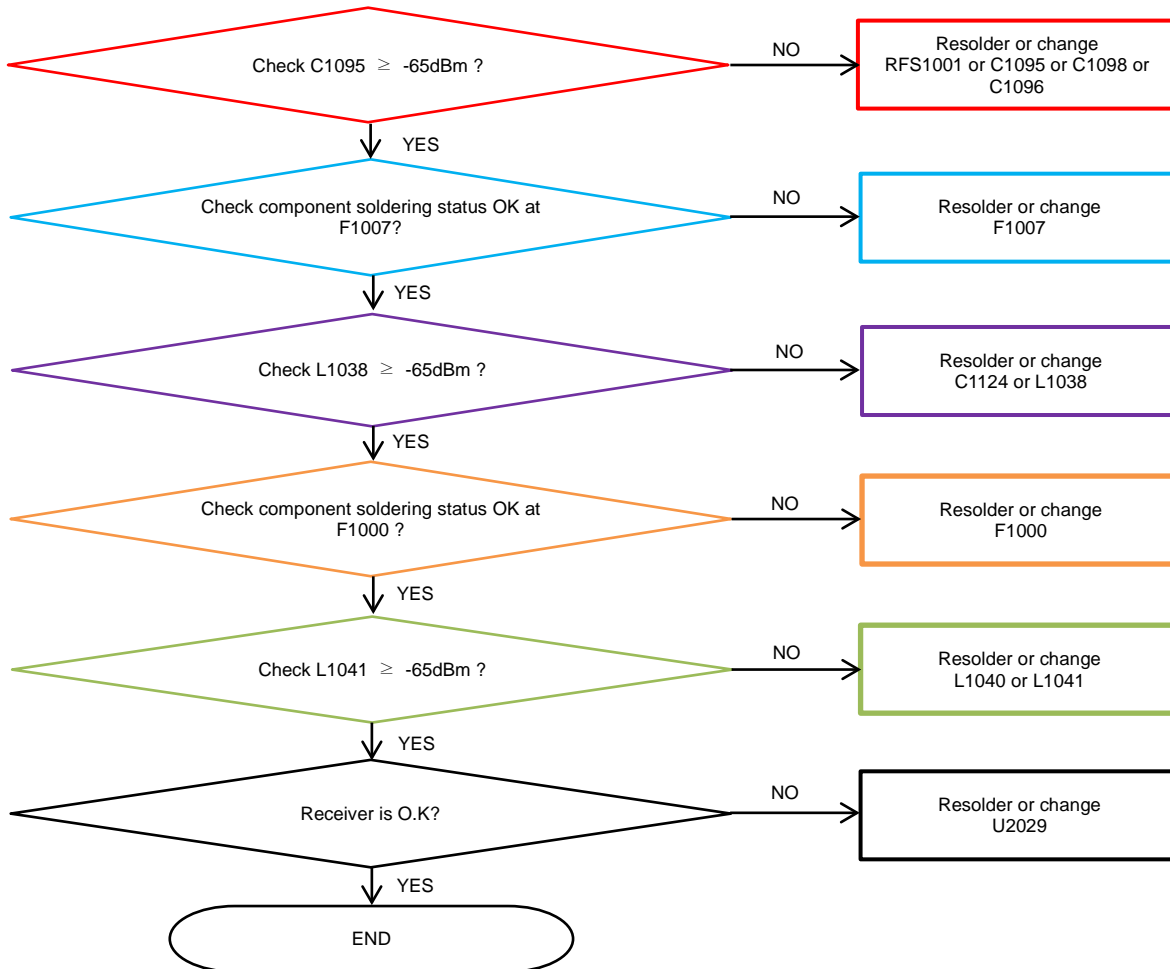
## 8. Level 3 Repair

### 8-4-28. PCS1900, WCDMA B2, LTE B2 Rx



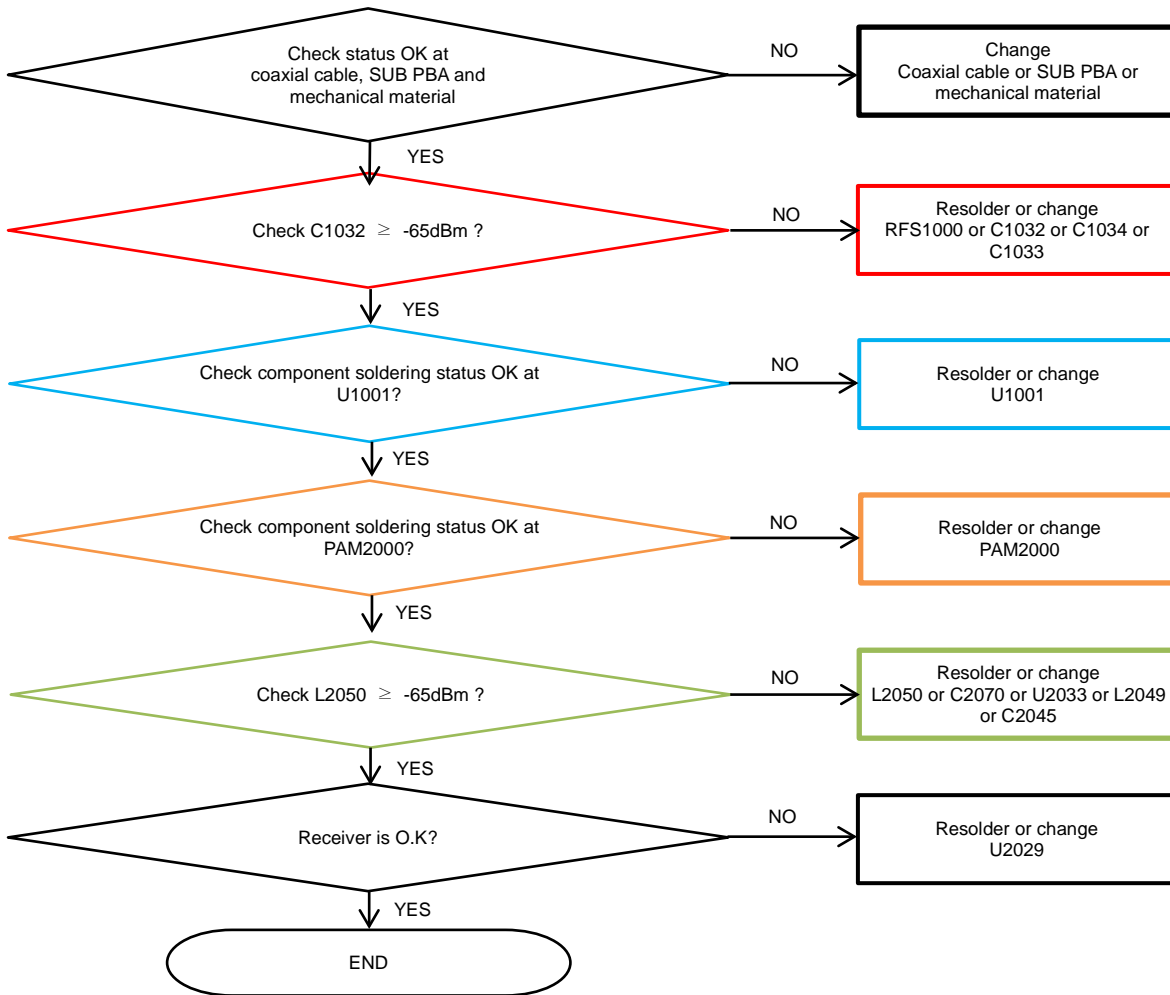
## 8. Level 3 Repair

### 8-4-29. GSM900, WCDMA B8, LTE B8 Rx



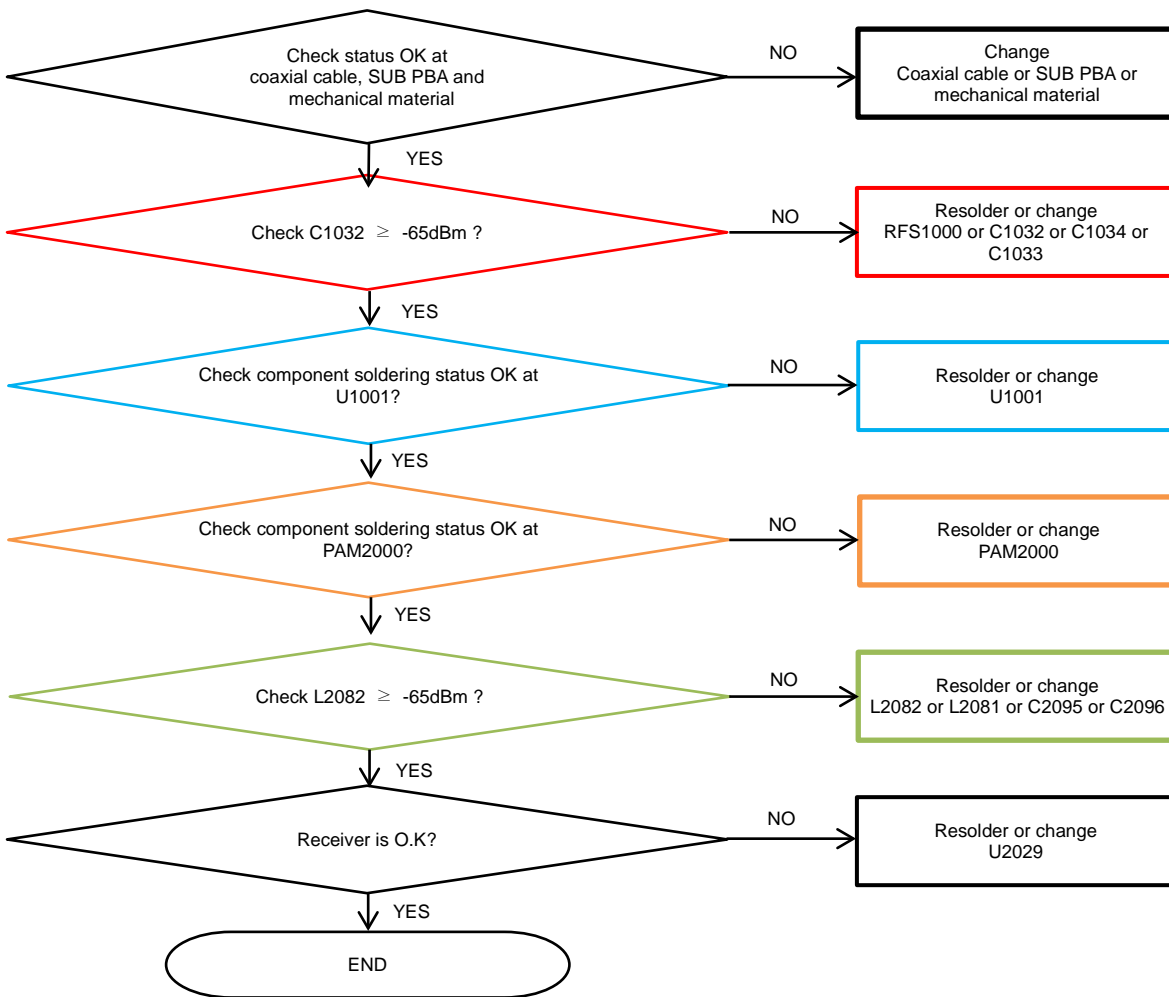
## 8. Level 3 Repair

### 8-4-30. LTE B38/40/41 Rx



## 8. Level 3 Repair

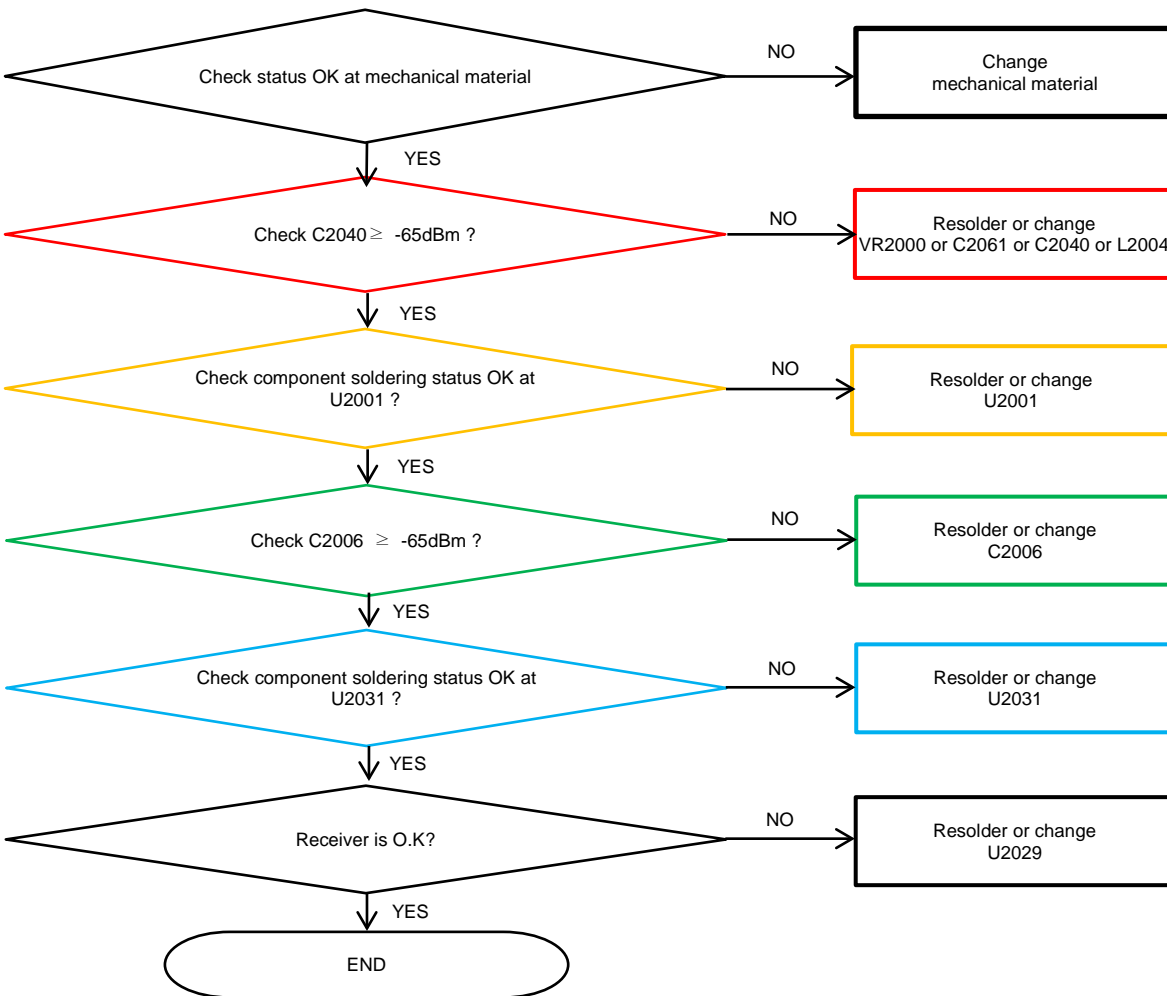
### 8-4-31. LTE B7 Rx





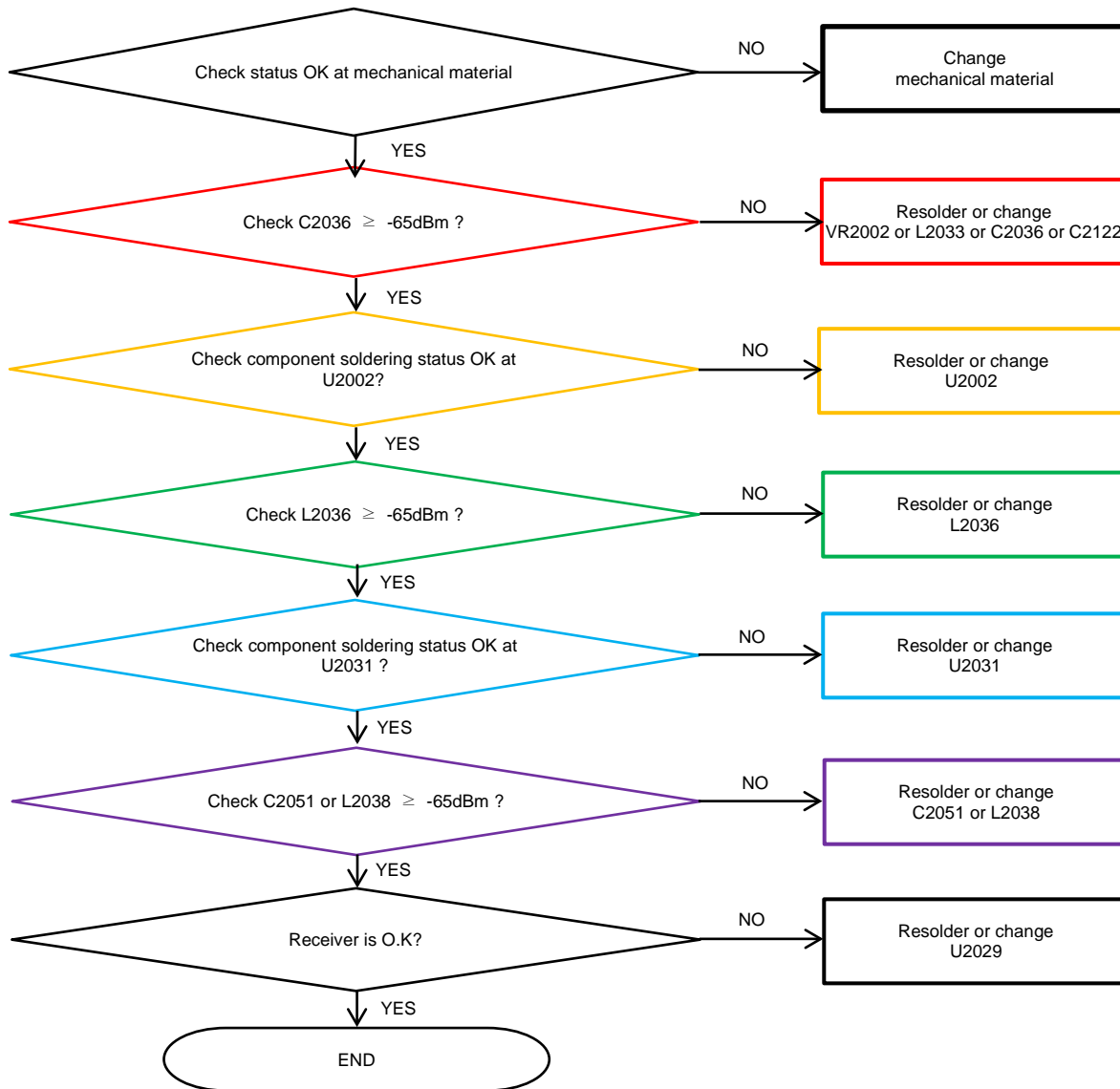
## 8. Level 3 Repair

### 8-4-32. LTE B5/8/12/13/17/20/26/28, WCDMA B5/8 DRx



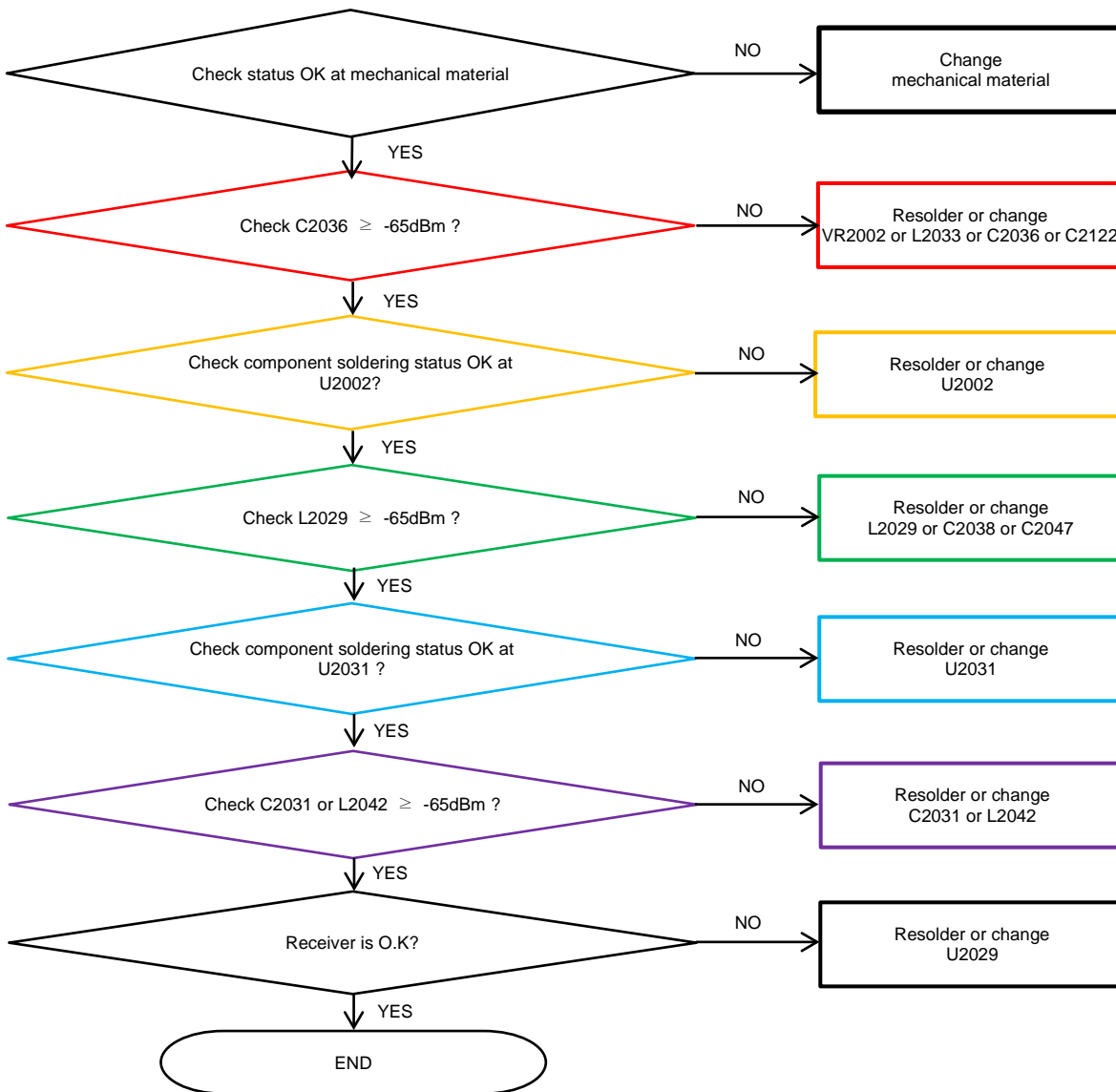
## 8. Level 3 Repair

### 8-4-33. LTE B7/38/40/41 , DRx



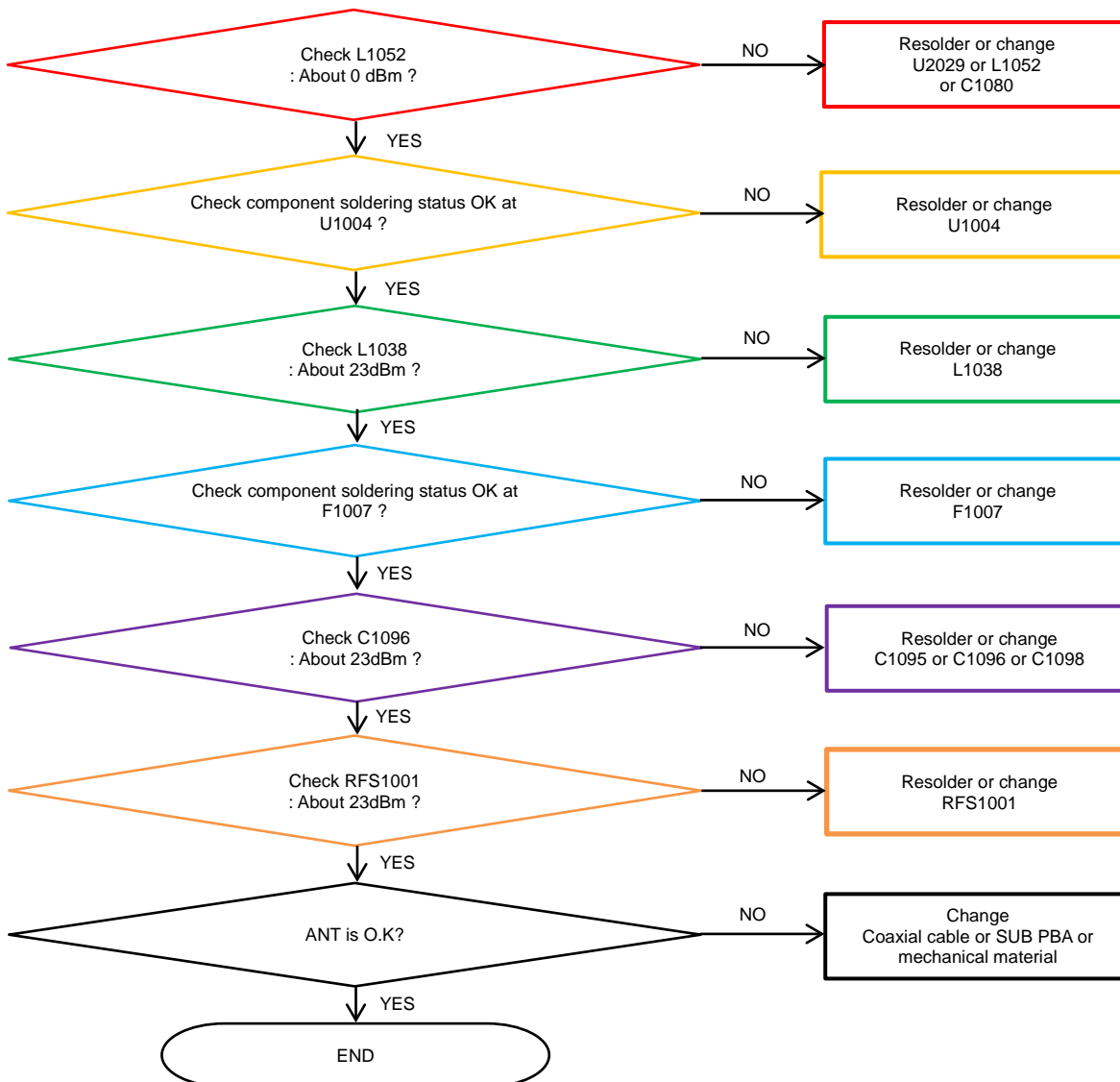
## 8. Level 3 Repair

### 8-4-34. LTE B1/4 , WCDMA B1/B4 DRx



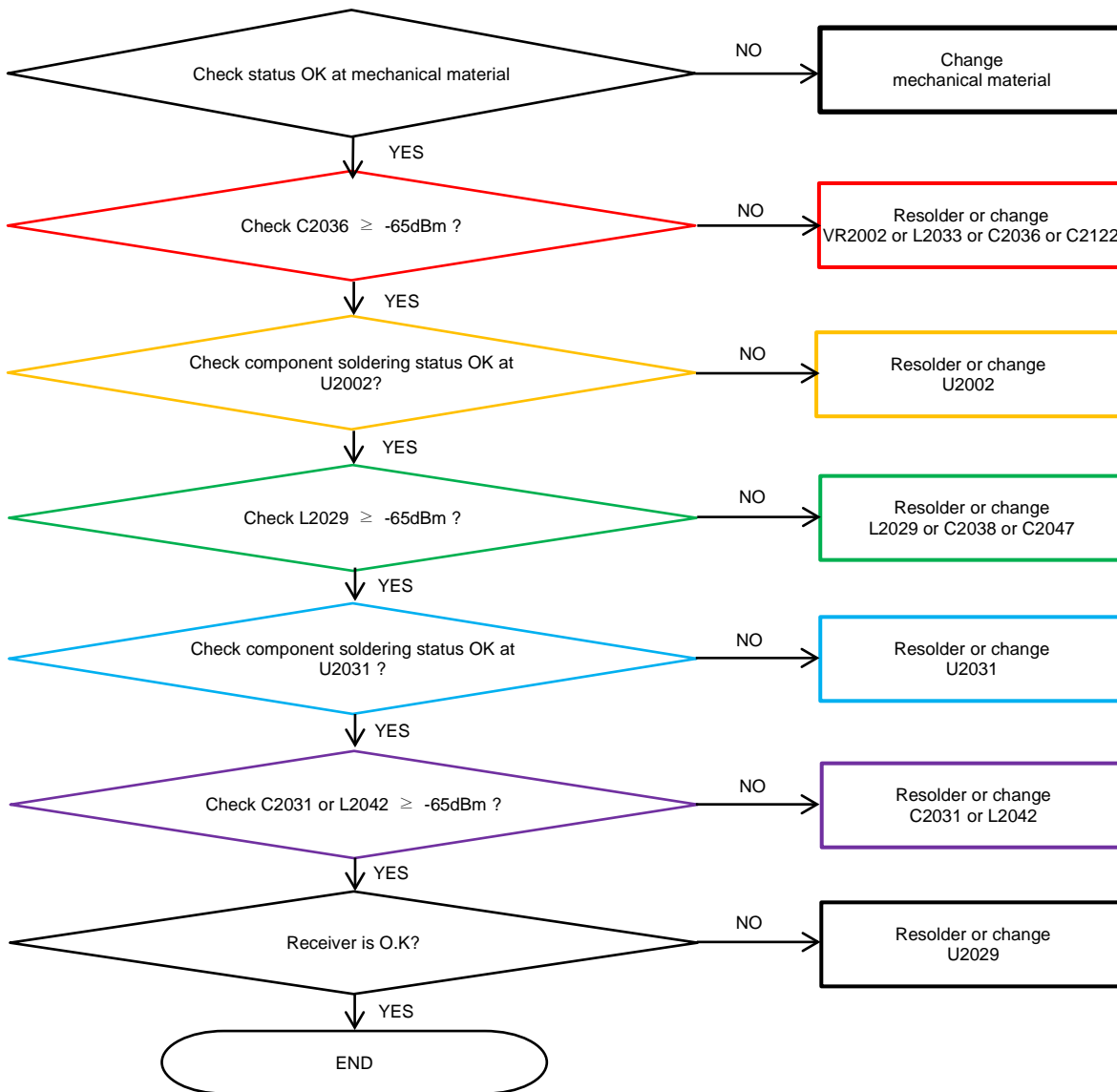
## 8. Level 3 Repair

### 8-4-35. WCDMA B5/8, LTE B5/8 Tx



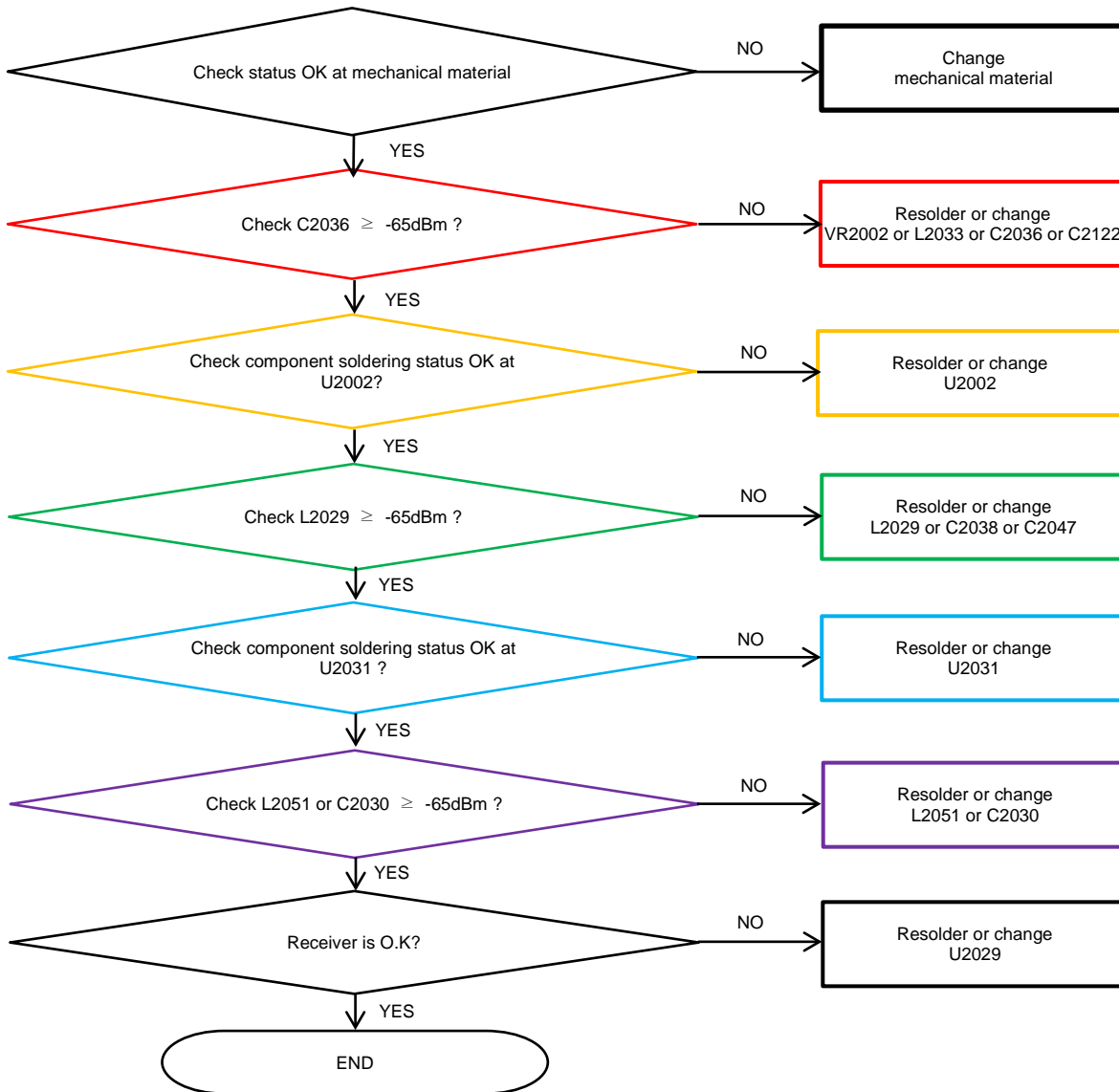
## 8. Level 3 Repair

### 8-4-36. LTE B1/4 , WCDMA B1/B4 DRx



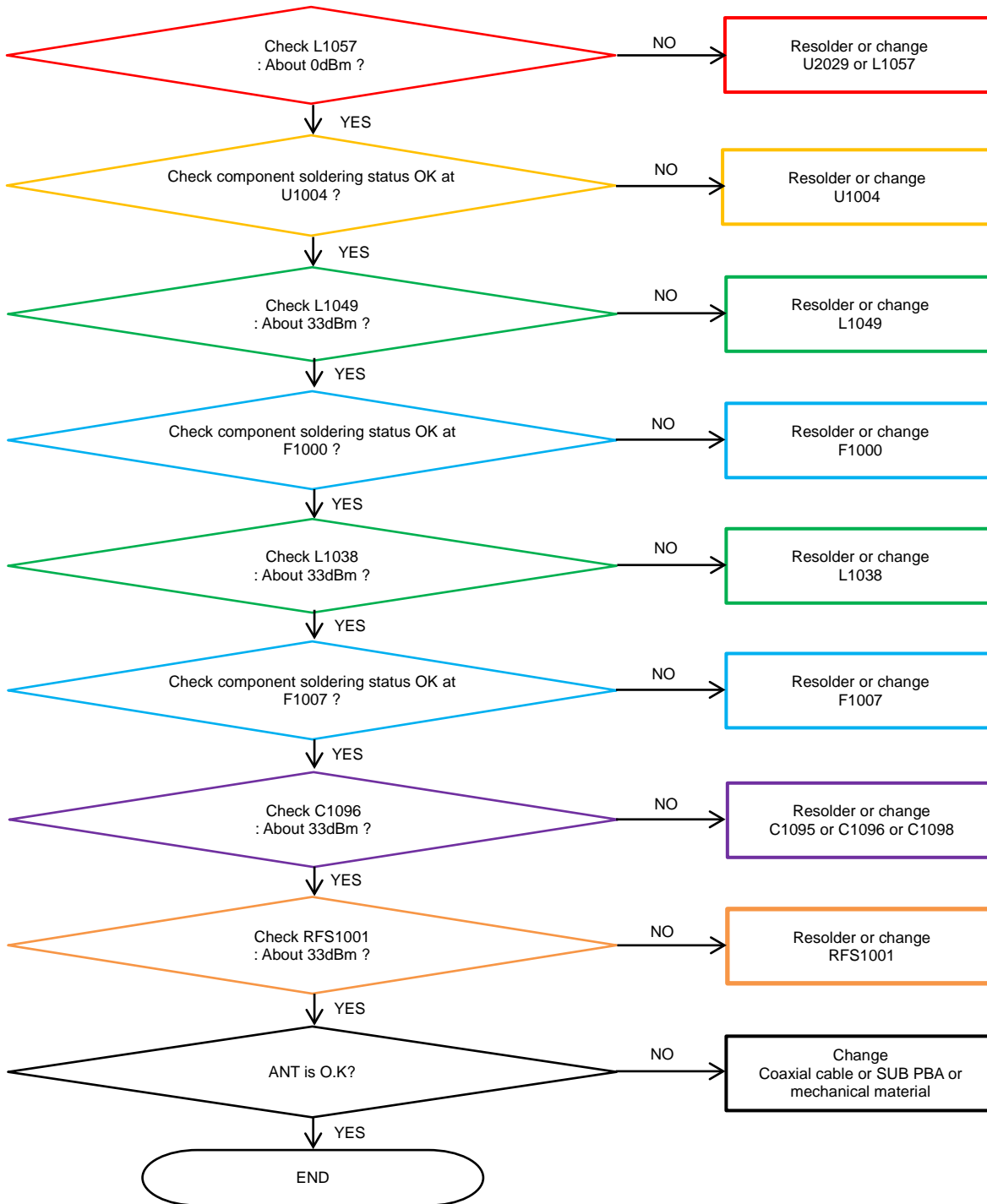
## 8. Level 3 Repair

### 8-4-37. LTE B2/3/66 , WCDMA B2 DRx



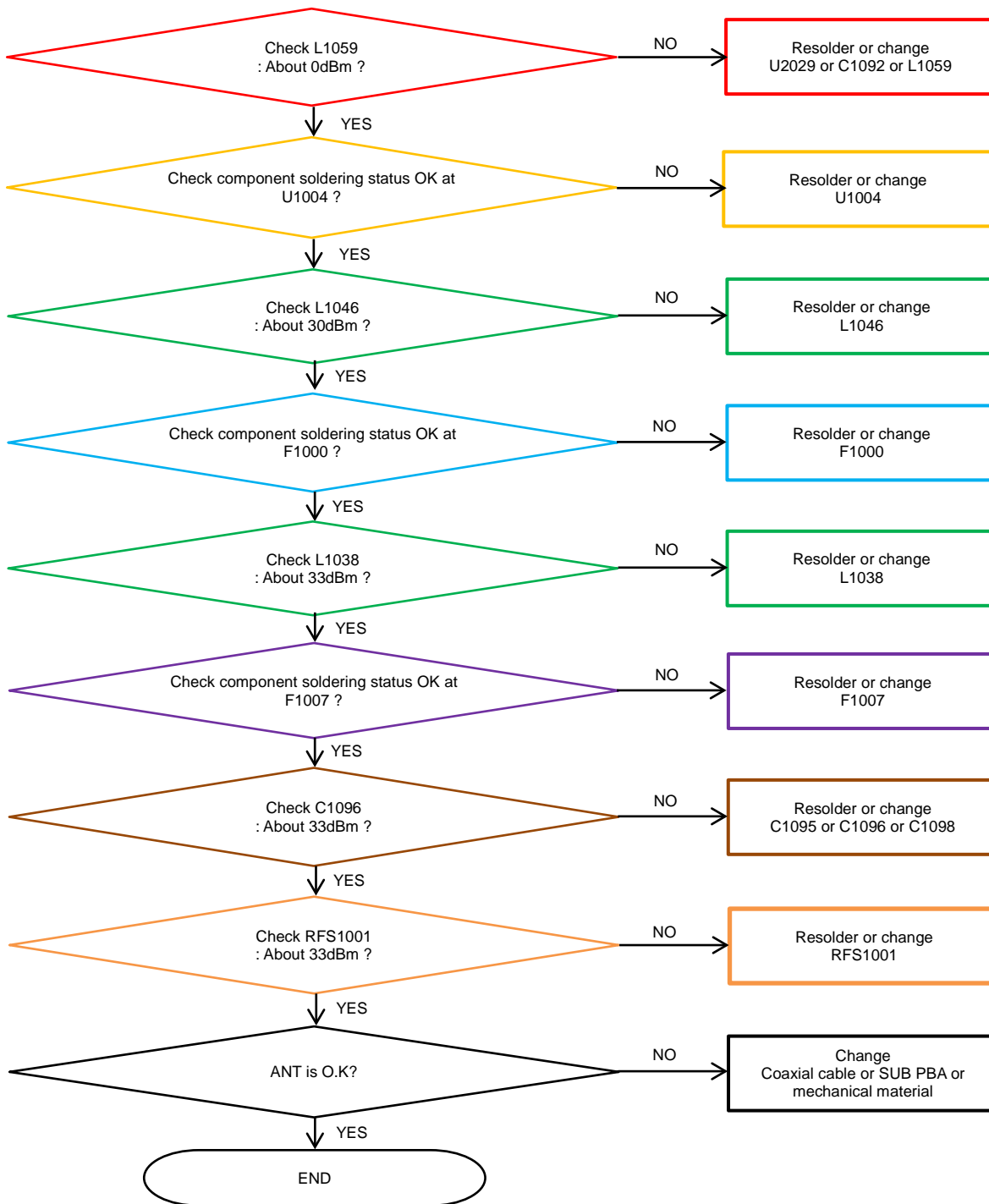
## 8. Level 3 Repair

### 8-4-38. GSM 850/900 Tx



## 8. Level 3 Repair

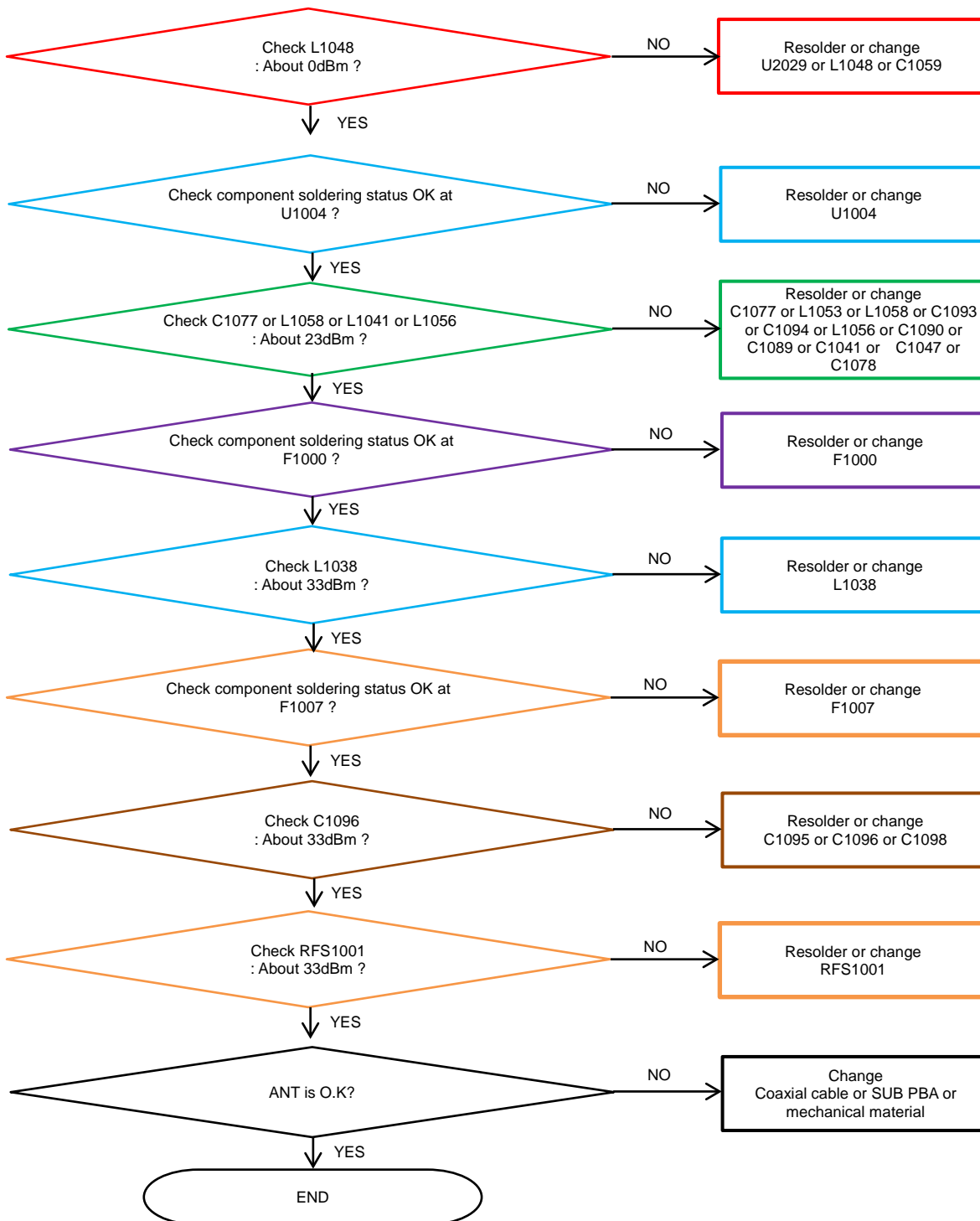
### 8-4-39. GSM 1800/1900 Tx





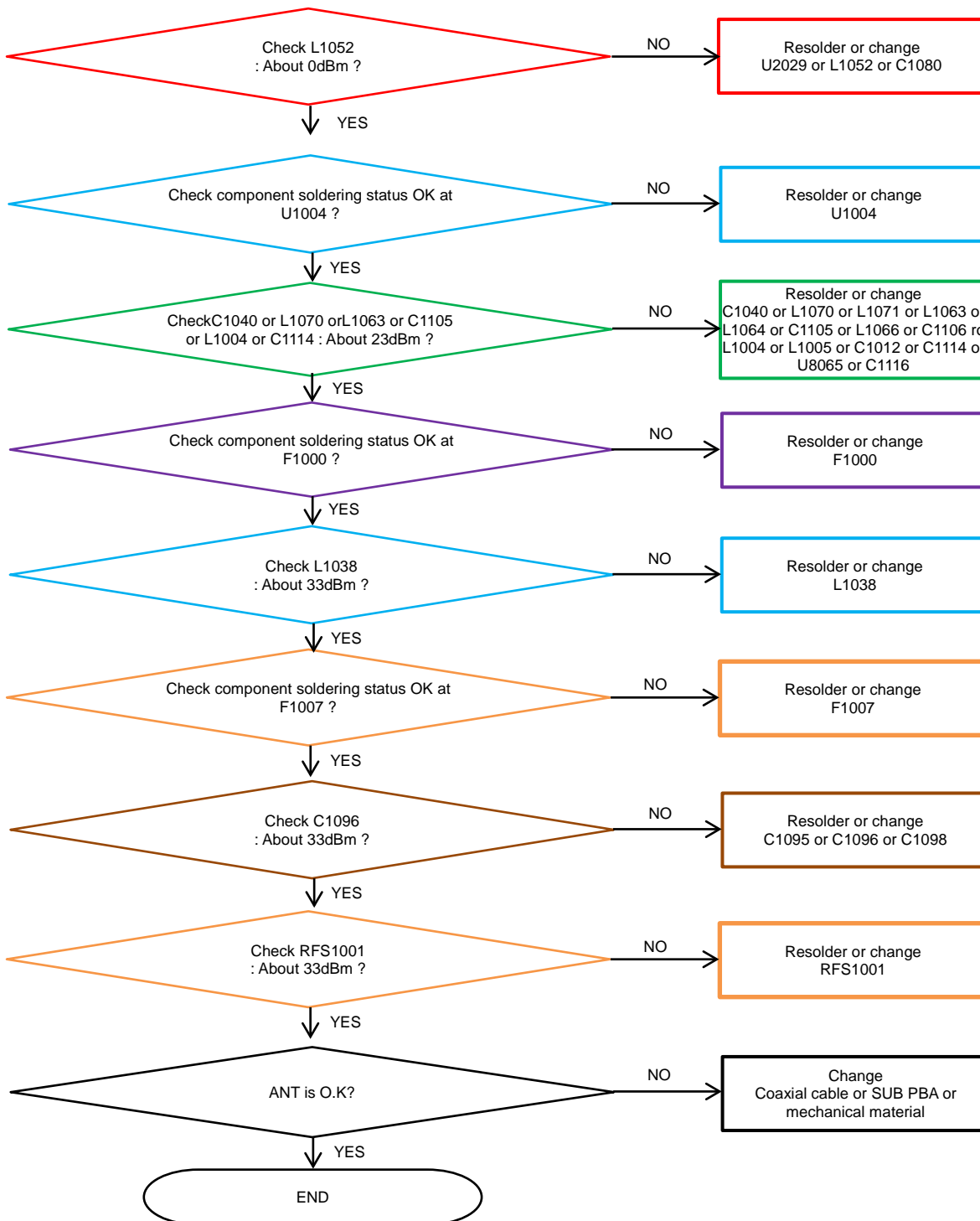
## 8. Level 3 Repair

### 8-4-40. WCDMA B1/2/4, LTE B1/2/3/4/66 Tx



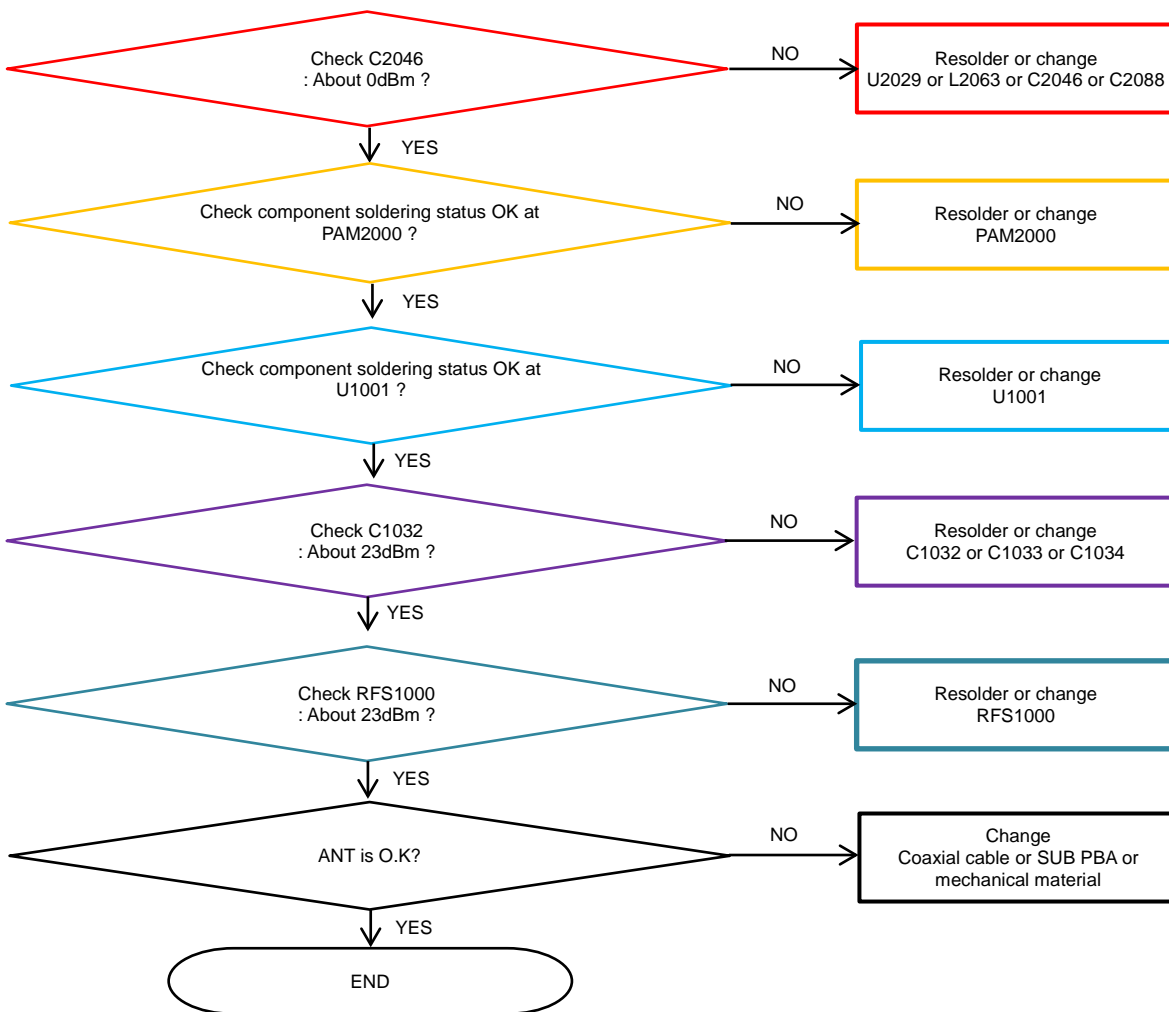
## 8. Level 3 Repair

### 8-4-41. WCDMA B5/8, LTE B5/8/12/13/17/20/26/28 Tx



## 8. Level 3 Repair

### 8-4-42. LTE B7/38/40/41 Tx





## 9. Reference Abbreviation

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### Reference Abbreviation

- **AAC**: Advanced Audio Coding.
- **AVC** : Advanced Video Coding.
- **BER** : Bit Error Rate
- **BPSK**: Binary Phase Shift Keying
- **CA** : Conditional Access
- **CDM** : Code Division Multiplexing
- **C/I** : Carrier to Interference
- **DMB** : Digital Multimedia Broadcasting
- **EN** : European Standard
- **ES** : Elementary Stream
- **ETSI**: European Telecommunications Standards Institute
- **MPEG**: Moving Picture Experts Group
- **PN** : Pseudo-random Noise
- **PS** : Pilot Symbol
- **QPSK**: Quadrature Phase Shift Keying
- **RS** : Reed-Solomon
- **SI** : Service Information
- **TDM** : Time Division Multiplexing
- **TS** : Transport Stream

# SAMSUNG